

X11DAC

USER'S MANUAL

Revision 1.0c



The information in this user's manual has been carefully reviewed and is believed to be accurate. The vendor assumes no responsibility for any inaccuracies that may be contained in this document, and makes no commitment to update or to keep current the information in this manual, or to notify any person or organization of the updates. **Please Note:** For the most up-to-date version of this manual, please see our website at www.supermicro.com.

Super Micro Computer, Inc. ("Supermcro") reserves the right to make changes to the product described in this manual at any time and without notice. This product, including software and documentation, is the property of Supermicro and/ or its licensors, and is supplied only under a license. Any use or reproduction of this product is not allowed, except as expressly permitted by the terms of said license.

IN NO EVENT WILL SUPER MICRO COMPUTER, INC. BE LIABLE FOR DIRECT, INDIRECT, SPECIAL, INCIDENTAL, SPECULATIVE OR CONSEQUENTIAL DAMAGES ARISING FROM THE USE OR INABILITY TO USE THIS PRODUCT OR DOCUMENTATION, EVEN IF ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. IN PARTICULAR, SUPER MICRO COMPUTER, INC. SHALL NOT HAVE LIABILITY FOR ANY HARDWARE, SOFTWARE, OR DATA STORED OR USED WITH THE PRODUCT, INCLUDING THE COSTS OF REPAIRING, REPLACING, INTEGRATING, INSTALLING OR RECOVERING SUCH HARDWARE, SOFTWARE, OR DATA.

Any disputes arising between manufacturer and customer shall be governed by the laws of Santa Clara County in the State of California, USA. The State of California, County of Santa Clara shall be the exclusive venue for the resolution of any such disputes. Supermicro's total liability for all claims will not exceed the price paid for the hardware product.

FCC Statement: This equipment has been tested and found to comply with the limits for a Class B digital device pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the manufacturer's instruction manual, may cause harmful interference with radio communications. Operation of this equipment in a residential area is likely to cause harmful interference, in which case you will be required to correct the interference at your own expense.

<u>California Best Management Practices Regulations for Perchlorate Materials</u>: This Perchlorate warning applies only to products containing CR (Manganese Dioxide) Lithium coin cells. "Perchlorate Material-special handling may apply. See www.dtsc.ca.gov/hazardouswaste/perchlorate".



WARNING: This product can expose you to chemicals including lead, known to the State of California to cause cancer and birth defects or other reproductive harm. For more information, go to www.P65Warnings.ca.gov.

The products sold by Supermicro are not intended for and will not be used in life support systems, medical equipment, nuclear facilities or systems, aircraft, aircraft devices, aircraft/emergency communication devices or other critical systems whose failure to perform be reasonably expected to result in significant injury or loss of life or catastrophic property damage. Accordingly, Supermicro disclaims any and all liability, and should buyer use or sell such products for use in such ultra-hazardous applications, it does so entirely at its own risk. Furthermore, buyer agrees to fully indemnify, defend and hold Supermicro harmless for and against any and all claims, demands, actions, litigation, and proceedings of any kind arising out of or related to such ultra-hazardous use or sale.

Manual Revision 1.0c

Release Date: May 9, 2019

Unless you request and receive written permission from Super Micro Computer, Inc., you may not copy any part of this document. Information in this document is subject to change without notice. Other products and companies referred to herein are trademarks or registered trademarks of their respective companies or mark holders.

Copyright © 2018 by Super Micro Computer, Inc. All rights reserved.

Printed in the United States of America



Preface

About This Manual

This manual is written for system integrators, IT technicians, and knowledgeable end users. It provides information for the installation and use of the X11DAC motherboard.

About This Motherboard

The Super X11DAC motherboard supports dual Intel® Xeon Scalable-SP and 2nd Generation Intel® Xeon Scalable-SP processors (Socket P) with a TDP (Thermal Design Power) of up to 205W and 2 UPIs (Ultra Path Interconnect) of up to 10.4 GT/s (Note 1 below). With the Intel C621 chipset built-in, this motherboard supports up to three PCI-E 3.0 x16 slots, three PCI-E 3.0 x8 slots, eight SATA 3.0 connections, and 4TB of 3DS LRDIMM/LRDIMM/3DS RDIMM/RDIMM/NVDIMM DDR4 ECC 2933*/2666/2400/2133 MHz memory in 16 DIMM slots. (*Note 2 below). This motherboard also supports up to 5TB memory with DCPMM modules installed. This motherboard is optimized for PCI-Express expansion with flexible IO support, and is ideal for workstations, computer-aided design, and visualization platforms. Please note that this motherboard is intended to be installed and serviced by professional technicians only. For processor/memory updates, please refer to our website at http://www.supermicro.com/products/.



Notes: 1. UPI/memory speeds are dependent on the processors installed in your system. The X11DAC supports Intel C621. 2. 2933 MHz memory is supported by 2nd Gen Intel Xeon Scalable-SP (82xx/62xx series) processors only. 3. Populating DDR4 memory modules in a two-DIMMs per-channel (2DPC) configuration on this motherboard will affect memory bandwidth and performance.

Manual Organization

Chapter 1 describes the features, specifications, and performance of the motherboard in addition to providing detailed information on the C621 chipset.

Chapter 2 provides hardware installation instructions. Read this chapter when installing the processor, memory modules, and other hardware components into the system.

Chapter 3 describes troubleshooting procedures for video, memory, and system setup stored in the CMOS.

Chapter 4 includes an introduction to the BIOS, and provides detailed information on running the CMOS Setup utility.

Appendix A provides BIOS Error Beep Codes information.

Appendix B lists software program installation instructions.



- **Appendix C** lists standardized warning statements in various languages.
- Appendix D provides UEFI BIOS Recovery instructions.
- **Appendix E** provides information on how to configure VROC RAID settings.
- **Appendix F** provides information on how to configure secure boot settings.
- **Appendix G** provides information on how to configure iSCSI settings.
- **Appendix H** provides information on how to configure Network Interface Card (NIC) settings.

Contacting Supermicro

Headquarters

Address: Super Micro Computer, Inc.

980 Rock Ave.

San Jose, CA 95131 U.S.A.

Tel: +1 (408) 503-8000 Fax: +1 (408) 503-8008

Email: marketing@supermicro.com (General Information)

support@supermicro.com (Technical Support)

Website: www.supermicro.com

Europe

Address: Super Micro Computer B.V.

Het Sterrenbeeld 28, 5215 ML

's-Hertogenbosch, The Netherlands

Tel: +31 (0) 73-6400390 Fax: +31 (0) 73-6416525

Email: sales@supermicro.nl (General Information)

support@supermicro.nl (Technical Support)
rma@supermicro.nl (Customer Support)

Website: www.supermicro.nl

Asia-Pacific

Address: Super Micro Computer, Inc.

3F, No. 150, Jian 1st Rd.

Zhonghe Dist., New Taipei City 235

Taiwan (R.O.C)

Tel: +886-(2) 8226-3990 Fax: +886-(2) 8226-3992

Email: support@supermicro.com.tw

Website: www.supermicro.com.tw

Table of Contents

Chapter 1 Introduction

1.1	Checklist	8
1.2	Processor and Chipset Overview	16
1.3	Special Features	17
1.4	System Health Monitoring	17
1.5	ACPI Features	18
1.6	Power Supply	18
1.7	Advanced Power Management	18
1.8	Intel® Optane DC Persistent Memory Overview	19
Cha	apter 2 Installation	
2.1	Static-Sensitive Devices	20
2.2	Motherboard Installation	21
2.3	Processor and Heatsink Installation	23
2.4	Memory Support and Installation	31
2.5	Rear I/O Ports	37
2.6	Front Control Panel	41
2.7	Connectors	46
2.8	SATA/SAS Connections	54
2.9	Jumper Settings	56
2.10) LED Indicators	60
Cha	apter 3 Troubleshooting	
3.1	Troubleshooting Procedures	62
3.2	Technical Support Procedures	65
3.3	Frequently Asked Questions	66
3.4	Battery Removal and Installation	67
3.5	Returning Merchandise for Service	68
4.1	Introduction	69
4.2	Main Setup	70
4.3	Advanced Setup Configurations	72
4.4	Event Logs	111
4.5	IPMI	113
4.6	Security Settings	116

4.7 Boot Settings	120
4.8 Save & Exit	123
Appendix A BIOS Codes	
A.1 BIOS Error POST (Beep) Codes	125
Appendix B Software Installation	
B.1 Installing Software Programs	127
B.2 SuperDoctor® 5	128
Appendix C Standardized Warning Statements	
Appendix D UEFI BIOS Recovery	
D.1 Overview	132
D.2 Recovering the UEFI BIOS Image	132
D.3 Recovering the Main BIOS Block with a USB Device	133
Appendix E Configuring VROC RAID Settings	
E.1 All Intel® VMD Controllers Features	137
E.2 Configuring RAID Settings	144
E.3 Use of Journaling Drive	157
Appendix F Secure Boot Settings	
F.1 Boot mode select Feature	161
F.2 Secure Boot/ Secure Boot Mode/ CSM Support Features	162
F.3 Secure Boot Settings	163
F.4 Key Management Settings	166
Appendix G Configuring iSCSI Settings	
G.1 PCIe/PCI/PnP Features	183
G.2 Configuring iSCSI Settings	186
Appendix H Configuring Network Interface Card (NIC) Settings	
H.1 Network Interface Card (NIC) Settings	205

Chapter 1

Introduction

Congratulations on purchasing your computer motherboard from an industry leader. Supermicro motherboards are designed to provide you with the highest standards in quality and performance.

In addition to the motherboard, several important parts that are included with your shipment are listed below. If anything listed is damaged or missing, please contact your retailer.

1.1 Checklist

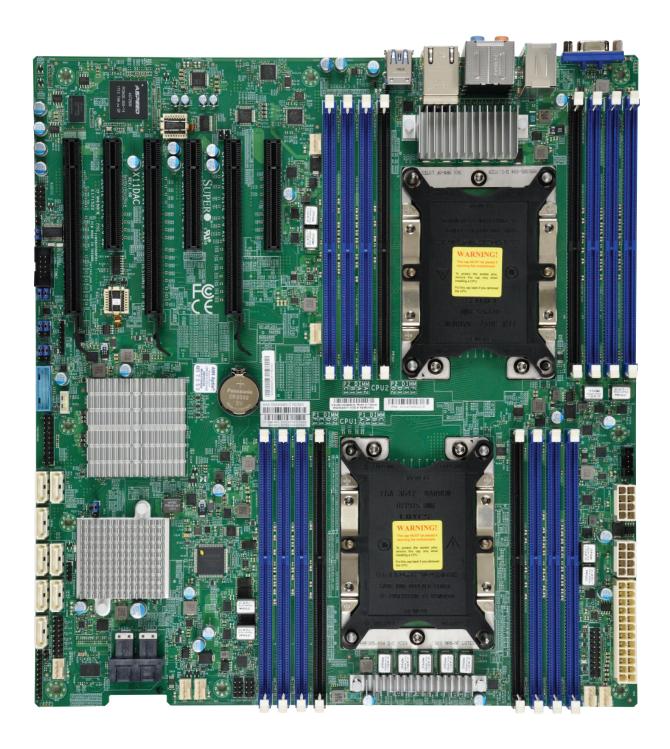
Main Parts List							
Description	Part Number	Quantity					
Supermicro motherboard-X11DAC	MNL-2082	1					
SATA cables	CBL-0044L (x6)	6					
I/O Shield	MCP-260-00042-ON	1					
Supermicro motherboard quick reference guide-X11DAC	MNL-2082-QRG	1					

Important Links

For your system to work properly, please follow the links below to download all necessary drivers/utilities and the user's manual for your server.

- Supermicro product manuals: http://www.supermicro.com/support/manuals/
- Product drivers and utilities: http://www.supermicro.com/wftp
- Product safety info: http://www.supermicro.com/about/policies/safety information.cfm
- If you have any questions, please contact our support team at: support@supermicro.com

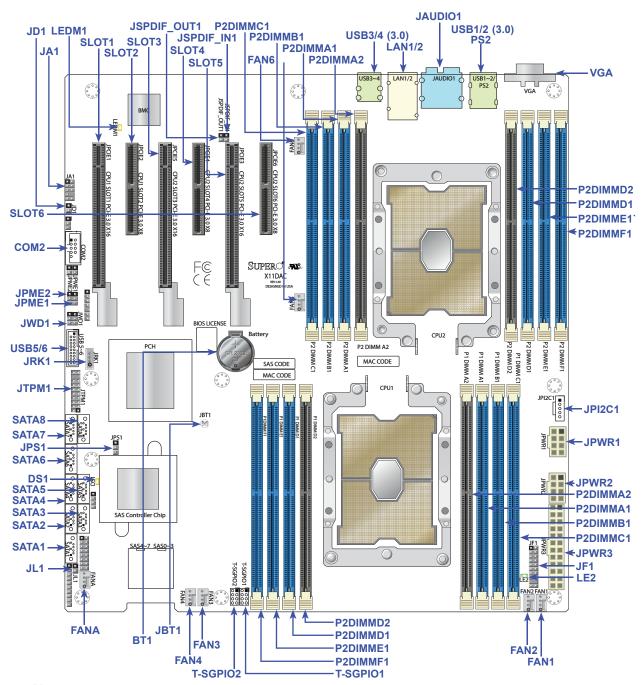
This manual may be periodically updated without notice. Please check the Supermicro website for possible updates to the manual revision level.



X11DAC Motherboard Image

Note: All graphics shown in this manual were based upon the latest PCB revision available at the time of publication of the manual. The motherboard you received may or may not look exactly the same as the graphics shown in this manual.

X11DAC Motherboard Layout





- See Chapter 2 for detailed information on jumpers, I/O ports, and JF1 front panel connections.
- "■" indicates the location of Pin 1.
- Jumpers/components/LED indicators not indicated are used for internal testing only.
- Use only the correct type of onboard CMOS battery as specified by the manufacturer. Do not install the onboard battery upside down to avoid possible explosion.



Quick Reference Table

Jumper	Description		Default Setting					
JBT1	CMOS Clear		Open (Normal)					
JPME1	ME Recovery		Pins 1-2 (Normal)					
JPME2	Manufacturing Mode Select	Pins 1-2 (Normal)						
JPS1	SAS Status	SAS Status Pins 1-2 (Enabled)						
JWD1	Watch Dog Timer Enable		Pins 1-2 (Reset)					
Connector	Description	Description						
BT1	Onboard CMOS battery socket							
	COM header for front access							
COM2		e FANA)						
FAN1-6, FANA	System cooling fan headers (FAN1-FAN6							
SATA0~3, SATA4~7	SATA 3.0 connection headers supported	by the Intel PCH						
JA1	Audio header for front access							
JD1	Internal speaker/Buzzer header							
JF1	Front Control Panel header							
JL1	Chassis Intrusion header (Note : please to the chassis to receive an alert via IPN		the Chassis Intrusion header at JL1					
JPI ² C1	Power Supply SMBus I ² C header							
JPWR1/JPWR2	8-pin Power Supply connectors							
JPWR3	24-pin ATX main power supply connecto	r						
JRK1	Intel VROC RAID Key header for NVMe	Solid State Device (S	SSD)					
JSPDIF_IN1/JSPDIF_ OUT1	SPDIF (Sony/Philips Digital Interconnect	Format) Audio In/Ou	t headers					
JTPM1	Port 80 connector for Trusted Platform M	Module (TPM)						
LAN1/LAN2	Dual 1GbE Ethernet ports on the IO bac	k panel						
SAS0~3	SAS Connections 0-3 supported by LSI	SAS 3008 Controller						
SAS4~7	SAS Connections 4-7 supported by LSI	SAS 3008 Controller						
SLOT1	PCI-Express 3.0 x16 Slot supported by 0	CPU1						
SLOT2	PCI-Express 3.0 x8 Slot supported by C	PU1						
SLOT3/SLOT5	PCI-Express 3.0 x16 Slots supported by	CPU2						
SLOT4/SLOT6	PCI-Express 3.0 x8 Slots supported by 0	CPU2						
T-SGPIO1/T-SGPIO2	General Purpose Serial I/O Port1/Port2							
USB1/2,USB3/4	Back panel USB 3.0 Ports 1/2, 3/4							
USB5/6	Front Accessible USB 3.0 header							
VGA	VGA Port							
LED	Description	Status						
DS1	SAS Heartbeat LED	Blinking Green: SAS	S Normal					
LE2	Onboard Power LED	On: Onboard power	on					
LEDM1	BMC Heartbeat LED	Blinking Green: BM	C normal					





Note: To avoid causing interference with other components, please be sure to use an add-on card that is fully compliant with the PCI-standard on a PCI slot.

Motherboard Features

CPU

• This motherboard supports dual Intel Xeon Scalable-SP and 2nd Gen Intel Xeon Scalable-SP (Socket P) processors which offer two Intel® UltraPath Interconnect (UPI) links of up to 10.4 GT/s



Note: Both CPUs need to be installed for full access to the PCI-E slots, DIMM slots, and onboard controllers. Refer to the block diagram on page 15 to determine which slots or devices may be affected.

Memory

 IIntegrated memory controller supports up to 4TB of Registered DIMM (RDIMM), Load Reduced DIMM (LRDIMM), 3DS LRDIMM, Non-Volatile DIMM (NV-DIMM) DDR4 (288-pin) ECC memory with speeds of up to 2933*/2666/2400/2133MHz in 16 slots.



Notes: **1.** Up to 5TB memory with DCPMM modules installed. **2.** 2933 MHz memory is supported by 2nd Gen Intel Xeon Scalable-SP (82xx/62xx series) processors only.

DIMM Size

• Up to 128GB at 1.2V



Note 1: Memory speed support depends on the processors used in the system.

Note 2: For the latest CPU/memory updates, please refer to our website at http://www.supermicro.com/products/motherboard.

Chipset

• Intel C621

Expansion Slots

- One (1) PCI-E 3.0 x16 slot supported by CPU1 (Slot1)
- One (1) PCI-E 3.0 x8 slot supported by CPU1 (Slot2)
- Two (2) PCI-E 3.0 x8 slots supported by CPU2 (Slot4/Slot6)
- Two (2) PCI-E 3.0 x16 slot supported by CPU2 (Slot3/Slot5)

Baseboard Management Controller (BMC)

• ASPEED AST 2500 Baseboard Management Controller (BMC) supports IPMI 2.0

Graphics

• Graphics controller via AST 2500 BMC

Network Connection

- Intel C621 supports two Gigabit LAN (1 GbE) ports
- One IPMI shared LAN supported by the AST2500 BMC

I/O Devices

• SATA 3.0	Eight (8) SATA 3.0 ports supported by Intel PCH (SATA 0-3, SATA 4-7)
SAS 3 Connections	Eight (8) SAS3 connections supported by LSI SAS 3008 controller (SAS 0-3, SAS 4-7)
RAID (PCH)	• RAID 0 1 5 and 10

Motherboard Features

Peripheral Devices

- Four (4) USB 3.0 ports on the rear I/O panel (USB1/2, USB3/4)
- Two (2) Front-accessible USB ports (USB5/6)

BIOS

- 32MB SPI AMI BIOS® SM Flash UEFI BIOS
- ACPI 3.0/4.0, PS/2 Keyboard/Mouse Combo, PCI F/W 3.0, and SMBIOS 2.7 or later

Power Management

- Main switch override mechanism
- Power-on mode for AC power recovery
- Intel® Intelligent Power Node Manager 4.0 (available when the Supermicro Power Manager [SPM] is installed and a special power supply is used)
- Management Engine (ME)
- S3, S4, S5 Sleep State

System Health Monitoring

- Onboard voltage monitoring for 3.3V standby, +5V, +5V standby, +12V, CPU core, memory, chipset, BMC, and PCH voltages
- · CPU System LED and control
- · CPU Thermal Trip support
- · Status monitor for on/off control
- CPU Thermal Design Power (TDP) support of up to 205W (See Note 1 on next page.)

Fan Control

• Multi-speed fan control via onboard BMC

System Management

- Trusted Platform Module (TPM) support
- PECI (Platform Environment Control Interface) 2.0 support
- System resource alert via SuperDoctor® 5
- SuperDoctor® 5, WatchDog, NMI
- IPMICFG
- SMCIPMITOOL
- IPMIView
- Chassis intrusion header and detection

LED Indicators

- CPU/Overheating
- Fan failure
- · Power/Suspend-state indicator
- HDD activity
- LAN activity

Dimensions

• 12" (L) x 13" (W) (304.8 mm x 330.2 mm)

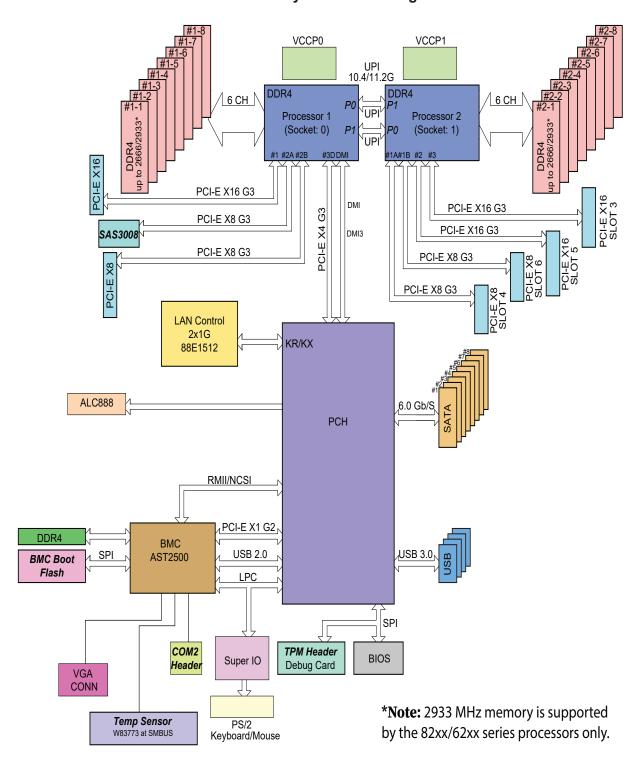




Note 1: The CPU maximum thermal design power (TDP) is subject to chassis and heatsink cooling restrictions. For proper thermal management, please check the chassis and heatsink specifications for proper CPU TDP sizing.

Note 2: For IPMI configuration instructions, please refer to the Embedded IPMI Configuration User's Guide available at http://www.supermicro.com/support/manuals/.

Note 3: It is strongly recommended that you change BMC login information upon initial system power-on. The manufacturer default username is ADMIN and the password is ADMIN. For proper BMC configuration, please refer to http://www.supermicro.com.



Intel C621 System Block Diagram

Note: This is a general block diagram and may not exactly represent the features on your motherboard. See the previous pages for the actual specifications of your motherboard.

1.2 Processor and Chipset Overview

Built upon the functionality and capability of Intel Xeon Scalable-SP and 2nd Gen Intel Xeon Scalable-SP processors (Socket P) with support of C621 chipset, this motherboard provides superb system performance, efficient power management, and a rich feature set based on cutting edge technologies to address the needs of next-generation users. It offers innovative solutions with unprecedented system reliability and scalability to meet the demands of High Performance Computing (HPC) platforms.

Features Supported by Intel Xeon Scalable-SP Processors

Intel Xeon Scalable-SP processors support the following features:

- Intel AVX-512 instruction support to handle complex workloads
- 1.5x memory bandwidth increased to 6 channels
- Hot plug and enclosure management with Intel Volume Management Device (Intel VMD)
- Rich set of available IOs with increased PCI-E lanes (48 lanes)
- Integrated Intel Ethernet Connection X722 with iWARP RDMA

New features supported by 2nd Gen Intel Xeon Scalable-SP Processors

2nd Gen Intel Xeon Scalable-SP processors support the following features:

- Higher performance for a wider range of workloads with per-core performance increase
- Support of Optane DC Persistent Memory (DCPMM) with affordable, persistent, and large capacity
- Up to 2993 MHz memory supported (Refer to Section 1.8 for details.)
- Vector Neural Network Instruction (VNNI) support for Accelerate Deep Learning & Artificial Intelligence (AI) workloads
- Speed Select Technology provides multiple CPU profiles that can be set in the BIOS.
 (This feature is available on select CPU SKUs)
- Seamless hardware security mitigations & performance/frequency flexibility



Note: DCPMM memory and 2933 MHz memory are supported by 2nd Gen Intel Xeon Scalable-SP processors only.

1.3 Special Features

This section describes the health monitoring features of the X11DAC motherboard. The motherboard has an onboard ASPEED 2500 Baseboard Management Controller (BMC) that supports system health monitoring.

Recovery from AC Power Loss

The Basic I/O System (BIOS) provides a setting that determines how the system will respond when AC power is lost and then restored to the system. You can choose for the system to remain powered off (in which case you must press the power switch to turn it back on), or for it to automatically return to the power-on state. See the Advanced BIOS Setup section for this setting. The default setting is Last State.

1.4 System Health Monitoring

This section describes the health monitoring features of the X11DAC motherboard. The motherboard has an onboard Baseboard Management Controller (BMC) chip that supports system health monitoring.

Onboard Voltage Monitors

The onboard voltage monitor will continuously scan crucial voltage levels. Once a voltage becomes unstable, it will give a warning or send an error message to the IPMI WebGUI and IPMIView. The user can adjust the voltage thresholds to define the sensitivity of the voltage monitor. Real time readings of these voltage levels are all displayed in the IPMI.

Fan Status Monitor with Firmware Control

The system health monitor embedded in the BMC chip can check the RPM status of the cooling fans. The CPU and chassis fans are controlled via IPMI.

Environmental Temperature Control

System Health sensors in the BMC monitor the temperatures and voltage settings of onboard processors and the system in real time via the IPMI interface. Whenever the temperature of the CPU or the system exceeds the manufacturer-defined threshold, system/CPU cooling fans will be turned on to prevent the CPU or the system from overheating.

Note: To avoid possible system overheating, please be sure to provide adequate airflow to your system.

System Resource Alert

This feature is available when used with SuperDoctor 5®. SuperDoctor 5 is used to notify the user of certain system events. For example, you can configure SuperDoctor 5 to provide you with warnings when the system temperature, CPU temperatures, voltages and fan speeds go beyond a predefined range.

1.5 ACPI Features

ACPI stands for Advanced Configuration and Power Interface. The ACPI specification defines a flexible and abstract hardware interface that provides a standard way to integrate power management features throughout a computer system including its hardware, operating system and application software. This enables the system to automatically turn on and off peripherals such as network cards, hard disk drives and printers.

In addition to enabling operating system-directed power management, ACPI also provides a generic system event mechanism for Plug and Play and an operating system-independent interface for configuration control. ACPI leverages the Plug and Play BIOS data structures while providing a processor architecture-independent implementation that is compatible with the appropriate Windows operating systems. For detailed information on OS support, please refer to our website at www.supermicro.com.

1.6 Power Supply

As with all computer products, a stable power source is necessary for proper and reliable operation. It is even more important for processors that have high CPU clock rates where noisy power transmission is present.

1.7 Advanced Power Management

The following new advanced power management features are supported by the motherboard.

Intel® Intelligent Power Node Manager (IPNM)

The Intel's Intelligent Power Node Manager (IPNM) provides your system with real-time thermal control and power management for maximum energy efficiency. Although IPNM Specification Version 2.0/3.0 is supported by the BMC (Baseboard Management Controller), your system must also have IPNM-compatible Management Engine (ME) firmware installed to use this feature.

 \mathbb{N}

Note: Support for IPNM 2.0/3.0 support is dependent on the power supply used in the system.



Management Engine (ME)

The Management Engine, which is an ARC controller embedded in the IOH (I/O Hub), provides Server Platform Services (SPS) to your system. The services provided by SPS are different from those provided by the ME on client platforms.

1.8 Intel® Optane DC Persistent Memory Overview

2nd Gen Intel Xeon Scalable-SP processors support new DCPMM (Optane™ DC Persistent Memory Modules) technology that offers data persistence with higher capacity than existing memory modules and lower latency than NVMe SSDs. DCPMM memory provides hyperspeed storage capability for high performance computing platforms with flexible configuration options.



Chapter 2

Installation

2.1 Static-Sensitive Devices

Electrostatic Discharge (ESD) can damage electronic components. To avoid damaging your motherboard and your system, it is important to handle it very carefully. The following measures are generally sufficient to protect your equipment from ESD.

Precautions

- Use a grounded wrist strap designed to prevent static discharge.
- Touch a grounded metal object before removing the board from the antistatic bag.
- Handle the board by its edges only; do not touch its components, peripheral chips, memory
 modules or gold contacts.
- When handling chips or modules, avoid touching their pins.
- Put the motherboard and peripherals back into their antistatic bags when not in use.
- For grounding purposes, make sure that your chassis provides excellent conductivity between the power supply, the case, the mounting fasteners and the motherboard.
- Use only the correct type of CMOS onboard battery as specified by the manufacturer. Do not install the CMOS battery upside down, which may result in a possible explosion.

Unpacking

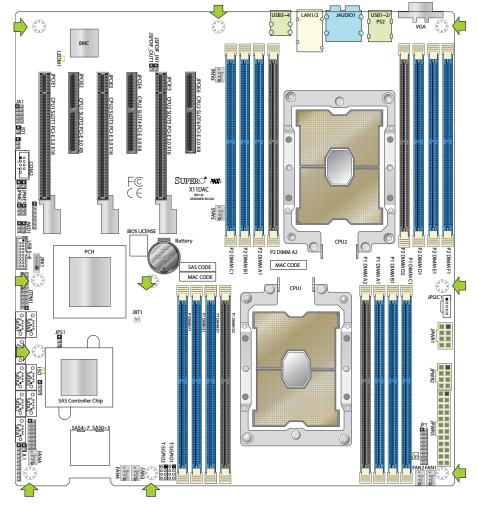
The motherboard is shipped in antistatic packaging to avoid static damage. When unpacking the motherboard, make sure that the person handling it is static protected.

2.2 Motherboard Installation

All motherboards have standard mounting holes to fit different types of chassis. Make sure that the locations of all the mounting holes for both the motherboard and the chassis match. Although a chassis may have both plastic and metal mounting fasteners, metal ones are highly recommended because they ground the motherboard to the chassis. Make sure that the metal standoffs click in or are screwed in tightly.



Tools Needed

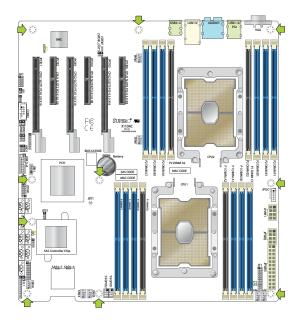


Location of Mounting Holes

Notes: 1) To avoid damaging the motherboard and its components, please do not use a force greater than 8 lb/inch on each mounting screw during motherboard installation.
2) Some components are very close to the mounting holes. Please take precautionary measures to avoid damaging these components when installing the motherboard to the chassis.

Installing the Motherboard

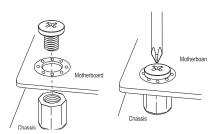
- Install the I/O shield into the back of the chassis as needed.
- 2. Locate the mounting holes on the motherboard as shown in the layout on the left side.







3. Locate the matching mounting holes on the chassis. Align the mounting holes on the motherboard against the mounting holes on the chassis.



- 4. Install standoffs in the chassis as needed.
- 5. Install the motherboard into the chassis carefully to avoid damaging other motherboard components.
- 6. Using the Phillips screwdriver, insert a Phillips head #6 screw into a mounting hole on the motherboard and its matching mounting hole on the chassis.
- 7. Repeat Step 5 to insert #6 screws into all mounting holes.
- 8. Make sure that the motherboard is securely placed in the chassis.



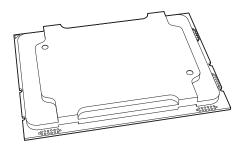
Note: Images displayed in this manual are for illustration only. Your system or components might look different from those shown in this manual.

2.3 Processor and Heatsink Installation

Warning: When handling the processor package, avoid placing direct pressure on the label area of the CPU or CPU socket. Also, improper CPU installation or socket misalignment can cause serious damage to the CPU or motherboard which may result in RMA repairs. Please read and follow all instructions thoroughly before installing your CPU and heatsink.

- Always connect the power cord last, and always remove it before adding, removing, or changing any hardware components. Please note that the processor and heatsink should be assembled together first to form the Processor Heatsink Module (PHM), and then install the entire PHM into the CPU socket.
- When you receive a motherboard without a processor pre-installed, make sure that the
 plastic CPU socket cap is in place and that none of the socket pins are bent; otherwise,
 contact your retailer immediately.
- Refer to the Supermicro website for updates on CPU support.
- Please follow the instructions given in the ESD Warning section on the first page of this chapter before handling, installing, or removing system components.

Intel Xeon Scalable-SP and 2nd Gen Intel Xeon Scalable-SP Processors



Intel Xeon Scalable-SP and 2nd Gen Intel Xeon Scalable-SP Processor



Note: All graphics, drawings, and pictures shown in this manual are for illustration only. The components that came with your machine may or may not look exactly the same as those shown in this manual.

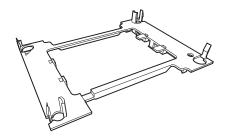
Overview of the Processor Socket Assembly

The processor socket assembly contains 1) Intel Xeon Scalable-SP or 2nd Generation Intel Xeon Scalable-SP processor, 2) the narrow processor clip, 3) the dust cover, and 4) the CPU socket.

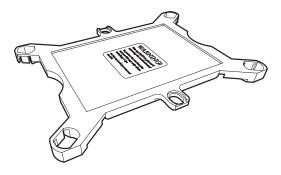
1. Intel Processor



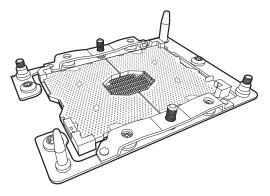
2. Narrow processor clip (the plastic processor package carrier used for the CPU)



3. Dust Cover



4. CPU Socket

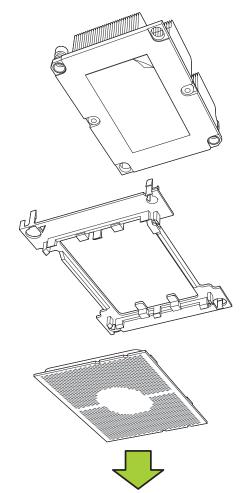


Note: Be sure to cover the CPU socket with the dust cover when the CPU is not installed.

Overview of the Processor Heatsink Module (PHM)

The Processor Heatsink Module (PHM) contains 1) a heatsink, 2) a narrow processor clip, and 3) Intel Xeon Scalable-SP or 2nd Gen Intel Xeon Scalable-SP processor.

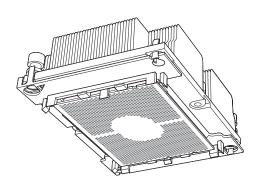
1. Heatsink



3. Intel Processor

2. Narrow processor clip



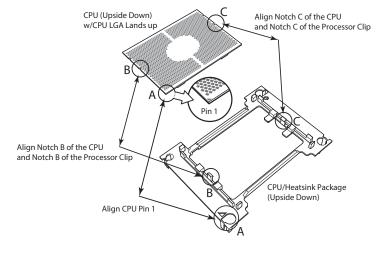


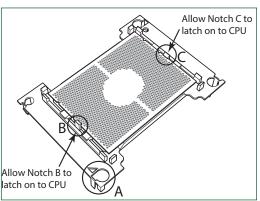
Attaching the Processor to the Narrow Processor Clip to Create the Processor Package Assembly

To properly install the CPU into the narrow processor clip, please follow the steps below.

- 1. Locate pin 1 (notch A), which is the triangle located on the top of the narrow processor clip. Also locate notch B and notch C on the processor clip.
- 2. Locate pin 1 (notch A), which is the triangle on the substrate of the CPU. Also, locate notch B and notch C on the CPU as shown below.
- 3. Align pin 1 (the triangle on the substrate) of the CPU with pin 1 (the triangle) of the narrow processor clip. Once they are aligned, carefully insert the CPU into the processor clip by sliding notch B of the CPU into notch B of the processor clip, and sliding notch C of the CPU into notch C of the processor clip.
- 4. Examine all corners of the CPU to ensure that it is properly seated on the processor clip. Once the CPU is securely attached to the processor clip, the processor package assembly is created.

Note: Please exercise extreme caution when handling the CPU. Do not touch the CPU LGA-lands to avoid damaging the LGA-lands or the CPU. Be sure to wear ESD gloves when handling components.





Processor Package Carrier (w/CPU mounted on the Processor Clip)

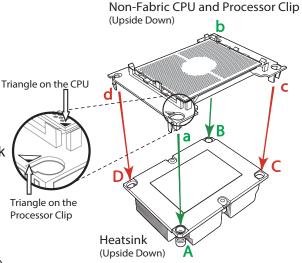
Attaching the Model Processor Package Assembly to the Heatsink to Form the Processor Heatsink Module (PHM)

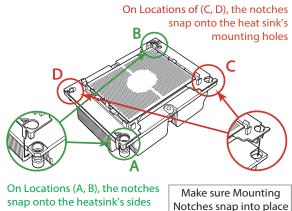
After you have made a processor package assembly by following the instructions on the previous page, please follow the steps below to mount the processor package assembly onto the heatsink to create the Processor Heatsink Module (PHM).

- 1. Locate "1" on the heatsink label and the triangular corner next to it on the heatsink. With your index finger pressing against the screw at this triangular corner, carefully hold and turn the heatsink upside down with the thermal-grease side facing up. Remove the protective thermal film if present, and apply the proper amount of the thermal grease as needed. (Skip this step if you have a new heatsink because the necessary thermal grease is pre-applied in the factory.)
- 2. Holding the processor package assembly at the center edge, turn it upside down. With the thermal-grease side facing up, locate the hollow triangle located at the corner of the processor carrier assembly ("a" in the graphic). Note a larger hole and plastic mounting clips located next to the hollow triangle. Also locate another set of mounting clips and a

larger hole at the diagonal corner of the same (reverse) side of the processor carrier assembly ("b" in the graphic).

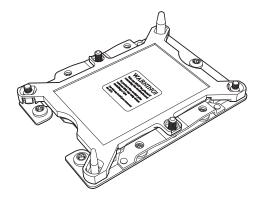
- 3. With the back of the heatsink and the reverse side of the processor package assembly facing up, align the triangular corner on the heatsink ("A" in the graphic) against the mounting clips next to the hollow triangle ("a") on the processor package assembly.
- Also align the triangular corner ("B") at the diagonal side of the heatsink with the corresponding clips on the processor package assembly ("b").
- 5. Once the mounting clips on the processor package assembly are properly aligned with the corresponding holes on the back of heatsink, securely attach the heatsink to the processor package assembly by snapping the mounting clips at the proper places on the heatsink to create the processor heatsink module (PHM).





Preparing the CPU Socket for Installation

This motherboard comes with the CPU socket pre-assembled in the factory. The CPU socket contains 1) a dust cover, 2) a socket bracket, 3) the CPU (P) socket, and 4) a back plate. These components are pre-installed on the motherboard before shipping.



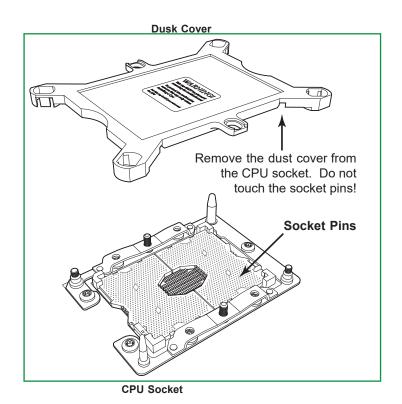
CPU Socket w/Dust Cover On

Removing the Dust Cover from the CPU Socket

Remove the dust cover from the CPU socket, exposing the CPU socket and socket pins as shown on the illustration below.



Note: Do not touch the socket pins to avoid damaging them, causing the CPU to malfunction.

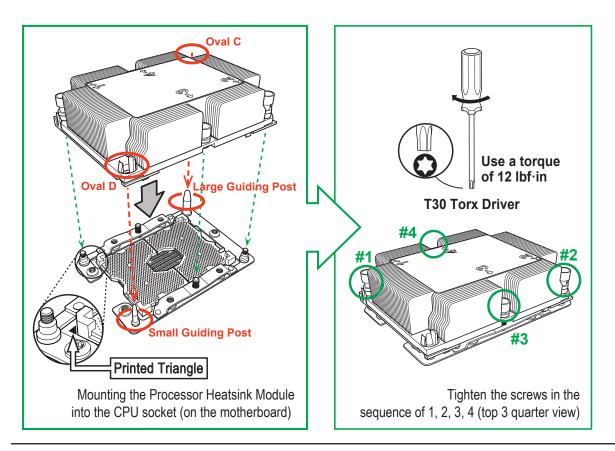


arkanetwork.com

Installing the Processor Heatsink Module (PHM)

- Once you have assembled the processor heatsink module (PHM) by following the
 instructions listed on page 27, you are ready to install the processor heatsink module
 (PHM) into the CPU socket on the motherboard. To install the PHM into the CPU socket,
 follow the instructions below.
- 2. Locate the triangle (pin 1) on the CPU socket, and locate the triangle (pin 1) at the corner of the PHM that is closest to "1." (If you have difficulty locating pin 1 of the PHM, turn the PHM upside down. With the LGA-lands side facing up, you will note the hollow triangle located next to a screw at the corner. Turn the PHM right side up, and you will see a triangle marked on the processor clip at the same corner of hollow triangle.)
- 3. Carefully align pin 1 (the triangle) on the the PHM against pin 1 (the triangle) on the CPU socket.
- 4. Once they are properly aligned, insert the two diagonal oval holes on the heatsink into the guiding posts.
- 5. Using a T30 Torx-bit screwdriver, install four screws into the mounting holes on the socket to securely attach the PHM onto the motherboard starting with the screw marked "1" (in the sequence of 1, 2, 3, and 4).

Note: Do not use excessive force when tightening the screws to avoid damaging the LGA-lands and the processor.

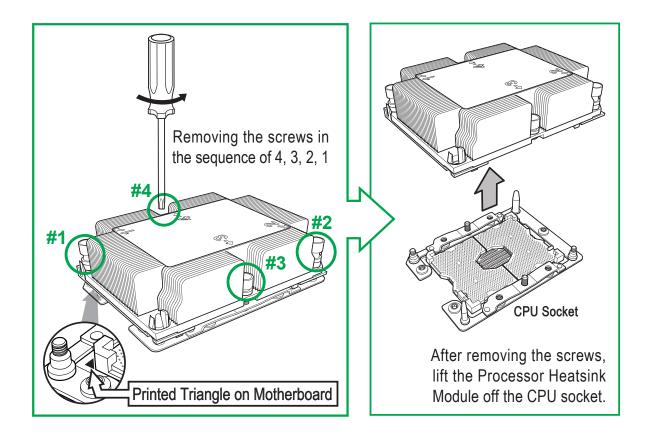


Removing the Processor Heatsink Module (PHM) from the Motherboard

Before removing the processor heatsink module (PHM), unplug the power cord from the power outlet.

- 1. Using a T30 Torx-bit screwdriver, turn the screws on the PHM counterclockwise to loosen them from the socket, starting with screw marked #4 (in the sequence of 4, 3, 2, 1).
- 2. After all four screws are removed, wiggle the PHM gently and pull it up to remove it from the socket.

Note: To properly remove the processor heatsink module, be sure to loosen and remove the screws on the PHM in the sequence of 4, 3, 2, 1 as shown below.



2.4 Memory Support and Installation

Note: Check the Supermicro website for recommended memory modules. Exercise extreme care when installing or removing DIMM modules to prevent any damage.

Memory Support

The motherboard supports up to 4TB of 3DS LRDIMM (3DS Load Reduced DIMM), LRDIMM, NV-DIMM (Non-Volatile DIMM), and RDIMM (Registered DIMM), DDR4 (288-pin), ECC 2933*/2666/2400/2133 MHz memory in 16 slots (*Note 1 below). The black DIMM slots are reserved for future NV-DIMM support. Populating these DIMM modules with memory modules of the same type and size will result in interleaved memory, which will improve memory performance. This motherboard also supports up to 5TB memory with DCPMM modules installed based on the DCPMM population table on "DCPMM Memory Population Tables for 2nd Gen Intel Xeon Scalable-SP Processors" on page 35.



Notes: **1.** 2933 MHz memory is supported by 2nd Generation Intel Xeon Scalable-SP (82xx/62xx series) processors only. **2.** Populating DDR4 memory modules in a two-DIMMs per-channel (2DPC) configuration on this motherboard will affect memory bandwidth and performance.

Memory Installation Sequence

Memory modules for this motherboards are populated using the "Fill First" method. The blue memory slot of each channel is considered the "first DIMM module" of the channel, and the black slot, the second module of the channel. When installing memory modules, be sure to populate the blue memory slots first and then populate the black slots. To maximize memory capacity, please populate all DIMM slots on the motherboard, including all blue slots and black slots.

General Memory Population Requirements

- 1. Be sure to use the memory modules of the same type and speed on the motherboard Mixing of memory modules of different types and speeds is not allowed.
- 2. Using unbalanced memory topology such as populating two DIMMs in one channel while populating one DIMM in another channel on the same motherboard will result in reduced memory performance.
- 3. Populating memory slots with a pair of DIMM modules of the same type and size will result in interleaved memory, which will improve memory performance.

A. DDR4 Memory Support for Intel Xeon Scalable-SP Processors

	DDR4 Memory Support									
		DIMM Capacity (GB)		Speed (MT/s); Voltage (V); Slots Per Channel (SPC) and DIMMs Per Channel (DPC)						
T	Ranks Per			1 Slot Per Channel	2 Slots Pe	r Channel				
Туре	DIMM & Data Width	DRAM Density		1DPC (1-DIMM Per Channel)	1DPC (1-DIMM Per Channel)	2DPC (2-DIMM Per Channel)				
		4Gb*	8Gb	1.2 V	1.2 V	1.2 V				
RDIMM	SRx4	4GB	8GB	2666	2666	2666				
RDIMM	SRx8	8GB	16GB	2666	2666	2666				
RDIMM	DRx8	8GB 16GB		2666	2666	2666				
RDIMM	DRx4	16GB	32GB	2666	2666	2666				
RDIMM 3Ds	QRX4	N/A	2H-64GB	2666	2666	2666				
RDIMM 3Ds	8RX4	N/A	4H-128GB	2666	2666	2666				
LRDIMM	QRx4	32GB	64GB	2666	2666	2666				
LRDIMM 3Ds	QRX4	N/A	2H-64GB	2666	2666	2666				
LRDIMM 3Ds	8Rx4	N/A	4H-128GB	2666	2666	2666				

B. DDR4 Memory Support for 2nd Gen Intel Xeon Scalable-SP Processors

DDR4 Memory Support										
	Ranks	DIMM Capacity (GB)			Speed (MT/s); Voltage (V); Slots Per Channel (SPC) and DIMMs Per Channel (DPC)					
T	Per DIMM				1 Slot Per Channel	2 Slots F	Per Channel			
Type	& Data Width	DRAM Density			1DPC (1-DIMM Per Channel)	1DPC (1-DIMM Per Channel)	2DPC (2-DIMM Per Channel)			
		4Gb*	8Gb	16Gb	1.2 V	1.2 V	1.2 V			
RDIMM	SRx4	4GB	8GB	16GB	2933	2933	2933			
RDIMM	SRx8	8GB	8GB 16GB		2933	2933	2933			
RDIMM	DRx8	8GB	8GB 16GB 3		2933	2933	2933			
RDIMM	DRx4	16GB	16GB 32GB		2933	2933	2933			
RDIMM 3Ds	QRX4	N/A	2H-64GB	2H-128GB	2933	2933	2933			
RDIMM 3Ds	8RX4	N/A	4H-128GB	4H-256GB	2933	2933	2933			
LRDIMM	QRx4	32GB	32GB 64GB		2933	2933	2933			
LRDIMM 3Ds	QRX4	N/A	N/A 2H-64GB 2H-128GE		2933	2933	2933			
LRDIMM 3Ds	8Rx4	N/A	4H-128GB	4H-256GB	2933	2933	2933			



Notes: **1.** 2933 MHz memory support in two-DIMMs per-channel (2DPC) configuration can be achieved by using memory purchased from Supermicro. **2.** 2933 MHz memory is supported by 2nd Gen Intel Xeon Scalable-SP (82xx/62xx series) processors only.



DIMM Population Guidelines for Optimal Performance

For optimal memory performance, follow the instructions listed in the tables below when populating memory modules.

Key Parameters for DIMM Configuration

Key Parameters for DIMM Configurations							
Parameters	Possible Values						
Number of Channels	1, 2, 3, 4, 5, or 6						
Number of DIMMs per Channel	1DPC (1 DIMM Per Channel) or 2DPC (2 DIMMs Per Channel)						
DIMM Type	RDIMM (w/ECC), 3DS RDIMM, LRDIMM, 3DS LRDIMM						
DIMM Construction	 non-3DS RDIMM Raw Cards: A/B (2Rx4), C (1Rx4), D (1Rx8), E (2Rx8) 						
	3DS RDIMM Raw Cards: A/B (4Rx4)						
	 non-3DS LRDIMM Raw Cards: D/E (4Rx4) 						
	3DS LRDIMM Raw Cards: A/B (8Rx4)						

DIMM Mixing Guidelines

General DIMM Mixing Guidelines

DIMM Mixing Rules

- All DIMMs must be all DDR4 DIMMs.
- x4 and x8 DIMMs can be mixed in the same channel.
- Mixing of LRDIMMs and RDIMMs is not allowed in the same channel, across different channels, and across different sockets.
- Mixing of non-3DS and 3DS LRDIMM is not allowed in the same channel, across different channels, and across different sockets.

Mixing of DIMM Types within a Channel									
DIMM Types RDIMM LRDIMM 3DS LRDIMM									
RDIMM	Allowed	Not Allowed	Not Allowed						
LRDIMM	Not Allowed	Allowed	Not Allowed						
3DS LRDIMM	Not Allowed	Not Allowed	Allowed						

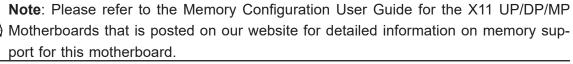


DIMM Population Table

Note. Unbalanced memory configuration decreases memory performance and is not recommended for Supermicro motherboards.

Memory Population Table for Intel Xeon Scalable-SP and 2nd Gen Intel Xeon Scalable-SP Processors

Memory Popu	Memory Population Table for the X11DP Motherboard w/16 DIMM Slots Onboard						
When 1 CPU is used:	Memory Population Sequence						
1 CPU & 1 DIMM	CPU1: P1-DIMMA1						
1 CPU & 2 DIMMs	CPU1: P1-DIMMA1/P1-DIMMD1						
1 CPU & 3 DIMMs	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1						
1 CPU & 4 DIMMs	CPU1: P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1						
1 CPU & 5 DIMMs (Unbalanced: not recommended)	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1						
1 CPU & 6 DIMM	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1						
1 CPU & 7 DIMMs (Unbalanced: not recommended)	CPU1:P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMA2/P1-DIMMD1/P1-DIMME1/P1-DIMMF1						
1 CPU & 8 DIMMs (Unbalanced: not recommended)	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMA2/P1-DIMMD2/P1-DIMMD1/P1-DIMME1/P1-DIMMF1						
When 2 CPUs are used:	Memory Population Sequence						
2 CPUs & 2 DIMMs	CPU1: P1-DIMMA1 CPU2: P2-DIMMA1						
2 CPUs & 4 DIMMs	CPU1: P1-DIMMA1/P1-DIMMD1 CPU2: P2-DIMMA1/P2-DIMMD1						
2 CPUs & 6 DIMMs	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1 CPU2: P2-DIMMC1/P2-DIMMB1/P2-DIMMA1						
2 CPUs & 8 DIMMs	CPU1: P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1 CPU2: P2-DIMMB1/P2-DIMMA1/P2-DIMMD1/P2-DIMME1						
2 CPUs & 10 DIMMs	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1 CPU2: P2-DIMMB1/P2-DIMMA1/P2-DIMMD1/P2-DIMME1						
2 CPUs & 12 DIMMs	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1 CPU2: P2-DIMMC1/P2-DIMMB1/P2-DIMMA1/P2-DIMMD1/P2-DIMME1/P2-DIMMF1						
2 CPUs & 14 DIMMs (Unbalanced: not recommended)	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMA2/P1-DIMMD1/P1-DIMME1/P1-DIMMF1 CPU2: P2-DIMMC1/P2-DIMMB1/P2-DIMMA1/P2-DIMMA2/P2-DIMMD1/P2-DIMME1/P2-DIMMF1						
2 CPUs & 16 DIMMs (Unbalanced: not recommended)	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMA2/P1-DIMMD2/P1-DIMMD1/P1-DIMME1/P1-DIMMF1 CPU2: P2-DIMMC1/P2-DIMMB1/P2-DIMMA1/P2-DIMMA2/P2-DIMMD2/P2-DIMMD1/P2-DIMME1/P2-DIMMF1						





DCPMM Memory Population Tables for 2nd Gen Intel Xeon Scalable-SP Processors

11000	<u> </u>											
	Symmetric Population within 1 CPU Socket											
Modes P1-DIMMF1 P1-DIMME1 P1-DIMMD1 P1-DIMMD2 P1-DIMMA2 P1-DIMMA1 P1-DIMMB1 P1-DIMMC1 Channel C												
AD	DRAM1	DRAM1	DRAM1	DCPMM	DCPMM	DRAM1	DRAM1	DRAM1	2-1-1			
MM	DRAM2	DRAM2	DRAM2	DCPMM	DCPMM	DRAM2	DRAM2	DRAM2	2-1-1			
AD + MM	DRAM3	DRAM3	DRAM3	DCPMM	DCPMM	DRAM3	DRAM3	DRAM3	2-1-1			
AD	DCPMM	DRAM1	DRAM1	-	-	DRAM1	DRAM1	DCPMM	1-1-1			
ММ	DCPMM	DRAM1	DRAM1	-	-	DRAM1	DRAM1	DCPMM	1-1-1			
AD + MM	DCPMM	DRAM3	DRAM3	-	-	DRAM3	DRAM3	DCPMM	1-1-1			

	Asymmetric Population within 1 CPU Socket										
Modes	Modes P1-DIMMF1 P1-DIMME1 P1-DIMMD1 P1-DIMMD2 P1-DIMMA2 P1-DIMMA1 P1-DIMMB1 P1-DIMMC1 Channel Config										
AD	DRAM1	DRAM1	DRAM1	-	DCPMM	DRAM1	DRAM1	DRAM1	2-1-1		
AD*	DRAM1	DRAM1	DRAM1	-	DCPMM	DRAM1	DRAM1	DRAM1	2-1-1		

Legend (for the two tables above)									
		Capacity							
DRAM1	RDIMM	3DS RDIMM	LRDIMM	3DS LRDIMM	Refer to Validation Matrix (DDR4 DIMMs validated with DCPMM) below.				
DRAM2	RDIMM	-	-	-					
DRAM3	RDIMM	3DS RDIMM	LRDIMM	-					

 \mathbb{N}

Note: DDR4 single rank x8 is not available for DCPMM Memory Mode or App-Direct Mode.

Legend						
(for the first two tables above)						
Capacity						
DCPMM	DCPMM Any Capacity (Uniformly for all channels for a given configuration)					

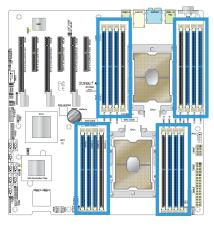
- * 2nd socket has no DCPMM DIMM
- For MM, general NM/FM ratio is between 1:4 and 1:16. Excessive capacity for FM can be used for AD. (NM = Near Memory; FM = Far Memory)
- For each individual population, rearrangements between channels are allowed as long as the resulting population is compliant with the memory rules for 2nd Gen Intel Xeon Scalable-SP (82xx/62xx/52xx/42xx series) processors.
- For each individual population, please use the same DDR4 DIMM in all slots.
- For each individual population, sockets are normally symmetric with exceptions for 1 DCPMM per socket and 1 DCPMM per node case. Currently, DCPMM modules operate at 2666 MHz.
- No mixing of DCPMM and NVMDIMMs within the same platform is allowed.
- These DCPMM population tables target a balanced DCPMM-to-DRAM-cache ratio in MM and MM + AD modes.

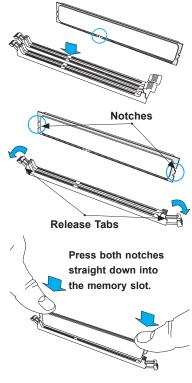
Validation Matrix (DDR4 DIMMs Validated w/DCPMM)							
	Ranks Per DIMM	DIMM Capacity (GB)					
DIMM Type	& Data Width	DRAM Density					
	(Stack)	4Gb	8Gb				
	1Rx4	8GB	16GB				
RDIMM	2Rx8	8GB	16GB				
	2Rx4	16GB	32GB				
LRDIMM	4Rx4	N/A	64GB				
LRDIMM 3DS	8Rx4 (4H)	N/A	128GB				



DIMM Installation

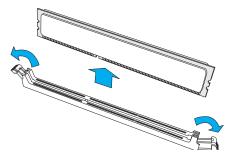
- Follow the instructions listed in the previous section to properly install the DIMM modules in the motherboard. Use memory modules of the same type and speed on the motherboard for the system to work properly.
- 2. Push the release tabs outwards on both ends of the DIMM slot to unlock it.
- 3. Align the key of the DIMM module with the receptive point on the memory slot.
- Align the notches on both ends of the module against the receptive points on the ends of the slot.
- 5. Use two thumbs together to press on both ends of the module straight down into the slot until the module snaps into place.
- Press the release tabs to the lock positions to secure the DIMM module into the slot.







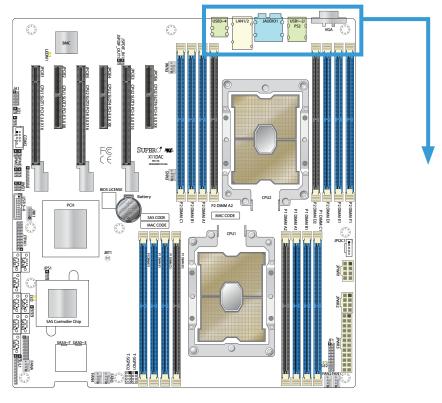
Press the release tabs on both ends of the DIMM socket to release the DIMM module from the socket as shown in the drawing on the right.



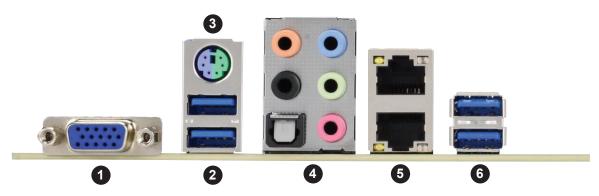
Warnings: 1. Please do not use excessive force when pressing the release tabs on the ends of the DIMM socket to avoid causing any damage to the DIMM module or the DIMM socket. 2. Please handle DIMM modules with care. Carefully follow all the instructions given on Page 1 of this chapter to prevent ESD-related damages to your memory modules or components.

2.5 Rear I/O Ports

See the layout below for the locations and descriptions of the various I/O ports on the rear of the motherboard.



Back panel I/O Port Locations and Definitions



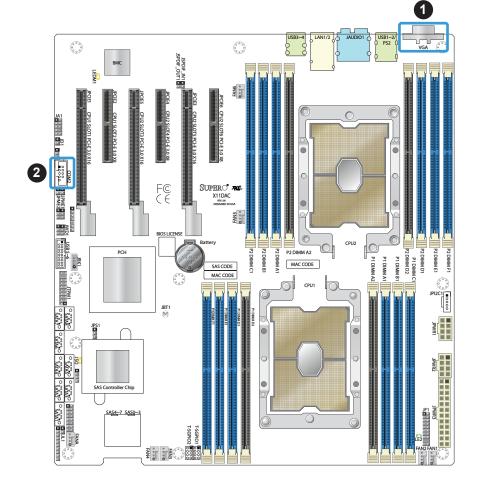
Back Panel I/O Ports			
No.	Description		
1.	VGA		
2.	USB 1/2 (USB 3.0)		
3.	PS2		
4.	AUDIO1		
5.	LAN1/2		
6.	USB 3/4 (USB 3.0)		

VGA Port

The onboard VGA port is located next to IPMI LAN port on the I/O back panel. Use this connection for VGA display.

Serial Port

There is one COM header (COM2) on the motherboard. The COM port header provides serial communication support. See the table below for pin definitions.



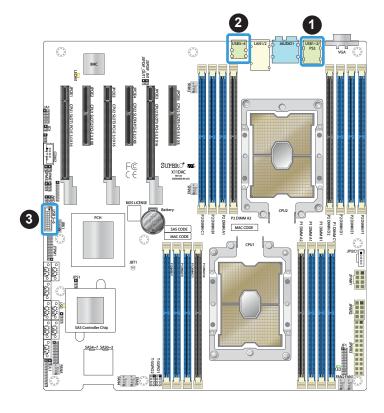
- 1. VGA Port
- 2. COM2

Universal Serial Bus (USB) Ports

There are four USB 3.0 ports (USB1/2, 3/4) on the I/O back panel and one USB 3.0 header that provides two USB connections (USB5/6) for front access. The onboard headers can be used to provide front side USB access with a cable (not included).

Back Panel USB 1/2,3/4 (3.0) Pin Definitions				
Pin#	Definition	Pin#	Definition	
1	VBUS	10	Power	
2	D- 11		USB 2.0 Differential Pair	
3	D+	12		
4	Ground	13	Ground of PWR Return	
5	StdA_SSRX-	14	SuperSpeed Receiver	
6	StdA_SSRX+	15	Differential Pair	
7	GND_DRAIN	16	Ground for Signal Return	
8	StdA_SSTX-	17	SuperSpeed Transmitter	
9	StdA_SSTX+	18	Differential Pair	

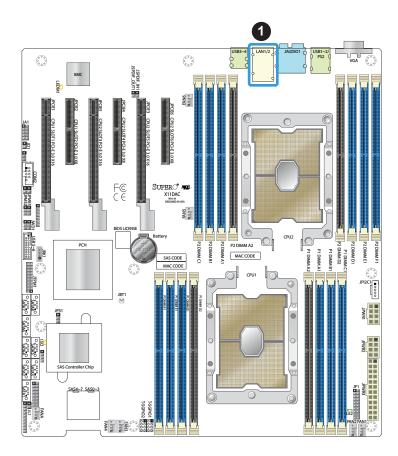
Front Panel USB 5/6 (3.0) Pin Definitions				
Pin#	Definition	Pin#	Definition	
1	VBUS	11	IntA_P2_D+	
2	IntA_P1_SSRX-	12	IntA_P2_D-	
3	IntA_P1_SSRX+	13	GND	
4	GND	14	IntA_P2_SSTX+	
5	IntA_P1_SSTX-	15	IntA_P2_SSTX-	
6	IntA_P1_SSTX+	16	GND	
7	GND	17	IntA_P2_SSRX+	
8	IntA_P1_D-	18	IntA_P2_SSRX-	
9	IntA_P1_D+	19	VBus	
10	ID			



- 1. USB1/2 (3.0)
- 2. USB3/4 (3.0)
- 3. USB5/6 (3.0)

Ethernet Ports

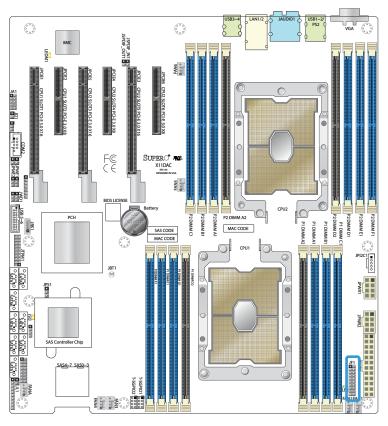
Two Ethernet ports (LAN1, LAN2) are located on the I/O backplane. These Ethernet ports support 1 GbE LAN connections on the X11DAC. All Ethernet ports accept RJ45 type cables. Please refer to the LED Indicator Section for LAN LED information.



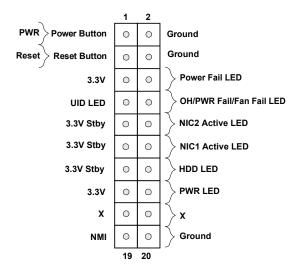
1. LAN 1/2

2.6 Front Control Panel

JF1 contains header pins for various buttons and indicators that are normally located on a control panel at the front of the chassis. These connectors are designed specifically for use with Supermicro chassis. See the figure below for the descriptions of the front control panel buttons and LED indicators.



JF1 Header Pins



Power Button

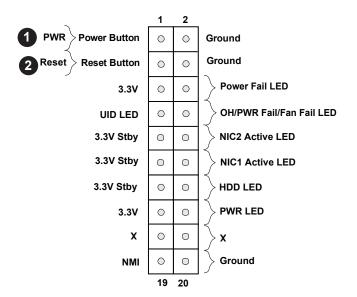
The Power Button connection is located on pins 1 and 2 of JF1. Momentarily contacting both pins will power on/off the system. This button can also be configured to function as a suspend button (with a setting in the BIOS - see Chapter 4). To turn off the power when the system is in suspend mode, press the button for 4 seconds or longer. Refer to the table below for pin definitions.

Power Button Pin Definitions (JF1)			
Pins	Definition		
1	Signal		
2	? Ground		

Reset Button

The Reset Button connection is located on pins 3 and 4 of JF1. Attach it to a hardware reset switch on the computer case to reset the system. Refer to the table below for pin definitions.

Reset Button Pin Definitions (JF1)		
Pins	Definition	
3	Reset	
4 Ground		



- 1. PWR Button
- 2. Reset Button

Power Fail LED

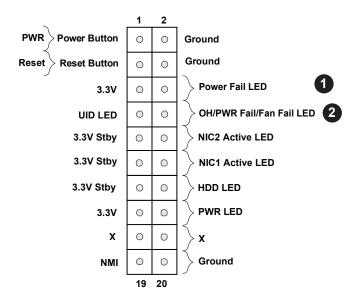
The Power Fail LED connection is located on pins 5 and 6 of JF1. Refer to the table below for pin definitions.

Power Fail LED Pin Definitions (JF1)		
Pin# Definition		
5	3.3V	
6 PWR Supply Fail		

OH/Fan Fail/PWR Fail/UID LED

Connect an LED cable to pins 7 and 8 of the Front Control Panel (JF1) to use UID/Overheat/ Fan Fail/Power Fail LED connections. The LED on pin 8 provides warnings of overheat, power failure or fan failure. Refer to the tables below for details.

Information LED-UID/OH/PWR Fail/Fan Fail LED Pin Definitions (Pin 7 & Pin 8 of JF1)			
Status	Description		
Solid red	An overheat condition has occurred. (This may be caused by cable congestion).		
Blinking red (1Hz)	Fan failure: check for an inoperative fan.		
Blinking red (0.25Hz)	Power failure: check for a non-operational power supply		
Solid blue	Local UID is activated. Use this function to locate a unit in a rack mount environment that might be in need of service.		
Blinking blue (300 msec)	Remote UID is on. Use this function to identify a unit from a remote location that might be in need of service.		



- 1. Power Fail LED
- 2. UID/OH/PWR Fail/Fan Fail LED

NIC1/NIC2 (LAN1/LAN2)

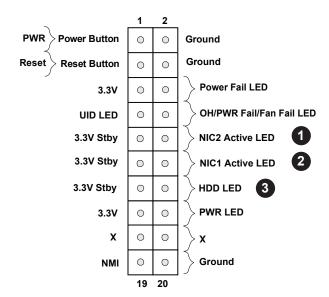
The NIC (Network Interface Controller) LED connection for LAN port 1 is located on pins 11 and 12 of JF1, and LAN port 2 is on pins 9 and 10. Attach the NIC LED cables here to display network activity. Refer to the table below for pin definitions.

LAN1/LAN2 LED Pin Definitions (JF1)		
Pin#	Definition	
9	NIC 2 Activity LED	
11	NIC 1 Activity LED	

HDD LED

The HDD LED connection is located on pins 13 and 14 of JF1. Attach a cable to pin 14 to show hard drive activity status. Refer to the table below for pin definitions.

HDD LED Pin Definitions (JF1)		
Pins Definition		
13	3.3V Stdby	
14	HDD Active	



- 1. NIC2 LED
- 2. NIC1 LED
- 3. HDD LED

Power LED

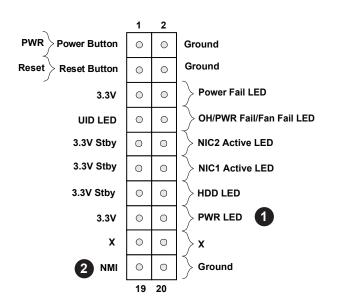
The Power LED connection is located on pins 15 and 16 of JF1. Refer to the table below for pin definitions.

Power LED Pin Definitions (JF1)		
Pins	Definition	
15	3.3V	
16	PWR LED	

NMI Button

The non-maskable interrupt (NMI) button header is located on pins 19 and 20 of JF1. Refer to the table below for pin definitions.

NMI Button Pin Definitions (JF1)		
Pins Definition		
19	Control	
20	Ground	



- 1. PWR LED
- 2. NMI

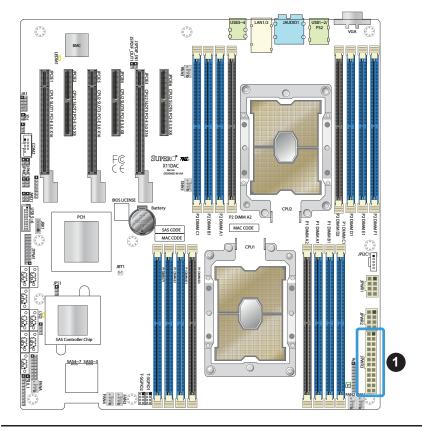
2.7 Connectors

Power Connector

ATX and CPU Power Connectors

JPWR3 is the 24-pin ATX main power supply connector. This primary power supply connector meets the ATX SSI EPS 24-pin specification. You must also connect the 8-pin (JPWR1/JPWR2) CPU power connectors to your power supply.

ATX Power 24-pin Connector Pin Definitions			
Pin#	Pin# Definition		Definition
13	+3.3V	1	+3.3V
14	NC	2	+3.3V
15	Ground	3	Ground
16	PS_ON	4	+5V
17	Ground	5	Ground
18	Ground	6	+5V
19	Ground	7	Ground
20	Res (NC)	8	PWR_OK
21	+5V	9	5VSB
22	+5V	10	+12V
23	+5V	11	+12V
24	Ground	12	+3.3V

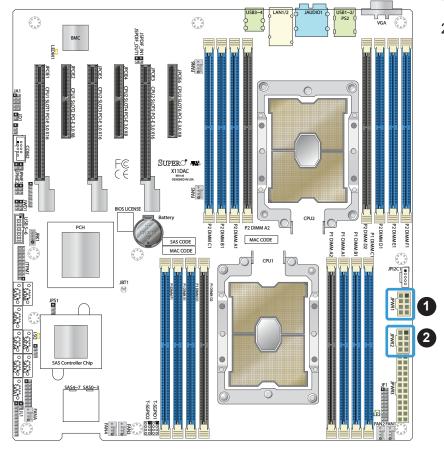


1. ATX Power Supply

12V 8-pin CPU Power Connectors

JPWR1 and JPWR2 are the 8-pin 12V DC power input for the CPU or alternative single power source for a special enclosure when the 24-pin ATX power is not in use. Refer to the table below for pin definitions.

12V 8-pin Power Pin Definitions		
Pin#	Pin# Definition	
1 - 4	Ground	
5 - 8	+12V	



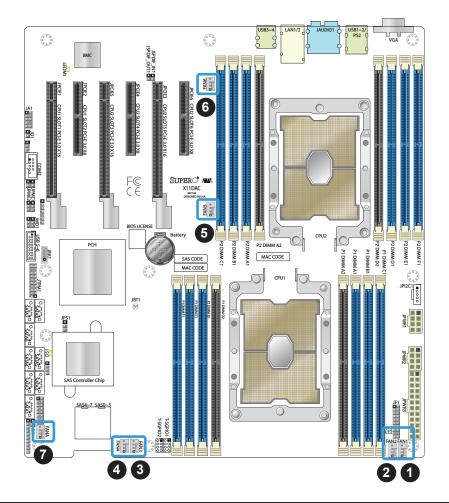
- 1. JPWR1
- 2. JPWR2

Headers

Onboard Fan Header

Seven 4-pin fan headers (FAN1~6, FANA) are located on the motherboard to provide CPU/ system cooling. These fan headers support both 3-pin fans and 4-pin fans; however, onboard fan speed control is available only when all 4-pin fans are used in the motherboard. Onboard fan speeds are controlled by thermal management via the BMC (or by IPMI). See the table below for pin definitions.

Fan Header Pin Definitions		
Pin# Definition		
1	Ground (Black)	
2	+12V (Red)	
3	Tachometer	
4	PWM Control	

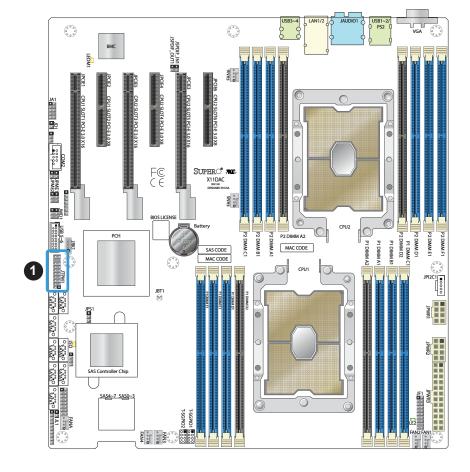


- 1. FAN1
- 2. FAN2
- 3. FAN3
- 4. FAN4
- 5. FAN5
- 6. FAN6
- 7. FANA

TPM Header

The JTPM1 header is used to connect a Trusted Platform Module (TPM)/Port 80, which is available from SMCI (optional). A TPM/Port 80 connector is a security device that supports encryption and authentication in hard drives. It allows the motherboard to deny access if the TPM associated with the hard drive is not installed in the system. See the layout below for the location of the TPM header.





VROC RAID Key Header

A VROC RAID Key header is located at JRK1 on the motherboard. The RAID key is used to support NVMe SSD.

Intel VROC RAID Key Pin Definitions		
Pin# Definition		
1	Ground	
2	3.3V Standby	
3	Ground	
4	PCH VROC RAID Key	

SGPIO Headers

The T-SGPIO1 and T-SGPIO2 (Serial General Purpose Input/Output) headers are used to communicate with the enclosure management chip on the backplane.

SGPIO Header Pin Definitions			
Pin#	Definition	Pin#	Definition
1	NC	2	NC
3	Ground	4	DATA Out
5	Load	6	Ground
7	Clock	8	NC

NC = No Connection

- AND COLORS SECOND STATE OF THE STATE OF THE
- 1. T-SGPIO1
- 2. T-SGPIO2

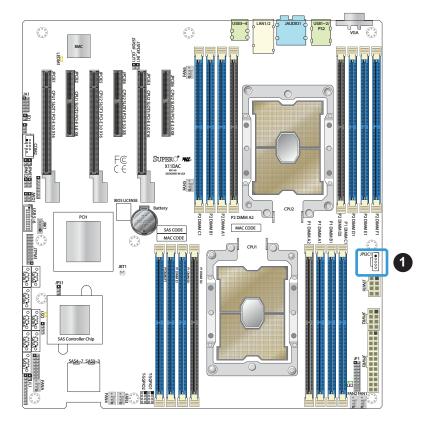


Power SMBus (I²C) Header

The Power System Management Bus (I²C) connector (JPI²C1) monitors the power supply, fan, and system temperatures. Refer to the table below for pin definitions.

Power SMBus Header Pin Definitions		
Pin# Definition		
1	Clock	
2	Data	
3	PMBUS_Alert	
4	Ground	
5	+3.3V	

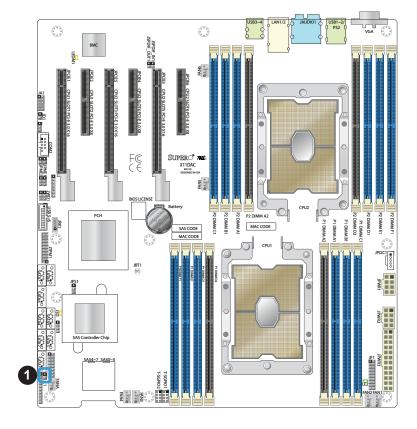
1. Power SMBus Header



Chassis Intrusion

A Chassis Intrusion header is located at JL1 on the motherboard. Connect an appropriate cable from JL1 to the chassis so that you can be informed of a chassis intrusion (via IPMI). Refer to the table below for pin definitions.

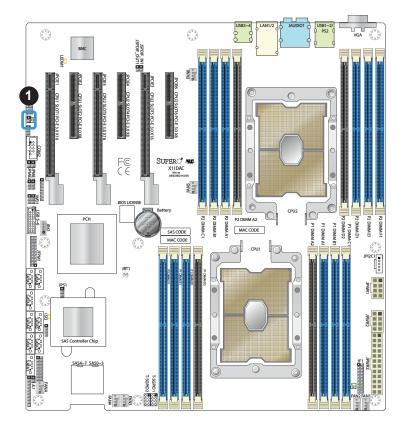
Chassis Intrusion Pin Definitions	
Pin# Definition	
1	Intrusion Input
2	Ground



1. Chassis Intrusion

Speaker Header

A speaker header is located on JD1. Close pins 1-2 of JD1 to use the onboard speaker. See the layout below for JD1 location.

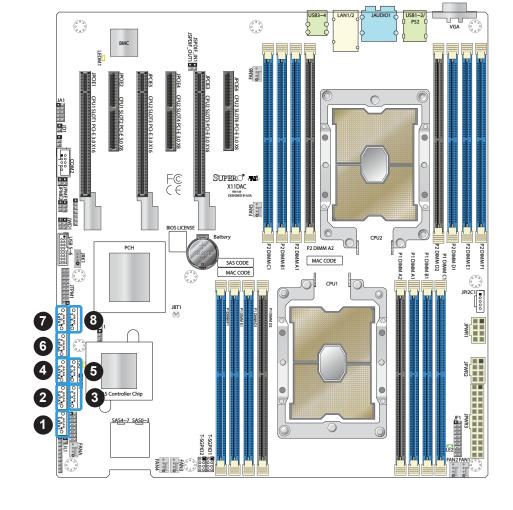


1. Speaker Header (JD1)

2.8 SATA/SAS Connections

SATA 3.0 Ports

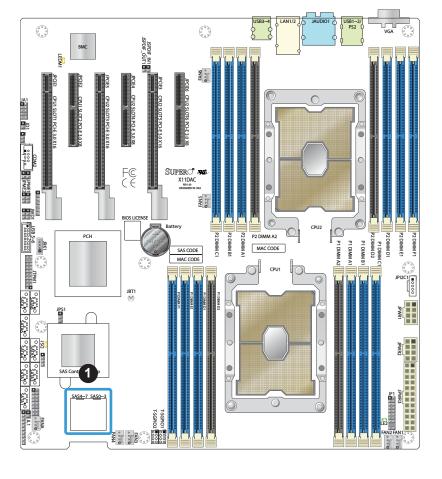
The X11DAC has eight SATA 3.0 ports (SATA0-3, SATA4-7) supported by the Intel PCH C621 chipset. These SATA ports provide serial-link signal connections that are faster than the connections of Parallel ATA.



- 1.SATA1
- 2.SATA2
- 3.SATA3
- 4.SATA4
- 5.SATA5
- 6.SATA6
- 7.SATA7
- 8.SATA8

SAS Ports

Two mini SAS HD ports offer eight SAS connections (SAS 0-3/SAS 4-7) supported by the LSI 3008 SAS controller. All SAS ports provide point-to-point serial signal connections that are faster than the connections of Parallel SCSI.



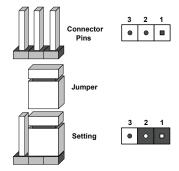
1. SAS 0~3, SAS 4~7

2.9 Jumper Settings

How Jumpers Work

To modify the operation of the motherboard, jumpers can be used to choose between optional settings. Jumpers create shorts between two pins to change the function of the connector. Pin 1 is identified with a square solder pad on the printed circuit board. See the diagram at right for an example of jumping pins 1 and 2. Refer to the motherboard layout page for jumper locations.

Note: On two-pin jumpers, "Closed" means the jumper is on and "Open" means the jumper is off the pins.



CMOS Clear

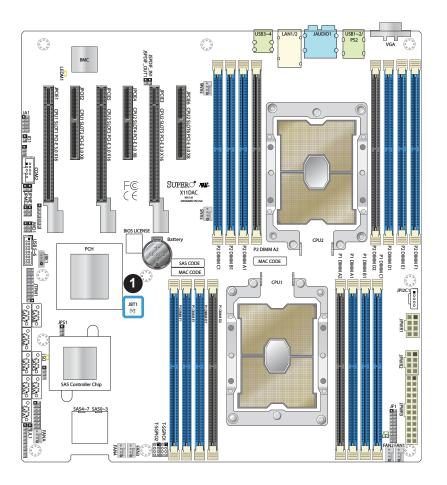
JBT1 is used to clear CMOS, which will also clear any passwords. Instead of pins, this jumper consists of contact pads to prevent accidentally clearing the contents of CMOS.

To Clear CMOS

- 1. First power down the system and unplug the power cord(s).
- 2. Remove the cover of the chassis to access the motherboard.
- 3. Remove the onboard battery from the motherboard.
- 4. Short the CMOS pads with a metal object such as a small screwdriver for at least four seconds.
- 5. Remove the screwdriver (or shorting device).
- 6. Replace the cover, reconnect the power cord(s), and power on the system.

Note: Clearing CMOS will also clear all passwords.

Do not use the PW ON connector to clear CMOS.





1. Clear CMOS



Management Engine (ME) Recovery

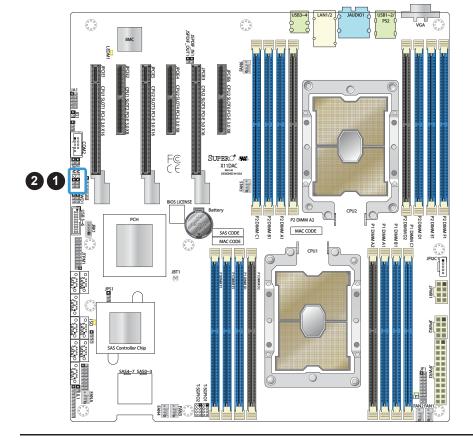
Use jumper JPME1 to select ME Firmware Recovery mode, which will limit resource allocation for essential system operation only in order to maintain normal power operation and management. In the single operation mode, online upgrade will be available via Recovery mode. See the table below for jumper settings.

Manufacturer Mode Jumper Settings		
Jumper Setting Definition		
Pins 1-2	Normal	
Pins 2-3 ME Recovery		

Manufacturing Mode Select

Close JPME2 to bypass SPI flash security and force the system to use the Manufacturing Mode, which will allow you to flash the system firmware from a host server to modify system settings. See the table below for jumper settings.

Manufacturing Mode Select Jumper Settings		
Jumper Setting	Definition	
Pins 1-2	Normal (Default)	
Pins 2-3	Manufacturing Mode	



- 1. ME Recovery
- 2. Manufacturing Mode Select

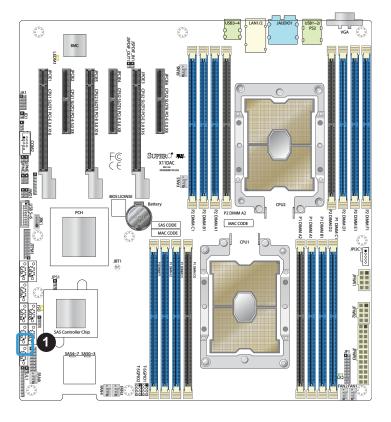


Watch Dog Timer

JWD1 controls the Watch Dog function. Watch Dog is a monitor that can reboot the system when a software application hangs. Jumping pins 1-2 will cause Watch Dog to reset the system if an application hangs. Jumping pins 2-3 will generate a non-maskable interrupt signal for the application that hangs. Watch Dog must also be enabled in BIOS. The default setting is Reset.

Note: When Watch Dog is enabled, the user needs to write their own application software to disable it.

Watch Dog Jumper Settings		
Jumper Setting Definition		
Pins 1-2	Reset	
Pins 2-3	NMI	
Open Disabled		

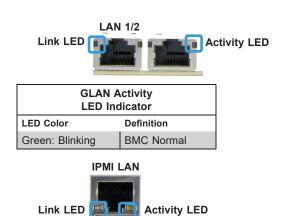


1. Watch Dog

2.10 LED Indicators

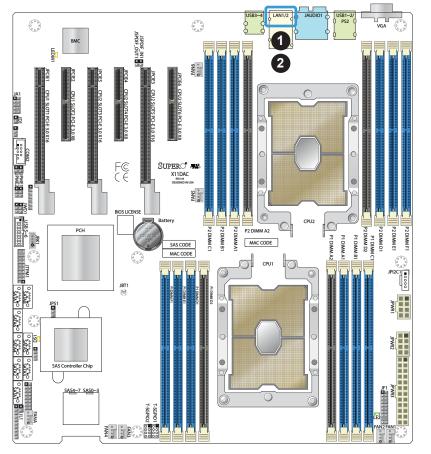
LAN LEDs

The LAN ports are located on the IO Backplane on the motherboard. Each Ethernet LAN port has two LEDs. The yellow LED indicates activity. Link LED, located on the left side of the LAN port, may be green, amber or off, indicating the speed of the connection. See the tables at right for more information.



LAN Connection LED		
LED Color	Definition	
Off	No Connection, 10 Mbps or 100 Mbps	
Amber	1 Gbps	

IPMI LAN Activity LED		
LED Color/State Definition		
Link (left)	Green: Solid	100 Mbps
Activity (Right)	Amber: Blinking	Active



- 1. LAN1/LAN2 LEDs
- 2. IPMI LAN LEDs



BMC Heartbeat LED

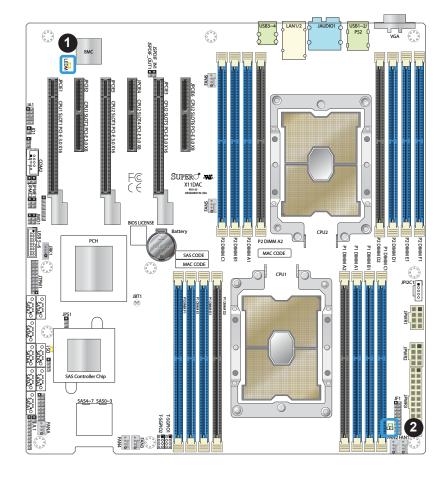
LEDM1 is the BMC heartbeat LED. When the LED is blinking green, BMC is functioning normally. See the table below for the LED status.

Onboard Power LED Indicator		
LED Color	Definition	
Green: Blinking	BMC Normal	

Onboard Power LED

The Onboard Power LED is located at LE2 on the motherboard. When this LED is on, the system is on. Be sure to turn off the system and unplug the power cord before removing or installing components. Refer to the table below for more information.

Onboard Power LED Indicator	
LED Color	Definition
Off	System Off (power cable not connected)
Green	System On



- 1. BMC Heartbeat LED
- 2. Onboard Power LED

Chapter 3

Troubleshooting

3.1 Troubleshooting Procedures

Use the following procedures to troubleshoot your system. If you have followed all of the procedures below and still need assistance, refer to the 'Technical Support Procedures' and/ or 'Returning Merchandise for Service' section(s) in this chapter. Always disconnect the AC power cord before adding, changing or installing any non hot-swap hardware components.

Before Power On

- 1. Check that the power LED on the motherboard is on.
- 2. Make sure that the power connector is connected to your power supply.
- 3. Make sure that no short circuits exist between the motherboard and chassis.
- 4. Disconnect all cables from the motherboard, including those for the keyboard and mouse.
- 5. Remove all add-on cards.
- 6. Install a CPU, a heatsink*, and connect the internal speaker and the power LED to the motherboard. Check all jumper settings as well. (Make sure that the heatsink is fully seated.)
- 7. Use the correct type of onboard CMOS battery as recommended by the manufacturer. To avoid possible explosion, do not install the CMOS battery upside down.

No Power

- 1. Make sure that no short circuits exist between the motherboard and the chassis.
- 2. Verify that all jumpers are set to their default positions.
- 3. Check that the 115V/230V switch on the power supply is properly set.
- 4. Turn the power switch on and off to test the system.
- 5. The battery on your motherboard may be old. If it is too old, replace it with a new one.

No Video

- 1. If the power is on but you have no video, remove all the add-on cards and cables.
- 2. Use the speaker to determine if any beep codes exist. Refer to Appendix A for details on beep codes.

System Boot Failure

If the system does not display POST (Power-On-Self-Test) or does not respond after the power is turned on, check the following:

- 1. Check for any error beep from the motherboard speaker.
- If there is no error beep, try to turn on the system without DIMM modules installed. If there is still no error beep, replace the motherboard.
- If there are error beeps, clear the CMOS settings by unplugging the power cord and contacting both pads on the CMOS Clear Jumper (JBT1). Refer to chapter 2.
- 2. Remove all components from the motherboard, especially the DIMM modules. Make sure that system power is on and that memory error beeps are activated.
- Turn on the system with only one DIMM module installed. If the system boots, check for bad DIMM modules or slots by following the Memory Errors Troubleshooting procedure in this Chapter.

Memory Errors

- 1. Make sure that the DIMM modules are properly and fully installed.
- Confirm that you are using the correct memory. Also, it is recommended that you use
 the same memory type and speed for all DIMMs in the system. <u>See Section 2.4 for
 memory details</u>.
- 3. Check for bad DIMM modules or slots by swapping modules between slots and noting the results.
- 4. Check the power supply voltage 115V/230V switch.



Losing the System's Setup Configuration

- Make sure that you are using a high quality power supply. A poor quality power supply
 may cause the system to lose the CMOS setup information. Refer to Section 1.6 for
 details on recommended power supplies.
- 2. The battery on your motherboard may be old. If it is too old, replace it with a new one.
- 3. If the above steps do not fix the setup configuration problem, contact your vendor for repairs.

When the System Becomes Unstable

A. If the system becomes unstable during or after OS installation, check the following:

- 1. CPU/BIOS support: Make sure that your CPU is supported and that you have the latest BIOS installed in your system.
- 2. Memory support: Make sure that the memory modules are supported by testing the modules using memtest86 or a similar utility.
 - **Note**: Refer to the product page on our website at http://www.supermicro.com for memory and CPU support and updates.
- 3. HDD support: Make sure that all hard disk drives (HDDs) work properly. Replace the bad HDDs with good ones.
- 4. System cooling: Check the system cooling to make sure that all heatsink fans and CPU/ system fans, etc., work properly. Check the hardware monitoring settings in the IPMI to make sure that the CPU and system temperatures are within the normal range. Also check the front panel Overheat LED and make sure that it is not on.
- 5. Adequate power supply: Make sure that the power supply provides adequate power to the system. Make sure that all power connectors are connected. Please refer to our website for more information on the minimum power requirements.
- 6. Proper software support: Make sure that the correct drivers are used.

B. If the system becomes unstable before or during OS installation, check the following:

- 1. Source of installation: Make sure that the devices used for installation are working properly, including boot devices such as CD.
- 2. Cable connection: Check to make sure that all cables are connected and working properly.
- 3. Using the minimum configuration for troubleshooting: Remove all unnecessary components (starting with add-on cards first), and use the minimum configuration (but



with a CPU and a memory module installed) to identify the trouble areas. Refer to the steps listed in Section A above for proper troubleshooting procedures.

- 4. Identifying bad components by isolating them: If necessary, remove a component in question from the chassis, and test it in isolation to make sure that it works properly. Replace a bad component with a good one.
- 5. Check and change one component at a time instead of changing several items at the same time. This will help isolate and identify the problem.
- 6. To find out if a component is good, swap this component with a new one to see if the system will work properly. If so, then the old component is bad. You can also install the component in question in another system. If the new system works, the component is good and the old system has problems.

3.2 Technical Support Procedures

Before contacting Technical Support, please take the following steps. Also, note that as a motherboard manufacturer, we do not sell directly to end-users, so it is best to first check with your distributor or reseller for troubleshooting services. They should know of any possible problem(s) with the specific system configuration that was sold to you.

- Please review the 'Troubleshooting Procedures' and 'Frequently Asked Questions' (FAQs) sections in this chapter or see the FAQs on our website before contacting Technical Support.
- 2. BIOS upgrades can be downloaded from our website. **Note:** Not all BIOS can be flashed depending on the modifications to the boot block code.
- 3. If you still cannot resolve the problem, include the following information when contacting us for technical support:
- Motherboard model and PCB revision number
- BIOS release date/version (this can be seen on the initial display when your system first boots up)
- · System configuration

An example of a Technical Support form is posted on our website.

<u>Distributors</u>: For immediate assistance, please have your account number ready when contacting our technical support department by e-mail.

3.3 Frequently Asked Questions

Question: What type of memory does my motherboard support?

Answer: The X11DAC motherboard supports up to 4TB of 3DS LRDIMM/LRDIMM/3DS RDIMM/RDIMM/NVDIMM DDR4 ECC 2933*/2666/2400/2133 MHz memory in 16 memory slots. It also supports up to 5TB memory with DCPMM modules installed. Populating DDR4 memory modules in a two-DIMMs per-channel (2DPC) configuration on this motherboard will affect memory bandwidth and performance.

Note: 2933 MHz memory is supported by 2nd Gen Intel Xeon Scalable-SP (82xx/62xx series) processors only. See Section 2.4 for details on installing memory.

Question: How do I update my BIOS?

Answer: It is recommended that you <u>do not</u> upgrade your BIOS if you are not experiencing any problems with your system. Updated BIOS files are located on our website at http://www.supermicro.com. Please check our BIOS warning message and the information on how to update your BIOS on our website. Select your motherboard model and download the BIOS file to your computer. Also, check the current BIOS revision to make sure that it is newer than your BIOS before downloading. You can choose from the zip file and the .exe file. If you choose the zip BIOS file, please unzip the BIOS file onto a bootable USB device. Run the batch file using the format FLASH.BAT filename.rom from your bootable USB device to flash the BIOS. Then, your system will automatically reboot.

Question: Why can't I turn off the power using the momentary power on/off switch?

Answer: The instant power off function is controlled in BIOS by the Power Button Mode setting. When the On/Off feature is enabled, the motherboard will have instant off capabilities as long as the BIOS has control of the system. When the Standby or Suspend feature is enabled or when the BIOS is not in control such as during memory count (the first screen that appears when the system is turned on), the momentary on/off switch must be held for more than four seconds to shut down the system. This feature is required to implement the ACPI features on the motherboard.

3.4 Battery Removal and Installation

Battery Removal

To remove the onboard battery, follow the steps below:

- 1. Power off your system and unplug your power cable.
- 2. Using a tool such as a pen or a small screwdriver, push the battery lock outwards to unlock it. Once unlocked, the battery will pop out from the holder.
- 3. Remove the battery.

Proper Battery Disposal

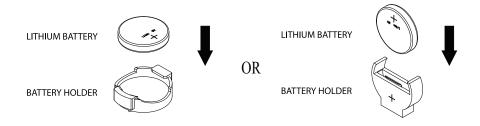
Please handle used batteries carefully. Do not damage the battery in any way; a damaged battery may release hazardous materials into the environment. Do not discard a used battery in the garbage or a public landfill. Please comply with the regulations set up by your local hazardous waste management agency to dispose of your used battery properly.

Battery Installation

- 1. To install an onboard battery, follow the steps 1 & 2 above and continue below:
- 2. Identify the battery's polarity. The positive (+) side should be facing up.
- 3. Insert the battery into the battery holder and push it down until you hear a click to ensure that the battery is securely locked.



 $lac{1}{2}$ **Note:** When replacing a battery, be sure to only replace it with the same type.





3.5 Returning Merchandise for Service

A receipt or copy of your invoice marked with the date of purchase is required before any warranty service will be rendered. You can obtain service by calling your vendor for a Returned Merchandise Authorization (RMA) number. When returning to the manufacturer, the RMA number should be prominently displayed on the outside of the shipping carton and mailed prepaid or hand-carried. Shipping and handling charges will be applied for all orders that must be mailed when service is complete.

For faster service, RMA authorizations may be requested online (http://www.supermicro.com/support/rma/).

This warranty only covers normal consumer use and does not cover damages incurred in shipping or from failure due to the alteration, misuse, abuse or improper maintenance of products.

During the warranty period, contact your distributor first for any product problems.

Chapter 4

UEFI BIOS

4.1 Introduction

This chapter describes the AMIBIOS™ setup utility for the X11DAC motherboard. The BIOS is stored on a chip and can be easily upgraded using a flash program.



Note: Due to periodic changes to the BIOS, some settings may have been added or deleted and might not yet be recorded in this manual. Please refer to the Manual Download area of our website for any changes to the BIOS that may not be reflected in this manual

Starting the Setup Utility

To enter the BIOS setup utility, press the <Delete> key while the system is booting-up. (In most cases, the <Delete> key is used to invoke the BIOS setup screen. There are a few cases when other keys are used, such as <F1>, <F2>, etc.) Each main BIOS menu option is described in this manual.

The Main BIOS screen has two main frames. The left frame displays all the options that can be configured. "Grayed-out" options cannot be configured. The right frame displays the key legend. Above the key legend is an area reserved for a text message. When an option is selected in the left frame, it is highlighted in white. Often a text message will accompany it. (Note that BIOS has default text messages built in. We retain the option to include, omit, or change any of these text messages.) Settings printed in **Bold** are the default values.

A ">" indicates a submenu. Highlighting such an item and pressing the <Enter> key will open the list of settings within that submenu.

The BIOS setup utility uses a key-based navigation system called hot keys. Most of these hot keys (<F1>, <F2>, <F3>, <F4>, <Enter>, <ESC>, <Arrow> keys, etc.) can be used at any time during the setup navigation process.



4.2 Main Setup

When you first enter the AMI BIOS setup utility, you will see the Main setup screen. You can always return to the Main setup screen by selecting the Main tab on the top of the screen. The Main BIOS setup screen is shown below.



System Date/System Time

Use this item to change the system date and time. Highlight *System Date* or *System Time* using the arrow keys. Enter new values using the keyboard. Press the <Tab> key or the arrow keys to move between fields. The date must be entered in Day MM/DD/YYYY format. The time is entered in HH:MM:SS format.

Note: The time is in the 24-hour format. For example, 5:30 P.M. appears as 17:30:00. The date's default value is the BIOS build date after the RTC (Real Time Clock) reset.

Supermicro X11DAC

BIOS Version

This feature displays the version of the BIOS ROM used in the system.

Build Date

This feature displays the date when the version of the BIOS ROM used in the system was built.

CPLD Version

This feature displays the version of the CPLD (Complex-Programmable Logical Device) used in the system.

Memory Information

Total Memory

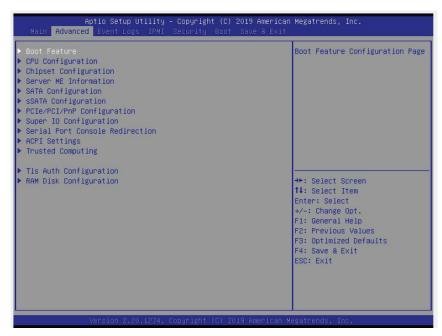
This feature displays the total size of memory available in the system.

Memory Speed

This feature displays the default speed of the memory modules installed in the system.

4.3 Advanced Setup Configurations

Use the arrow keys to select the Advanced submenu and press <Enter> to access the submenu items:

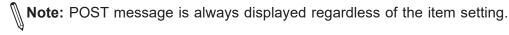


Warning: Take Caution when changing the Advanced settings. An incorrect value, an improper DRAM frequency, or a wrong BIOS timing setting may cause the system to malfunction. When this occurs, restore the setting to the manufacturer default setting.

▶Boot Configuration

Quiet Boot

Use this feature to select the screen between displaying POST messages or the OEM logo at bootup. Select Disabled to display the POST messages. Select Enabled to display the OEM logo instead of the normal POST messages. The options are **Enabled** and Disabled.



Option ROM Messages

Use this feature to set the display mode for the Option ROM. Select Keep Current to use the current AddOn ROM display settings. Select Force BIOS to use the Option ROM display mode set by the system BIOS. The options are **Force BIOS** and Keep Current.

Bootup NumLock State

Use this feature to set the Power-on state for the Numlock key. The options are Off and On.

Wait For 'F1' If Error

Select Enabled to force the system to wait until the <F1> key is pressed if an error occurs. The options are Disabled and **Enabled**.

Interrupt 19 Capture

Interrupt 19 is the software interrupt that handles the boot disk function. When this feature is set to Immediate, the ROM BIOS of the host adaptors will "capture" Interrupt 19 at bootup immediately and allow the drives that are attached to these host adaptors to function as bootable disks. If this item is set to Postponed, the ROM BIOS of the host adaptors will not capture Interrupt 19 immediately to allow the drives attached to these adaptors to function as bootable devices at bootup. The options are **Immediate** and Postponed.

Re-try Boot

When EFI (Extensible Firmware Interface) Boot is selected, the system BIOS will automatically reboot the system from an EFI boot device after an initial boot failure. Select Legacy Boot to allow the BIOS to automatically reboot the system from a Legacy boot device after an initial boot failure. The options are **Disabled**, Legacy Boot, and EFI Boot.

Power Configuration

Watch Dog Function

Select Enabled to allow the Watch Dog timer to reboot the system when it is inactive for more than 5 minutes. The options are Enabled and **Disabled.**

EuP (Energy using Product)

Select Enabled for EuP (Energy using Product) support to conserve energy use and enhance power performance. The options are Enabled and **Disabled**.

Power Button Function

This feature controls how the system shuts down when the power button is pressed. Select 4 Seconds Override for the user to power off the system after pressing and holding the power button for 4 seconds or longer. Select Instant Off to instantly power off the system as soon as the user presses the power button. The options are 4 Seconds Override and **Instant Off**.

Restore on AC Power Loss

Use this feature to set the power state after a power outage. Select Power Off for the system power to remain off after a power loss. Select Power On for the system power to be turned on after a power loss. Select Last State to allow the system to resume its last power state before a power loss. The options are Stay Off, Power On, and **Last State**.



▶CPU Configuration

Warning: Setting the wrong values in the following sections may cause the system to malfunction.

▶Processor Configuration

The following CPU information will be displayed:

- Processor BSP Revision
- Processor Socket
- Processor ID
- Processor Frequency
- Processor Max Ratio
- Processor Min Ratio
- Microcode Revision
- L1 Cache RAM
- L2 Cache RAM
- L3 Cache RAM
- Processor 0 Version
- Processor 1 Version

Hyper-Threading (ALL)

Select Enable to use Intel Hyper-Threading Technology to enhance CPU performance. The options are **Enable** and Disable.

Core Enabled

Use this feature to enable or disable CPU cores in the processor specified by the user. Use the <+> key and the <-> key on the keyboard to set the desired number of CPU cores you want to enable in a processor. Please note that the maximum of 24 CPU cores are currently available in each CPU package. The default setting is **0**.

Monitor/Mwait

Select Enable to enable the Monitor/Mwait instructions in the processor. The options are **Enable** and Disable.

Execute Disable Bit (Available if supported by the OS & the CPU)

Select Enable for Execute Disable Bit support which will allow the processor to designate areas in the system memory where an application code can execute and where it cannot, thus preventing a worm or a virus from flooding illegal codes to overwhelm the processor, damaging the system during a virus attack. The options are **Enable** and Disable. (Refer to Intel and Microsoft websites for more information.)



Intel Virtualization Technology (Available when two processors are installed on the motherboard)

Select Enable to use Intel Virtualization Technology which will allow multiple workloads to share the same set of common resources. On shared virtualized hardware, various workloads (or tasks) can co-exist, sharing the same resources, while functioning in full independence from each other, and migrating freely across multi-level infrastructures and scale as needed. The settings are **Enable** and Disable.

PPIN Control

Select Unlock/Enable to use the Protected-Processor Inventory Number (PPIN) in the system. The options are **Unlock/Enable** and Unlock/Disable.

Hardware Prefetcher (Available when supported by the CPU)

If this feature is set to Enable, the hardware prefetcher will prefetch streams of data and instructions from the main memory to the Level 2 (L2) cache to improve CPU performance. The options are Disable and **Enable**.

Adjacent Cache Prefetch (Available when supported by the CPU)

Select Enable for the CPU to prefetch both cache lines for 128 bytes as comprised. Select Disable for the CPU to prefetch both cache lines for 64 bytes. The options are Disable and **Enable**.

Note: Please power off and reboot the system for the changes you've made to take effect. Please refer to Intel's website for detailed information.

DCU Streamer Prefetcher (Available when supported by the CPU)

If this feature is set to Enable, the DCU (Data Cache Unit) streamer prefetcher will prefetch data streams from the cache memory to the DCU (Data Cache Unit) to speed up data accessing and processing to enhance CPU performance. The options are Disable and **Enable**.

DCU IP Prefetcher

This feature allows the system to use the sequential load history, which is based on the instruction pointer of previous loads, to determine whether the system will prefetch additional lines. The options are **Enable** and Disable.

LLC Prefetch

If this feature is set to Enable, LLC (hardware cache) prefetching on all threads will be supported. The options are **Disable** and Enable.

Extended APIC (Extended Advanced Programmable Interrupt Controller)

Based on the Intel Hyper-Threading technology, each logical processor (thread) is assigned 256 APIC IDs (APIDs) in 8-bit bandwidth. When this feature is set to Enable, the APIC ID will be expanded from 8 bits to 16 bits to provide 512 APIDs to each thread to enhance CPU performance. The options are **Disable** and Enable.



AES-NI

Select Enable to use the Intel Advanced Encryption Standard (AES) New Instructions (NI) to ensure data security. The options are **Enable** and Disable.

► Advanced Power Management Configuration

Power Technology

Select Energy Efficient to support power-saving mode. Select Custom to customize system power settings. Select Disabled to disable power-saving settings. The options are Disable, **Energy Efficient**, and Custom.

Power Performance Tuning (Available when "Power Technology" is set to Custom)

Select BIOS to allow the system BIOS to configure the Power-Performance Tuning Bias setting. The options are BIOS Controls EPB and **OS Controls EPB**.

Energy Performance BIAS Setting (Available when "Power Performance Tuning" isset to BIOS Controls EPB)

Use this feature to set the processor power use policy to achieve the desired operation settings for your machine by prioritizing system performance or energy savings. Select Maximum Performance to maximize system performance (to its highest potential); however, this may result in maximum power consumption as energy is needed to fuel the processor frequency. The higher the performance is, the higher the power consumption will be. Select Max Power Efficient to maximize power saving; however, system performance may be substantially impacted because limited power use decreases the processor frequency. The options are Maximum Performance, Performance, Balanced Performance, Balanced Power, Power, and Max Power Efficient.

► CPU P State Control (Available when "Power Technology" is set to Custom)

SpeedStep (PStates)

EIST (Enhanced Intel SpeedStep Technology) allows the system to automatically adjust processor voltage and core frequency in an effort to reduce power consumption and heat dissipation. Please refer to Intel's website for detailed information. The options are Disable and **Enable**.

Config (Configure) TDP (Available when SpeedStep is set to Enable)

Use this feature to set the appropriate TDP (Thermal Design Power) level for the system. The TDP refers to the maximum amount of power allowed for running "real applications" without triggering an overheating event. The options are **Normal**, Level 1, and Level 2.

Activate PBF (Available when SpeedStep is set to Enable)

Select Enable to enable Prioritized Base Frequency (PBF) feature support which will enhance CPU performance. The options are **Disable** and Enable.

Configure PBF (Available when Activate PBF is set to Enable)

Select Enable to allow the BIOS to configure high priority CPU cores as Prioritized Base Frequency (PBF) so that software programs do not have to configure the PBF (Prioritized Base Frequency) settings. The options are **Enable** and Disable.

EIST PSD Function (Available when SpeedStep is set to Enable)

Use this item to configure the processor's P-State coordination settings. During a P-State, the voltage and frequency of the processor will be reduced when it is in operation. This makes the processor more energy efficient, resulting in further energy gains. The options are **HW_ALL**, SW ALL and SW-ANY.

Turbo Mode (Available when SpeedStep is set to Enable)

Select Enable for processor cores to run faster than the frequency specified by the manufacturer. The options are Disable and **Enable**.

► Hardware PM (Power Management) State Control Available when "Power Technology" is set to Custom)

Hardware P-States

If this feature is set to Disable, hardware will choose a P-state setting for the system based on an OS request. If this feature is set to Native Mode, hardware will choose a P-state setting based on OS guidance. If this feature is set to Native Mode with No Legacy Support, hardware will choose a P-state setting independently without OS guidance. The options are **Disable**, Native Mode, Out of Band Mode, and Native Mode with No Legacy Support.

► CPU C State Control

Autonomous Core C-State

Select Enable to support Autonomous Core C-State control which will allow the processor core to control its C-State setting automatically and independently. The options are **Disable** and Enable.

CPU C6 Report (Available when Autonomous Core C-State is set to Disable)

Select Enable to allow the BIOS to report the CPU C6 state (ACPI C3) to the operating system. During the CPU C6 state, power to all caches is turned off. The options are **Auto**, Enable, and Disable.



Enhanced Halt State (C1E) (Available when Autonomous Core C-State is set to Disable)

Select Enable to enable "Enhanced Halt State" support, which will significantly reduce the CPU's power consumption by minimizing CPU's clock cycles and reduce voltage during a "Halt State." The options are Disable and **Enable**.

▶ Package C State Control (Available when "Power Technology" is set to Custom)

Package C State

Use this feature to set the limit on the C-State package register. The options are C0/C1 state, C2 state, C6 (non-Retention) state, C6 (Retention) state, No Limit, and **Auto**.

► CPU T State Control Available when "Power Technology" is set to Custom)

Software Controlled T-States

If this feature is set to Enable, CPU throttling settings will be supported by the software of the system. The options are **Enable** and Disable.

▶Chipset Configuration

Warning: Setting the wrong values in the following items may cause the system to malfunction.

► North Bridge

This feature allows the user to configure the settings for the Intel North Bridge.

▶UPI (Ultra Path Interconnect) Configuration

This section displays the following UPI General Configuration information:

- Number of CPU
- Number of Active UPI Link
- Current UPI Link Speed
- Current UPI Link Frequency
- UPI Global MMIO Low Base/Limit
- UPI Global MMIO High Base/Limit
- UPI PCI-E Configuration Base/Size



Degrade Precedence

Use this feature to select the degrading precedence option for Ultra Path Interconnect (UPI) connections. Select Topology Precedent to degrade UPI features if system options are in conflict. Select Feature Precedent to degrade UPI topology if system options are in conflict. The options are **Topology Precedence** and Feature Precedence.

Link L0p Enable

Select Enable to enable Link L0p. The options are Disable, Enable, and Auto.

Link L1 Enable

Select Enable to enable Link L1 (Level 1 link). The options are Disable, Enable, and Auto.

IO Directory Cache (IODC)

Select Enable for the

IODC (I/O Directory Cache) to generate snoops instead of generating memory lockups for remote IIO (InvIToM) and/or WCiLF (Cores). Select Auto for the IODC to generate snoops (instead of memory lockups) for WCiLF (Cores). The options are Disable, **Auto**, Enable for Remote InvItoM Hybrid Push, InvItoM AllocFlow, Enable for Remote InvItoM Hybrid AllocNonAlloc, and Enable for Remote InvItoM and Remote WViLF.

SNC

Select Enable to use "Sub NUMA Clustering" (SNC), which supports full SNC (2-cluster) interleave and 1-way IMC interleave. Select Auto for 1-cluster or 2-cluster support depending on the status of IMC (Integrated Memory Controller) Interleaving. The options are **Disable**, Enable, and Auto.

XPT Prefetch

Select Enable to support XPT Prefetching to enhance system performance. The options are Enable, **Disable**, and Auto.

KTI Prefetch

Select Enable to support KTI Prefetching to enhance system performance. The options are **Enable** and Disable.

Local/Remote Threshold

This feature allows the user to set the threshold for the Interrupt Request (IRQ) signal, which handles hardware interruptions. The options are Disable, **Auto**, Low, Medium, and High.

Stale AtoS (A to S)

The in-memory directory has three states: I, A, and S states. The I (-invalid) state indicates that the data is clean and does not exist in the cache of any other sockets. The A (-snoop All) state indicates that the data may exist in another socket in an exclusive or modified state. The S state (-Shared) indicates that the data is clean and may be shared in the caches across one or more sockets. When the system is performing "read" on the memory



and if the directory line is in A state, we must snoop all other sockets because another socket may have the line in a modified state. If this is the case, a "snoop" will return the modified data. However, it may be the case that a line "reads" in an A state, and all the snoops come back with a "miss". This can happen if another socket reads the line earlier and then has silently dropped it from its cache without modifying it. If the "Stale AtoS" feature is enabled, a line will transition to the S state when the line in the A state returns only snoop misses. That way, subsequent reads to the line will encounter it in the S state and will not have to snoop, saving the latency and snoop bandwidth. Stale "AtoS" may be beneficial in a workload where there are many cross-socket reads. The options are Disable, Enable, and **Auto**.

LLC Dead Line Alloc

Select Enable to opportunistically fill the deadlines in the LLC. The options are **Enable**, Disable, and Auto.

Isoc Mode

Select Enable to enable Isochronous support to meet QoS (Quality of Service) requirements. This feature is especially important for Virtualization Technology. The options are Disable, Enable, and **Auto**.

▶ Memory Configuration

Enforce POR (Plan of Record)

Select POR to enforce POR restrictions for DDR4 memory frequency and voltage programming. The options are **POR** and Disable.

PPR Type

Post Package Repair (PPR) is a new feature available for the DDR4 Technology. PPR provides additional spare capacity within a DDR4 DRAM module that is used to replace faulty cell areas detected during system boot. PPR offers two types of memory repairs. Soft Post Package Repair (sPPR) provides a quick, temporary fix on a raw element in a bank group of a DDR4 DRAM device, while hard Post Package Repair (hPPR) will take a longer time to provide a permanent repair on a raw element. The options are **Auto**, Enable, Soft PPR, and Disabled.

Memory Frequency

Use this feature to set the maximum memory frequency for onboard memory modules. The options are **Auto**, 1866, 2000, 2133, 2400, 2666, and 2933. **Note**: 2933 MHz memory is supported by 2nd Gen Intel Xeon Scalable-SP (82xx/62xx series) processors only.



Data Scrambling for DDR4

Select Enable to enable data scrambling for DDR4 memory to enhance system performance and security. Select Auto for the default setting of the Memory Reference Code (MRC) to set configure data scrambling for DDR4 setting. The options are **Auto**, Disable, and Enable.

tCCD_L Relaxation

If this feature is set to Enable, SPD (Serial Presence Detect) will override tCCD_L ("Column to Column Delay-Long", or "Command to Command Delay-Long" on the column side.) If this feature is set to Disable, tCCD_L will be enforced based on the memory frequency. The options are **Auto**, Enable and Disable.

tRWSR (Read to Write turnaround time for Same Rank) Relaxation

Select Enable to use the same tRWSR DDR timing setting among all memory channels, and in which case, the worst case value among all channels will be used. Select Disable to use different values for the tRWSR DDR timing settings for different channels as trained. The options are Auto, **Disable**, and Enable.

Enable ADR

Select Enable for ADR (Async DIMM Self-Refresh) support to enhance memory performance. The options are Disable and **Enable**.

Data Scrambling for NVDIMM

Select Enable to enable data scrambling support for onboard NVDIMM memory to improve system performance and security. The options are **Auto**, Disable, and Enable.

Erase-Arm NVDIMMs

If this feature is set to Enable, the function that arms the NVDIMMs for safe operations in the event of a power loss will be removed. The options are **Enable** and Disable.

Restore NVDIMMs

Select Enable to restore the functionality and the features of NVDIMMs. The options are **Enable** and Disable.

Interleave NVDIMMs

If this item is set to Enable, all onboard NVDIMM modules will be configured together as a group for the interleave mode. If this item is set to Disable, individual NVDIMM modules will be configured separately for the interleave mode. The options are Enable and **Disable**.

Reset Trigger ADR (Async DIMM Self-Refresh)

Upon system power loss, an ADR sequence will be triggered to allow ADR to flush the write-protected data buffers in the memory controller and place the DRAM memory in self-



refresh mode. When this process is complete, the NVDIMM will then take control of the DRAM memory and transfer the contents to the onboard Flash memory. After the transfer is complete, the NVDIMM goes into a zero power state. The data transferred will be retained for the duration specified by the flash memory. The options are Enable and **Disable**.

S5 Trigger ADR

Select Enabled to support S5-Triggered ADR to enhance system performance and data integrity. The options are **Disabled** and Enabled.

2X Refresh

Select Enable for memory 2X refresh support to enhance memory performance. The options are Disable, Enable and **Auto**.

Page Policy

Use this feature to set the page policy for onboard memory support. The options are Closed, Adaptive, and **Auto**.

IMC Interleaving

Use this feature to configure interleaving settings for the IMC (Integrated Memory Controller), which will improve memory performance. The options are 1-way Interleave, 2-way Interleave, and **Auto**.

► Memory Topology

This item displays the information of onboard memory modules as detected by the BIOS.

- P1 DIMMA1/DIMMA2/DIMMB1/DIMMC1/DIMMD1/DIMMD2/DIMME1/DIMMF1
- P2 DIMMA1/DIMMA2/DIMMB1/DIMMC1/DIMMD1/DIMMD2/DIMME1/DIMME1

► Memory RAS (Reliability_Availability_Serviceability) Configuration

Use this submenu to configure the following Memory RAS settings.

Static Virtual Lockstep Mode

Select Enable to support Static Virtual Lockstep mode to enhance memory performance. The options are Enable and **Disable**.

Mirror Mode

Use this feature to configure the mirror mode settings for all 1LM/2LM memory modules installed in the system which will create a duplicate copy of data stored in the memory to increase memory security, but it will reduce the memory capacity into half. The options are **Disable**, Mirror Mode 1LM, and Mirror Mode 2LM.



UEFI ARM Mirror

If this feature is set to Enable, mirror mode configuration settings for UEFI-based Address Range memory will be enabled upon system boot. This will create a duplicate copy of data stored in the memory to increase memory security, but it will reduce the memory capacity into half. The options are **Disable** and Enable.

Memory Rank Sparing

Select Enable to support memory-rank sparing to optimize memory performance. The options are Enable and **Disable**.

Note: This item will not be available when memory mirror mode is set to Mirror Mode 1LM or an AEP device is plugged in.

Correctable Error Threshold

Use this item to enter the threshold value for correctable memory errors. The default setting is **512**.

Intel Run Sure

Select Enable to use Intel Run Sure Technology which will enhance critical data protection and increase system uptime and resiliency. The options are **Enable** and Disable.

SDDC Plus One (Available when this feature is supported by the CPU & the item: Intel Run Sure is set to Disable)

SDDC (Single Device Data Correction) checks and corrects single-bit or multiple-bit (4-bit max.) memory faults that affect an entire single x4 DRAM device. SDDC Plus One is the enhanced feature to SDDC. SDDC+1 will spare the faulty DRAM device out after an SDDC event has occurred. After the event, the SDDC+1 ECC mode is activated to protect against any additional memory failure caused by a 'single-bit' error in the same memory rank. The options are Disable and **Enable***. (The option "Enable" can be set as default when it is supported by the motherboard.)

ADDDC (Adaptive Double Device Data Correction) Sparing (Available when Intel Run Sure is set to Enable)

Select Enable for Adaptive Double Device Data Correction (ADDDC) support, which will not only provide memory error checking and correction but will also prevent the system from issuing a performance penalty before a device fails. Please note that virtual lockstep mode will only start to work for ADDDC after a faulty DRAM module is spared. The options are **Enable** and Disable.



Patrol Scrub

Patrol Scrubbing is a process that allows the CPU to correct correctable memory errors detected in a memory module and send the corrections to the requestor (the original source). When this feature is set to Enable, the IO hub will read and write back one cache line every 16K cycles if there is no delay caused by internal processing. By using this method, roughly 64 GB of memory behind the IO hub will be scrubbed every day. The options are **Enable** and Disable.

Patrol Scrub Interval

Use this item to specify the number of hours (between 0 to 24) required for the system to complete a full patrol scrubbing. Enter 0 for patrol scrubbing to be performed automatically. The default setting is **24**.



Note: This item is hidden when Patrol Scrub item is set to Disable.

►IIO Configuration

EV DFX (Device Function On-Hide) Features

When this feature is set to Enable, the EV_DFX Lock Bits that are located in a processor will always remain clear during electric tuning. The options are **Disable** and Enable.

► CPU1 Configuration/CPU2 Configuration

IOU0 (IIO PCIe Br1)

Use this feature to configure the PCI-E Bifurcation setting for a PCI-E port specified by the user. The options are x4x4x4x4, x4x4x8, x8x4x4, x8x8, x16, and **Auto**.

IOU1 (IIO PCIe Br2)

Use this feature to configure the PCI-E Bifurcation setting for a PCI-E port specified by the user. The options are x4x4x4x4, x4x4x8, x8x4x4, x8x8, x16, and **Auto**.

IOU2 (IIO PCIe Br3)

Use this feature to configure the PCI-E Bifurcation setting for a PCI-E port specified by the user. The options are x4x4x4x4, x4x4x8, x8x4x4, x8x8, x16, and **Auto**.

MCP0 / IOU3 (IIO PCIe Br4)

Use this feature to configure the PCI-E Bifurcation setting for a PCI-E port specified by the user. The options are x16 and **Auto**.

MCP1 (IIO PCIe Br5)

Use this feature to configure the PCI-E Bifurcation setting for a PCI-E port specified by the user. The options are x16 and **Auto**.



► Socket 0 PCI-E Br0D00F0 - Port 0/DMI (Available for CPU 1 Configuration only)

Link Speed

Use this feature to configure the link speed of a PCI-E port specified by the user. The options are **Auto**, Gen 1 (Generation 1) (2.5 GT/s), Gen 2 (Generation 2) (5 GT/s), and Gen 3 (Generation 3) (8 GT/s)

The following information will be displayed:

- PCI-E Port Link Status
- PCI-E Port Link Max
- PCI-E Port Link Speed

PCI-E Port Max (Maximum) Payload Size (Available for CPU 1 Configuration only)

Select Auto for the system BIOS to automatically set the maximum payload value for a PCI-E device specified by to user for system performance enhancement. The options are **Auto**, 128B, and 256B.

►IOAT Configuration

Disable TPH (TLP Processing Hint)

TPH is used for data-tagging with a destination ID and a few important attributes. It can send critical data to a particular cache without writing through to memory. Select No in this item for TLP Processing Hint support, which will allow a "TPL request" to provide "hints" to help optimize the processing of each transaction occurred in the target memory space. The options are Yes and **No**.

Prioritize TPH (TLP Processing Hint)

Select Yes to prioritize the TPL requests that will allow the "hints" to be sent to help facilitate and optimize the processing of certain transactions in the system memory. The options are Enable and **Disable**.

Relaxed Ordering

Select Enable to allow certain transactions to be processed and completed before other transactions that have already been enqueued. The options are **Disable** and Enable.



▶Intel VT for Directed I/O (VT-d)

Intel® VT for Directed I/O (VT-d)

Select Enable to use Intel Virtualization Technology support for Direct I/O VT-d by reporting the I/O device assignments to the VMM (Virtual Machine Monitor) through the DMAR ACPI tables. This feature offers fully-protected I/O resource sharing across Intel platforms, providing greater reliability, security and availability in networking and data-sharing. The options are **Enable** and Disable.

ACS (Access Control Services) Control

Select Enable to program Access Control Services to Chipset PCI-E Root Port Bridges. Select Disable to program Access Control Services to all PCI-E Root Port Bridges. The options are **Enable** and Disable.

Interrupt Remapping

Select Enable for Interrupt Remapping support to enhance system performance. The options are **Enable** and Disable.

PassThrough DMA

Select Enable for the Non-Isoch VT-d engine to pass through DMA (Direct Memory Access) to enhance system performance. The options are **Enable** and Disable.

ATS

Select Enable to enable ATS (Address Translation Services) support for the Non-Isoch VT-d engine to enhance system performance. The options are **Enable** and Disable.

Posted Interrupt

Select Enable to support VT_D Posted Interrupt which will allow external interrupts to be sent directly from a direct-assigned device to a client machine in non-root mode to improve virtualization efficiency by simplifying interrupt migration and lessening the need of physical interrupts. The options are **Enable** and Disable.

Coherency Support (Non-Isoch)

Select Enable for the Non-Isoch VT-d engine to pass through DMA (Direct Memory Access) to enhance system performance. The options are **Enable** and Disable.



▶IIO-PCIE Express Global Options

IIO-PCIE Express Global Options

The section allows the user to configure the following PCI-E global options:

PCE-E Hot Plug

Select Enable to support Hot-plugging for the selected PCI-E slots which will allow the user to replace the devices installed in the slots without shutting down the system. The options are Enable, **Disable**, Auto and Manual.

PCI-E Completion Timeout (Global) Disable

Use this feature to select the PCI-E Completion Time-out settings. The options are Yes, **No**, and Per-Port.

► South Bridge

The following South Bridge information will display:

- USB Module Version
- USB Devices

Legacy USB Support

Select Enabled to support onboard legacy USB devices. Select Auto to disable legacy support if there are no legacy USB devices present. Select Disable to have all USB devices available for EFI applications only. The options are **Enabled**, Disabled and Auto.

XHCI Hand-Off

This is a work-around solution for operating systems that do not support XHCI (Extensible Host Controller Interface) hand-off. The XHCI ownership change should be claimed by the XHCI driver. The options are Disabled and **Enabled**.

Port 60/64 Emulation

Select Enabled for I/O port 60h/64h emulation support, which in turn, will provide complete legacy USB keyboard support for the operating systems that do not support legacy USB devices. The options are **Enabled** and Disabled.

PCIe PLL SSC

Select Enabled for PCH PCI-E Spread Spectrum Clocking support, which will allow the BIOS to monitor and attempt to reduce the level of Electromagnetic Interference caused by the components whenever needed. The options are Enabled and **Disabled**.

Port 61h Bit-4 Emulation

Select Enabled for I/O Port 61h-Bit 4 emulation support to enhance system performance. The options are Enabled and **Disabled**.



▶ Server ME (Management Engine) Configuration

This feature displays the following system ME configuration settings.

- Oper. (Operational) Firmware Version
- Backup Firmware Version
- Recovery Firmware Version
- ME Firmware Status #1/ME Firmware Status #2
 - Current State
 - Error Code

PTT Support (Available when TPM Configuration is set to Disable.)

Select Enable to support Intel® Platform Trust Technology (PTT) to enhance system security and data integrity. Intel PTT technology integrates the Host software stack, the system BIOS, Manageability Engine (ME) features, and the PCH to run on Intel's TCG (Trusted Computing Group) in conjunction with the TPM (Trusted Platform Module) firmware installed in your system to ensure data security and integrity. The options are **Disable** and Enable.

Suppress PTT Commands (Available when PTT Support is set to Enable.)

Select Enable to bypass TPM2 commands and submit the system to the PTT (Platform Trust Technology) Firmware.

► (PCH) SATA Configuration

When this submenu is selected, the AMI BIOS automatically detects the presence of the SATA devices that are supported by the Intel PCH chip and displays the following items:

SATA Controller

This item enables or disables the onboard SATA controller supported by the Intel PCH chip. The options are **Enable** and Disable.

Configure SATA as (Available when SATA Controller is set to Enable)

Select AHCI to configure a SATA drive specified by the user as an AHCI drive. Select RAID to configure a SATA drive specified by the user as a RAID drive. The options are **AHCI** and RAID. (**Note:** This item is hidden when the SATA Controller item is set to Disabled.)

SATA HDD Unlock (Available when SATA Controller is set to Enable)

Select Enable to unlock SATA HDD password in the OS. The options are **Enable** and Disable.

SATA/sSATA RAID Boot Select (Available when Configure SATA as is set to RAID)

This feature allows the user to decide which controller should be used to boot the system. The options are None, SATA Controller, **sSATA Controller**, and Both.

Aggressive Link Power Management

When this feature is set to Enable, the SATA AHCI controller manages the power use of the SATA link. The controller will put the link in a low power mode during an extended period of I/O inactivity, and will return the link to an active state when I/O activity resumes. The options are Enable and **Disable**.

SATA RAID Option ROM/UEFI Driver (Available when Configure SATA as is set to RAID)

Select EFI to load the EFI driver for system boot. Select Legacy to load a legacy driver for system boot. The options are Disable, EFI, and **Legacy**.

SATA Port 0 - SATA Port 7

Hot Plug

Select Enable to support Hot-plugging for the device installed on a selected SATA port which will allow the user to replace the device installed in the slot without shutting down the system. The options are **Enable** and Disable.

Spin Up Device

When this feature is set to Enable, the SATA device installed on the SATA port specified by the user will start a COMRESET initialization when an edge is detected from 0 to 1. The options are Enable and **Disable**.

SATA Device Type

Use this feature to specify if the device installed on the SATA port specified by the user should be connected to a Solid State drive or a Hard Disk Drive. The options are **Hard Disk Drive** and Solid State Drive.

▶sSATA Configuration

When this submenu is selected, the AMI BIOS automatically detects the presence of the sSATA devices that are supported by the sSATA controller and displays the following items:

sSATA Controller

This item enables or disables the onboard sSATA controller supported by the Intel PCH. The options are **Enable** and Disable.

Configure sSATA as (Available when sSATA Controller is set to Enable)

Select AHCI to configure an sSATA drive specified by the user as an AHCI drive. Select RAID to configure an sSATA drive specified by the user as a RAID drive. The options are **AHCI** and RAID. (**Note:** This feature is hidden when the sSATA Controller item is set to Disabled.)



SATA HDD Unlock (Available when sSATA Controller is set to Enable)

Select Enable to unlock sSATA HDD password in the OS. The options are **Enable** and Disable.

SATA/sSATA RAID Boot Select (Available when Configure sSATA as is set to RAID)

This feature allows the user to decide which controller should be used to boot the system. The options are None, SATA Controller, **sSATA Controller**, and Both.

Aggressive Link Power Management

When this feature is set to Enable, the sSATA AHCI controller manages the power use of the sSATA link. The controller will put the link in a low power mode during an extended period of I/O inactivity, and will return the link to an active state when I/O activity resumes. The options are **Disable** and Enable.

sSATA RAID Option ROM/UEFI Driver (Available when Configure sSATA as is set to RAID)

Select EFI to load the EFI driver for system boot. Select Legacy to load a legacy driver for system boot. The options are Disable, EFI, and **Legacy**.

sSATA Port 0 - sSATA Port 5

Hot Plug

Select Enable to support Hot-plugging for the device installed on an sSATA port specified by the user which will allow the user to replace the device installed in the slot without shutting down the system. The options are **Enable** and Disabled.

Spin Up Device

This setting allows the SATA device installed on the SATA port specified by the user to start a COMRESET initialization when an edge is detected from 0 to 1. The options are Enable and **Disable**.

sSATA Device Type

Use this feature to specify if the device installed on the sSATA port specified by the user should be connected to a Solid State drive or a Hard Disk Drive. The options are **Hard Disk Drive** and Solid State Drive.



▶PCIe/PCI/PnP Configuration

The following PCI information will be displayed:

- PCI Bus Driver Version
- PCI Devices Common Settings

Above 4G Decoding (Available if the system supports 64-bit PCI decoding)

Select Enabled to decode a PCI device that supports 64-bit in the space above 4G Address. The options are **Enabled** and Disabled.

SR-IOV Support (Available if the system supports Single-Root Virtualization)

Select Enabled for Single-Root IO Virtualization support. The options are Enabled and **Disabled**.

MMIO High Base

Use this feature to select the base memory size according to memory-address mapping for the IO hub. The base memory size must be between 4032G to 4078G. The options are **56T**, 40T, 24T, 16T, 4T, and 1T.

MMIO High Granularity Size

Use this feature to select the high memory size according to memory-address mapping for the IO hub. The options are 1G, 4G, 16G, 64G, **256G**, and 1024G.

Maximum Read Request

Select Auto for the system BIOS to automatically set the maximum size for a read request for a PCI-E device to enhance system performance. The options are **Auto**, 128 Bytes, 256 Bytes, 512 Bytes, 1024 Bytes, 2048 Bytes, and 4096 Bytes.

MMCFG Base

This feature determines how the lowest MMCFG (Memory-Mapped Configuration) base is assigned to onboard PCI devices. The options are 1G, 1.5G, 1.75G. **2G**, 2.25G, and 3G.

VGA Priority

Use this feature to select the graphics device to be used as the primary video display for system boot. The options are Auto, **Onboard** and Offboard.

PCI Devices Option ROM Settings

CPU1 Slot 1 PCI-E x16 OPROM/CPU2 Slot 2 PCI-E x8 OPROM/CPU2 Slot 3 PCI-E x16 OPROM/CPU2 Slot 4 PCI-E x16 OPROM/CPU2 Slot 5 PCI-E x16 OPROM/CPU2 Slot 6 PCI-E x8 OPROM/LSI SAS OPROM

Select EFI to allow the user to boot the computer using an EFI (Extensible Firmware Interface) device installed on the PCI-E slot specified by the user. Select Legacy to allow the user to



boot the computer using a legacy device installed on the PCI-E slot specified by the user. The options are Disabled, **Legacy** and EFI. (**Note:** Riser card names may differ in each system.)

Onboard Video OPROM (Option ROM)

Use this feature to select the Onboard Video Option ROM type. The options are Do Not Launch, **Legacy** and UEFI.

Onboard LAN Device

Select Enable to use onboard LAN devices. The options are Disabled, Enabled, and Auto.

Onboard LAN1 Option ROM

Use this feature to select the type of device installed in LAN Port1, which will be used for system boot. The options are **Legacy**, EFI and Disabled.

Onboard LAN2 Option ROM

Use this feature to select the type of device installed in LAN Port2, which will be used for system boot. The options are Legacy, EFI and **Disabled**.

► Network Stack Configuration

Network Stack

Select Enabled to enable PXE (Preboot Execution Environment) or UEFI (Unified Extensible Firmware Interface) for network stack support. The options are **Enabled** and Disabled.

*If "Network Stack" is set to Enabled, the following items will display:

Ipv4 PXE Support

Select Enabled to enable Ipv4 PXE boot support. If this feature is disabled, it will not create the Ipv4 PXE boot option. The options are Disabled and **Enabled**.

Ipv4 HTTP Support

Select Enabled to enable Ipv4 HTTP boot support. If this feature is disabled, it will not create the Ipv4 HTTP boot option. The options are Enabled and **Disabled**.

Ipv6 PXE Support

Select Enabled to enable Ipv6 PXE boot support. If this feature is disabled, it will not create the Ipv6 PXE boot option. The options are Disabled and **Enabled**.

Ipv6 HTTP Support

Select Enabled to enable Ipv6 HTTP boot support. If this feature is disabled, it will not create the Ipv6 HTTP boot option. The options are Enabled and **Disabled**.

IPSEC Certificate

Select Enable to enable the IPSEC certificate for Ikev support. The options are Disabled and **Enabled**.



PXE Boot Wait Time

Use this feature to select the wait time to press the <ESC> key to abort the PXE boot. The default is **0**.

Media Detect Time

Use this feature to select the wait time in seconds for the BIOS ROM to detect the LAN media (Internet connection or LAN port). The default is 1.

► Super IO Configuration

Super IO Chip AST2500

► Serial Port 2 Configuration

Serial Port

Select Enabled to enable Serial Port 2. The options are **Enabled** and Disabled.

Device Settings (Available when the item above "Serial Port (2)" is set to Enabled)

This feature displays the base I/O port address and the Interrupt Request address of a serial port specified by the user.

Change Settings

This feature specifies the base I/O port address and the Interrupt Request address of Serial Port 2. Select Auto for the BIOS to automatically assign the base I/O and IRQ address to a serial port specified.

The options for Serial Port 2 are **Auto**, (IO=2F8h; IRQ=3), (IO=3F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12), (IO=2F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12); (IO=3E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12), and (IO=2E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12).

Serial Port 2 Attribute

Select SOL to use COM Port 2 as a Serial_Over_LAN (SOL) port for console redirection. The options are COM and **SOL**.



▶ Serial Port Console Redirection

CM2/SOL

► Console Redirection Settings

Out-of-Band Management Port

This feature selects a serial port in a client server to be used by the Windows Emergency Management Services (EMS) to communicate with a remote host server. The options are **COM1 (Console Redirection)** and COM2/SOL (Console Redirection).

Terminal Type

Use this feature to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII character set. Select VT100+ to add color and function key support. Select ANSI to use the extended ASCII character set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are ANSI, VT100, VT100+, and VT-UTF8.

Bits Per Second

This feature sets the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in both host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 57600, and **115200** (bits per second).

Flow Control

Use this feature to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a "Stop" signal to stop data-sending when the receiving buffer is full. Send a "Start" signal to start data-sending when the receiving buffer is empty. The options are **None**, Hardware RTS/CTS, and Software Xon/Xoff.

The setting for each these features is displayed:

Data Bits, Parity, Stop Bits

► ACPI Settings

Use this feature to configure Advanced Configuration and Power Interface (ACPI) power management settings for your system.

NUMA Support (Available when the OS supports this feature)

Select Enabled to enable Non-Uniform Memory Access support to enhance system performance. The options are **Enabled** and Disabled.



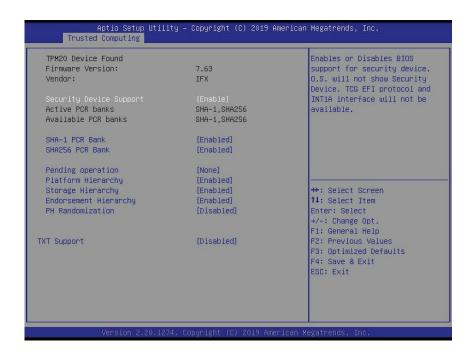
WHEA Support

Select Enabled to support the Windows Hardware Error Architecture (WHEA) platform and provide a common infrastructure for the system to handle hardware errors within the Windows OS environment to reduce system crashes and to enhance system recovery and health monitoring. The options are **Enabled** and Disabled.

► Trusted Computing (Available when a TPM device is installed and detected by the BIOS)

When a TPM (Trusted-Platform Module) device is detected in your machine, the following information will be displayed.

- TPM2.0 Device Found
- Firmware Version
- Vendor



Security Device Support

If this feature and the TPM jumper (JPT1) on the motherboard are both enabled, the onboard security (TPM) device will be enabled in the BIOS to enhance data integrity and system security. Please note that the OS will not show the security device. Neither TCG EFI protocol nor INT1A interaction will be made available for use. If you have made changes on the setting on this item, be sure to reboot the system for the change to take effect. The options are Disable and **Enable**. If this option is set to Enable, the following screen and items will display:

- Active PCR Banks
- Available PCR Banks

SHA-1 PCR Bank

Select Enabled to enable SHA-1 PCR Bank support to enhance system security and data integrity. The options are **Enabled** and Disabled.

SHA256 PCR Bank

Select Enabled to enable SHA256 PCR Bank support to enhance system security and data integrity. The options are **Enabled** and Disabled.

Pending Operation

Use this feature to schedule a TPM-related operation to be performed by a security (TPM) device at the next system boot to enhance system data integrity. Your system will reboot to carry out a pending TPM operation. The options are None and TPM Clear.



Note: Your system will reboot to carry out a pending TPM operation.

Platform Hierarchy (for TPM Version 2.0 and above)

Select Enabled for TPM Platform Hierarchy support which will allow the manufacturer to utilize the cryptographic algorithm to define a constant key or a fixed set of keys to be used for initial system boot. These early boot codes are shipped with the platform and are included in the list of "public keys". During system boot, the platform firmware uses the trusted public keys to verify a digital signature in an attempt to manage and control the security of the platform firmware used in a host system via a TPM device. The options are **Enabled** and Disabled.

Storage Hierarchy

Select Enabled for TPM Storage Hierarchy support that is intended to be used for non-privacysensitive operations by the platform owner such as an IT professional or the end user. Storage Hierarchy has an owner policy and an authorization value, both of which can be set and are held constant (-rarely changed) through reboots. This hierarchy can be cleared or changed independently of the other hierarchies. The options are Enabled and Disabled.

Endorsement Hierarchy

Select Enabled for Endorsement Hierarchy support, which contains separate controls to address the user's privacy concerns because the primary keys in this hierarchy are certified by the TPM or a manufacturer to be constrained to an authentic TPM device that is attached to an authentic platform. A primary key can be an encrypted, and a certificate can be created using TPM2 ActivateCredential. It allows the user to independently enable "flag, policy, and authorization value" without involving other hierarchies. A user with privacy concerns can disable the endorsement hierarchy while still using the storage hierarchy for TPM applications and permitting the platform software to use the TPM. The options are **Enabled** and Disabled.



PH (Platform Hierarchy) Randomization (for TPM Version 2.0 and above)

Select Enabled for Platform Hierarchy Randomization support, which is used only during the platform developmental stage. This feature cannot be enabled in the production platforms. The options are **Disabled** and Enabled.

TXT Support

Select Enabled to enable Intel Trusted Execution Technology (TXT) support to enhance system security and data integrity. The options are **Disabled** and Enabled.



Note 1: If the option for this item (TXT Support) is set to Enabled, be sure to disable EV DFX (Device Function On-Hide) support for the system to work properly. (EV DFX is under "IIO Configuration" in the "Chipset/North Bridge" submenu).



Note 2: For more information on TPM, please refer to the TPM manual at http://www. supermicro.com/manuals/other.

▶TLS Authenticate Configuration

When this submenu is selected, the following items will be displayed:

▶Server CA Configuration

This feature allows the user to configure the client certificate that is to be used by the server.

▶Enroll Certification

This feature allows the user to enroll the certificate in the system.

▶Enroll Cert (Certification) Using File

This feature allows the user to enroll the security certificate in the system by using a file.

Cert (Certification) GUID (Global Unique Identifier)

This feature displays the GUID for this system.

▶Commit Changes and Exit

Select this feature to keep the changes you have made and exit from the system.

▶Discard Changes and Exit

Select this feature to discard the changes you have made and exit from the system.

▶ Delete Certification

If this feature is set to Enable, the certificate enrolled in the system will be deleted. The options are Enable and **Disable**.

▶ Client Certification Configuration

This feature allows the user to configure the client certificate to be used by the server.

▶Enroll Certification

This feature allows the user to enroll the certificate in the system.

▶Enroll Cert (Certification) Using File

This feature allows the user to enroll the security certificate in the system by using a file.

Cert (Certification) GUID (Global Unique Identifier)

This feature displays the GUID for this system.

▶Commit Changes and Exit

Select this feature to keep the changes you have made and exit from the system.

▶Discard Changes and Exit

Select this feature to discard the changes you have made and exit from the system.

▶Delete Certification

If this feature is set to Enable, the certificate enrolled in the system will be deleted. The options are Enable and **Disable**.

▶RAM Disk Configuration

This feature allows the user to configure the settings for the RAM disks installed in the system. When you select this submenu and press <Enter>, the following items will display:

• Disk Memory Type: This feature specifies the type of memory that is available for you to create a RAM disk. The options are **Boot Service Data** and Reserved.

▶Create Raw

This feature allows the user to create a raw RAM disk from all available memory modules in the system. When you select this submenu and press <Enter>, the following items will display:

- Size (Hex): Use this feature to set the size of the raw RAM disk. The default setting is 1.
- Create & Exit: Select this feature when you want to exit from this submenu after you've created a raw RAM disk.
- **Discard & Exit**: Select this feature when you want to abandon the changes you've made and to exit from the submenu.

▶Create from File

This feature allows the user to create a RAM disk from a file specified by the user. Select this submenu and press <Enter>, the following items will display:

- Create RAM Disk List: Use this feature to create a RAM disk list.
- Remove Selected RAM Disk(s): Use this feature to delete the RAM disk(s) specified by the user.

▶Intel® Optane® DC Persistent Memory Configuration

When you select this submenu and press <Enter>, the following screen will display:

- Version: This feature displays the version of DCPMM used in the system.
- Select an action below
- Detected DIMMs: This feature displays the number of DCPMM memory modules detected by the BOS.
- All DIMMs are healthy (The health status of the DCPMM is displayed.)

▶DIMMs

This submenu allows the user to view and configure the settings of the DCPMM memory modules installed in the system. Select this submenu and press <Enter>, the following items will display:

- Select a specific DIMM that you want to view.
- DIMMs on Socket 0x0000:
- DIMMs on Socket 0x0001:

▶DIMM ID

This submenu allows the user to view and to perform an action on a DCPMM module specified by the user. When this submenu is selected, the following items will display:

- **DIMM UID**: This feature displays the unique ID of the DCPMM module.
- DIMM Handle: This feature displays the unique handle that the CPU assigns to the DCPMM module.
- **DIMM Physical ID:** This feature displays the physical ID of the DCPMM module.
- Manageability State: This feature indicates the manageability state of the DCPMM module.
- Health State: This feature indicates the health state of the DCPMM module.
- **Health State Reason:** This feature indicates the reason that effectuates the health state of the DCPMM module.
- Capacity: This feature indicates the capacity of the DCPMM module.
- Firmware Version: This feature indicates the firmware version of the DCPMM module.
- Firmware API Version: This feature indicates the firmware API version of the DCPMM module.
- Lock State: This feature indicates the lock state of the DCPMM module.
- **Staged Firmware Version:** This feature indicates the staged firmware version of the DCPMM module.
- **Firmware Update Status:** This feature indicates the firmware update status of the DCPMM module.
- Manufacturer: This feature indicates the manufacturer of the DCPMM module.

Show More Details

Select Enabled to view more detailed information on the DCPMM module. The options are **Disabled** and Enabled.

*If this option is set to Enabled, the following items will display:

- Serial Number
- Part Number
- Socket
- Memory Controller ID
- Vendor ID
- Device ID



- System Vendor ID
- Subsystem Vendor ID
- Subsystem Device ID
- Device Locator
- Subsystem Revision ID
- Interface Format Code
- Manufacturing Information Valid
- · Manufacturing Date
- Manufacturing Location
- Memory Type
- Memory Bank Label
- Data Width Label [b]
- Total Width [b]
- Speed [MHz]
- Channel ID
- · Channel Position
- Revision ID
- Form Factor
- Manufacturer ID
- · Controller Revision ID
- IS New
- Memory Capacity
- APP Direct Capacity
- Unconfigured Capacity

- Inaccessible Capacity
- Reserved Capacity
- Peak Power Budget [mW]
- Avg (Average) Power Budget [mW]
- Max Average Power Budget [mW]
- Package Sparing Capable
- Package Sparing Enabled
- Package Spares Available
- Configuration Status
- SKU Violation
- ARS Status
- Overwrite DIMM Status
- · Last Shutdown Time
- First Fast Refresh
- Viral Policy Enable
- Viral State
- · Latched Last Shutdown Status
- Unlatched Last Shutdown Status
- · Security Capabilities
- · Modes Supported
- Boot Status
- AIT DRAM Enabled
- Error Injection Enabled
- Media Temperature Injection Enabled
- Software Triggers Enabled
- Software Triggers Enabled Details



- Poison Error Injections Counter
- Poison Error Clear Counter
- Media Temperature Injections Counter
- Software Triggers Counter
- · Master Passphrase Enabled

▶ Monitor Health

Select this submenu to view the health status and thresholds of the DCPMM module specified by the user.

- Sensor Type: This feature displays the type of health items that are being monitored.
- Value: This feature displays the value of the monitor sensor mentioned above.
- Non-critical Thresholds: This feature displays the normal threshold value for the DCPMM module to maintain normal operations.
- **Critical Lower Threshold:** This feature displays the lowest threshold value for the DCPMM module to maintain normal operations.
- Critical Upper Threshold: This feature displays the higher threshold value for the DCPMM module to maintain normal operations.
- Fatal Threshold: This feature indicates the highest value allowed for the DCPMM module to remain functional. Beyond this value, the DCPMM selected will become non-operational.
- State: This feature indicates the health state of the DCPMM module.
- Alarm Enabled State: This feature indicates the status of the non-critical threshold alarm for the DCPMM module specified by the user.
- Modify Non-critical Thresholds: Use this feature to modify non-critical thresholds.
- Controller Temperature: This feature displays the controller temperature in Celsius.
- Media Temperature: This feature displays the media temperature in Celsius.
- Percentage Remaining

▶Apply Changes

Use this feature to apply changes that you've made on the DCPMM modules to the system.

▶Back to Main Menu

Select this feature and press <Enter> to go back to the Intel® Optane® DC Persistent Memory Configuration menu.



▶Update Firmware

Use this feature to select the firmware image to be loaded on the DCPMM module. Once it is loaded to the system, please reboot the system and select update for the firmware to take effect. The following items will display:

- Current Firmware Version: This feature displays the current firmware version.
- **Selected Firmware Version**: This feature allows the user to select a new firmware version to use.
- **File:** This feature allows the user to specify the file path in the root directory that contains the new firmware for firmware update.
- **Staged Firmware Version:** This feature indicates the staged firmware version of the DCPMM module specified by the user.

▶Update

Select this feature to update the firmware settings.

▶Back to Main Menu

Select this feature and press <Enter> to go back to the Intel® Optane® DC Persistent Memory Configuration menu.

▶Configure Security

Use this feature to configure the security settings for all onboard DCPMM modules.

State

Select Enabled to configure the security settings for the DCPMM modules installed in the system. The options are **Disabled** and Enabled.

- Enable Security: Use this feature to enable security settings for the onboard DCPMM modules.
- Secure Erase: Use this feature to erase all the persistent data saved in the DCPMM modules.
- Freeze Lock: Use this feature to enable the security lock for the onboard DCPMM modules.

▶Back to Main Menu

• Select this feature and press <Enter> to go back to the Intel® Optane® DC Persistent Memory Configuration menu.

▶Configure Data Policy

Use this feature to configure the data policy settings for all onboard DCPMM modules.

First Fast Fresh State

Select Enabled to display the First Fast Fresh state for onboard DCPMM modules.

► Enable First Fast Fresh State

Select Enabled to support the first fast fresh state of DCPMM data policy.

▶Disable First Fast Fresh State

Select Disable to disable the first fast fresh state of DCPMM data policy.

▶Back to Main Menu

Select this feature and press <Enter> to go back to the Intel® Optane® DC Persistent Memory Configuration menu.

▶ Regions

Current Configuration

▶ Region ID

When this submenu is selected, the following items will display:

- Region ID: This feature displays the Region ID of the DCPMM module.
- **DIMM ID:** This feature displays the DIMM ID of the DCPMM module.
- **ISet ID:** This feature displays the ISet ID of the DCPMM module.
- Persistent Memory Type: This feature indicates the persistent memory type of the DCPMM module.
- Capacity: This feature indicates the capacity of the DCPMM module.
- Free Capacity: This feature indicates the capacity of the DCPMM module that is available for use.
- **Health:** This feature indicates the health state of the DCPMM module.
- Socket ID: This feature displays the Socket ID of the DCPMM module.

Persistent Memory Type

Capacity

Free Capacity



▶Create Goal Configuration

When this submenu is selected, the following items will display:

- Create Goal Configuration for: Use this feature to select the target to create goal configuration for the DCPMM modules. The options are Platform and Socket.
- Reserved [%]: Use this feature to reserve a percentage of the DCPMM capacity for a particular purpose and keep this portion of memory space from being mapped into the physical address of system for system use.
- **Memory Mode** [%]: Use this feature to reserve a percentage of the DCPMM capacity for special use in a specific Memory Mode. Please note that this value can be automatically set by the system.

Persistent Memory Type

This feature allows the user to specify the type of DCPMM memory capacity to be created. The options are **App Direct** and App Direct Not Interleave.

Namespace Label Version

Use this feature to view and modify the namespace label version to initialize when creating goals. The options are **1.2** and 1.1.

▶ Back to Regions Menu

Select this feature and press <Enter> to go back to the Regions submenu.

▶Back to Main Menu

Select this feature and press <Enter> to go back to the Intel® Optane® DC Persistent Memory Configuration menu.

▶Namespaces

This subsection allows the user to select a namespace to view the following information on the selected namespace

Namespace ID/Name/Heath Status

▶0x00000201

Select this feature and press <Enter>, the following items will display:

- UUID
- ID
- Name
- Region
- Health



- Mode
- Block Size
- Units: Use this feature to change the namespace capacity (in the unit of B, MB, MiB, GB, **GiB**, TB, and TiB.)
- Capacity
- Label Version
- ▶Save: After configuring the settings for the namespace above, click on <Save> to save changes.
- ▶ Delete After configuring the settings for the namespace above, click on <delete> to delete the changes you've made on the namespace. Please note that all data contained in the namespace will be deleted as well when you press <delete>.
- **▶**Back to Namespaces
- ▶ Back to Main Menu

▶Create Namespace

Use this submenu to create a namespace. The following information will display:

Name

Region ID

This feature displays the region ID of the DCPMM module. The options are **0x0001** and 0x0002.

Mode

Use this item to set the Namespace mode. The options are **None** and Sector.

Capacity Input

Select Remaining to use the maximum memory capacity currently available as system memory capacity. Select Manual to enter the system memory capacity manually. The options are **Remaining** and Manual.

Units

Use this feature to select the type of unit to use when inputting namespace capacity in the system.

The options are B, MB, MiB, GB, GiB, TB, and TiB.

Capacity: This feature displays the namespace capacity.

▶Back to Namespace

Select this feature and press <Enter> to go back to the Namespaces submenu.

▶Back to Main Menu

Select this feature and press <Enter> to go back to the Intel® Optane® DC Persistent Memory Configuration menu.

▶ Total Capacity

This feature allows the user to set the total DCPMM resource capacity allocated across all segments in the host server.

- Raw Capacity: This feature specifies the raw capacity of the DCPMM module.
- App. Direct Capacity: This feature specifies the App. direct capacity of the DCPMM module.
- Memory Capacity: This feature specifies the memory capacity of the DCPMM module.
- **Unconfigured Capacity**: This feature specifies the capacity of the DCPMM module that has not been configured.
- **Inaccessible Capacity**: This feature specifies the capacity of the DCPMM memory that is not accessible to the user.
- **Reserved Capacity**: This feature specifies the capacity of the DCPMM memory that is reserved for a particular use.

▶Back to Main Menu

Select this feature and press <Enter> to go back to the Intel® Optane® DC Persistent Memory Configuration menu.

▶Diagnostics

Perform Diagnostic Tests on DIMMs

When you select this submenu and press <enter>, the following items will display:

Choose Diagnostics Type:

Quick Diagnostics

Select Enabled for the quick diagnostics test to be performed on the DCPMM module installed in the system when needed. The options are **Enabled** and Disabled.

DIMM ID

Select Enabled for the quick diagnostics test to be performed on the DCPMM module. The options are **Enabled** and Disabled. (**Note**: More DIMM IDs will appear If more DCPMM modules are installed on the motherboard.)



Config (Configure) Diagnostics

Select Enabled for the platform configuration diagnostics test to be performed on the DCPMM module. The options are **Enabled** and Disabled.

FW (Firmware) Diagnostics

Select Enabled for the firmware diagnostics test to be performed on the DCPMM module. The options are **Enabled** and Disabled.

Security Diagnostics

Select Enabled for the security diagnostics test to be performed on the DCPMM module. The options are **Enabled** and Disabled.

▶ Execute Tests

Select this feature and press <Enter> to execute the selected diagnostic tests.

► Back to Main Menu

Select this feature and press <Enter> to go back to the Intel® Optane® DC Persistent Memory Configuration menu.

▶Preferences

View and/or modify user preferences

Default DIMM ID

This feature allows the user to view and to modify the default DIMM ID as displayed on the screen. The options are **Handle** and UID.

Capacity Units

This feature allows the user to view and to set the default capacity unit of the selected DCPMM to be displayed on the screen. The options are **Auto**, Auto_10, B, MB, MiB, GB, GiB, TB, and TiB.

App Direct Settings

This feature displays the Application Direct Settings. The default setting is **4KB_4KB** (**Recommended**).

App Direct Granularity

This feature allows the user to view and modify the minimum App Direct Granularity for each DIMM installed on the motherboard. The default setting is **Recommended** and 1.

► Back to Main Menu

Press this to return to the Intel® Optane® DC Persistent Memory Configuration menu.



4.4 Event Logs

Use this feature to configure Event Log settings.

Note: After you've made a change on a setting below, please be sure to reboot the system for the change to take effect.



► Change SMBIOS Event Log Settings

Enabling/Disabling Options

SMBIOS Event Log

Select Enabled to enable SMBIOS (System Management BIOS) Event Logging during system boot. The options are **Enabled** and Disabled.

Erasing Settings

Erase Event Log

Select "No" to keep the event log without erasing it upon next system bootup. Select "Yes, Next Reset" to erase the event log upon next system reboot. The options are "No", "Yes, Next Reset", and "Yes, Every Reset".

When Log is Full

Select Erase Immediately to immediately erase all errors in the SMBIOS event log when the event log is full. Select Do Nothing for the system to do nothing when the SMBIOS event log is full. The options are **Do Nothing** and Erase Immediately.

SMBIOS Event Log Standard Settings

Log System Boot Event

Select Enabled to log system boot events. The options are Enabled and Disabled.

MECI (Multiple Event Count Increment)

Enter the increment value for the multiple event counter. Enter a number between 1 to 255. The default setting is **1**.

METW (Multiple Event Count Time Window)

This feature is used to determine how long (in minutes) should the multiple event counter wait before generating a new event log. Enter a number between 0 to 99. The default setting is **60**.

▶View System Event Log

This feature allows the user to view the event in the system event log. Select this item and press <Enter> to view the status of an event in the log. The following categories are displayed: Date/Time/Error Code/Severity



4.5 **IPMI**





When you select this submenu and press the <Enter> key, the following information will display:

- IPMI Firmware Revision: This feature indicates the IPMI firmware revision used in your system.
- **Status of BMC**: This feature indicates the status of the BMC (Baseboard Management Controller) installed in your system.

► System Event Log

Enabling/Disabling Options

SEL Components

Select Enabled to enable all system event logging upon system boot. The options are **Enabled** and Disabled.

Erasing Settings

Erase SEL

Select "Yes, On next reset" to erase all system event logs upon next system boot. Select "Yes, On every reset" to erase all system event logs upon each system reboot. Select "No" to keep all system event logs after each system reboot. The options are "**No**", "Yes, On next reset", and "Yes, On every reset".



When SEL is Full

This feature allows the user to determine what the BIOS should do when the system event log is full. Select Erase Immediately to erase all events in the log when the system event log is full. The options are **Do Nothing** and Erase Immediately.

Note: After you've made a change on a setting below, please be sure to reboot the system for the change to take effect.

▶BMC Network Configuration

The following items will be displayed:

- IPMI LAN Selection: This feature displays the IPMI LAN setting. The default setting is **Failover**.
- IPMI Network Link Status: This feature displays the IPMI Network Link status. The default setting is **Dedicated LAN**.
- Station MAC Address: This feature displays the Station MAC address for this computer.
 Mac addresses are 6 two-digit hexadecimal numbers.
- VLAN: This feature displays the status of VLAN support. The default setting is **Disabled**.
- IPv4 Address Source: This feature displays the source of IPv4 addresses. The default setting is **DHCP**.
- Station IP Address: This feature displays the Station IP address for this computer. This should be in decimal and in dotted guad form (i.e., 192.168.10.253).
- Subnet Mask: This feature displays the sub-network that this computer belongs to. The value of each three-digit number separated by dots should not exceed 255.
- Gateway IP Address: This feature displays the Gateway IP address for this computer. This should be in decimal and in dotted quad form (i.e., 192.168.10.253).
- IPv6 Address Status: This feature displays the IPv6 address status. The default setting is
 Disabled.
- Station IPv6 Address: This feature displays the station IPv6 address.
- Prefix Length: This item displays the prefix length.
- IPv6 Router IP Address: This feature displays the IPv6 router IP address.

Update IPMI LAN Configuration

Select Yes for the BIOS to implement all IP/MAC address changes upon next system boot. The options are **No** and Yes. If this option is set to Yes, the following items will display:



IPMI LAN Selection (Available when Update IPMI LAN Configuration is set to Yes)

Use this feature to select the type of the IPMI LAN. The options are Dedicated, Shared, and **Failover**.

VLAN

Select Enabled to enable IPMI VLAN function support. The default setting is **Disabled**.

Configuration Address Source

Use this feature to select the IP address source for this computer. If Static is selected, you will need to know the IP address of this computer and enter it to the system manually in the field. If DHCP is selected, AMI BIOS will search for a DHCP (Dynamic Host Configuration Protocol) server attached to the network and request the next available IP address for this computer. The options are **DHCP** and Static.

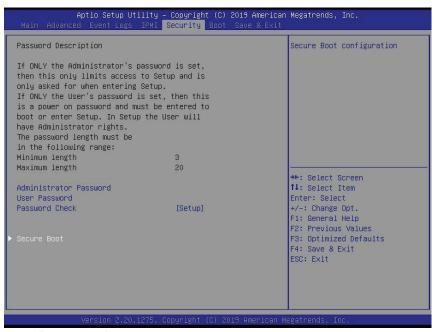
IPv6 Support: Select Enabled for IPv6 support. The options are Enabled, and **Disabled**. If this option is set to Enabled, the following item will display:

Configuration Address Source: Use this feature to select the IP address source for this computer. If Static is selected, you will need to know the IP address of this computer and enter it to the system manually in the field. If DHCP is selected, AMI BIOS will search for a DHCP (Dynamic Host Configuration Protocol) server attached to the network and request the next available IP address for this computer. The options are DHCP and Static



4.6 Security Settings

This menu allows the user to configure the following security settings for the system.



Administrator Password

Use this feature to set the administrator password which is required to enter the BIOS setup utility. The length of the password should be from 3 characters to 20 characters long.

User Password

Use this feature to set the user password which is required to enter the BIOS setup utility. The length of the password should be from 3 characters to 20 characters long.

Password Check

Select Setup for the system to check for a password at Setup. Select Always for the system to check for a password at system boot and upon entering the BIOS Setup utility. The options are **Setup** and Always.

▶Secure Boot

When you select this submenu and press the <Enter> key, the following items will display:

· System Mode

Secure Boot

Select Enabled to use Secure Boot settings. The options are Enabled and Disabled.

Secure Boot Mode

Use this feature to select the desired secure boot mode for the system. The options are Standard and **Custom**.

CMS Support

If this feature is set to Enabled, legacy devices will be supported by the system. The options are **Enabled** and Disabled.

▶ Restore Factory Keys

Select Yes to restore manufacturer default keys used to ensure system security. The options are **Yes** and No.

▶ Reset to Setup Mode

Select Yes to reset the system to the Setup Mode. The options are Yes and No.

▶Key Management

Vendor Keys

Factory Key Provision

Select Yes to install manufacturer default keys for system security use. The options are Enabled and **Disabled**.

▶ Restore Factory Keys

Select Yes to restore all manufacturer default keys for system security use. The options are **Yes** and No.

▶ Reset to Setup Mode

This feature resets the system to Setup Mode.

▶Export Secure Boot Variables

This feature is used to copy the NVRAM content of Secure Boot variables to a storage device.

▶Enroll EFI Image

Select this feature and press <Enter> to specify an EFI (Extensible Firmware Interface) image for the system to use when it operates in the Secure Boot mode.

Device Guard Ready

▶ Remove 'UEFI CA' from DB

Select Yes to remove UEFI CA from the database. The options are **Yes** and No.

▶ Restore DB defaults

Select Yes to restore database variables to the manufacturer default settings. The options are **Yes** and No.

Secure Boot Variable/Size/Keys/Key Source

▶Platform Key (PK)

This feature allows the user to enter and configure a set of values to be used as platform firmware keys for the system. The sizes, keys numbers, and key sources of the platform keys will be indicated as well. Select Update to update the platform key.

▶ Key Exchange Keys

This feature allows the user to enter and configure a set of values to be used as Key-Exchange-Keys for the system. The sizes, keys numbers, and key sources of the Key-Exchange-Keys will be indicated as well. Select Update to update your "Key Exchange Keys". Select Append to append your "Key Exchange Keys".

► Authorized Signatures

This feature allows the user to enter and configure a set of values to be used as Authorized Signatures for the system. These values also indicate the sizes, keys numbers, and the sources of the authorized signatures. Select Update to update your "Authorized Signatures". Select Append to append your "Authorized Signatures". The settings are Details, Export, Update, Append, and Delete.



▶ Forbidden Signatures

This feature allows the user to enter and configure a set of values to be used as Forbidden Signatures for the system. These values also indicate sizes, keys numbers, and key sources of the forbidden signatures. Select Update to update your "Forbidden Signatures". Select Append to append your "Forbidden Signatures". The settings are Details, Export, Update, Append, and Delete.

▶Authorized TimeStamps

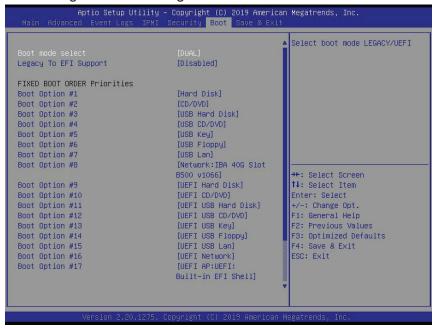
This feature allows the user to set and save the timestamps for the authorized signatures which will indicate the time when these signatures are entered into the system. Select Update to update your "Authorized TimeStamps". Select Append to append your "Authorized TimeStamps". The settings are Update, and Append.

▶Os Recovery Signatures

This feature allows the user to set and save the authorized signatures used for OS recovery. Select Update to update your "OS Recovery Signatures". Select Append to append your "OS Recovery Signatures". The settings are Update, and Append.

4.7 Boot Settings

Use this feature to configure Boot Settings:



Boot Mode Select

Use this feature to select the type of devices from which the system will boot. The options are Legacy, UEFI (Unified Extensible Firmware Interface), and **Dual**.

Legacy to EFI Support

Select Enabled for the system to boot from an EFI OS when the Legacy OS fails. The options are Enabled and **Disabled**.

Fixed Boot Order Priorities

This feature prioritizes the order of a bootable device from which the system will boot. Press <Enter> on each item sequentially to select devices.

When the item above -"Boot Mode Select" is set to **Dual** (default), the following items will be displayed for user's configuration:

Boot Option #1 - Boot Option #17

When the item above -"Boot Mode Select" is set to Legacy, the following items will be displayed for configuration:

• Boot Option #1 - Boot Option #8

When the item above -"Boot Mode Select" is set to UEFI, the following items will be displayed for configuration:

• Boot Option #1 - Boot Option #9

Add New Boot Option

This feature allows the user to add a new boot option to the boot priority features for system boot.

Add Boot Option

Use this item to specify the name for the new boot option.

Path for Boot Option

Use this feature to enter the path for the new boot option in the format fsx:\path\filename.efi.

Boot Option File Path

Use this feature to specify the file path for the new boot option.

Create

After the name and the file path for the boot option are set, press <Enter> to create the new boot option in the boot priority list.

▶ Delete Boot Option

Use this feature to select a boot device to delete from the boot priority list.

Delete Boot Option

Use this feature to remove an EFI boot option from the boot priority list.

► Add New Driver Option

Use this feature to select a new driver to add to the boot priority list.

Add Driver Option

Use this feature to specify the name of the driver to be added to the boot priority list.

Path for Drover Option

Use this feature to specify the path to the driver that will be added to the boot priority list.

Driver Option File Path

Use this feature to specify the file path of the driver that will be added to the boot priority list.

Create

After the driver option name and the file path are set, press <Enter> to enter to submenu and click OK to create the new boot option drive.



▶ Delete Driver Option

Use this item to select a boot driver to delete from the boot priority list.

Delete Drive Option

Select the target boot driver to delete from the boot priority list.

► Hard Disk Drive BBS Priorities

• Boot Option #1 - #5

► USB Key Drive BBS Priorities

• Boot Option #1

▶UEFI Application Boot Priorities

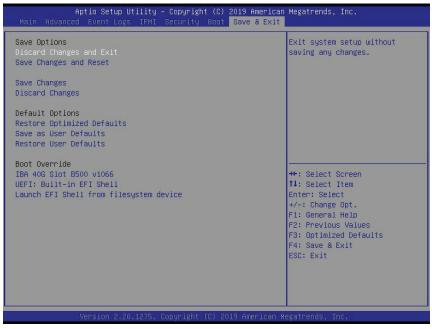
• Boot Option #1

► Network Drive BBS Priorities

• Boot Option #1

4.8 Save & Exit

Select the Save & Exit menu from the BIOS setup screen to configure the settings below.



Save Options

Discard Changes and Exit

Select this option to exit from the BIOS setup utility without making any permanent changes to the system configuration and reboot the computer.

Save Changes and Reset

When you have completed the system configuration changes, select this option to leave the BIOS setup utility and reboot the computer for the new system configuration parameters to become effective.

Save Changes

When you have completed the system configuration changes, select this option to save all changes made. This will not reset (reboot) the system.

Discard Changes

Select this option and press <Enter> to discard all the changes you've made and return to the AMI BIOS setup utility.

Default Options

Restore Optimized Defaults

To set this feature, select Restore Defaults from the Exit menu and press <Enter> to load manufacturer default settings which are intended for maximum system performance but not for maximum stability.

Save As User Defaults

To set this feature, select Save as User Defaults from the Exit menu and press <Enter>. This enables the user to save all changes to the BIOS setup for future use.

Restore User Defaults

To set this feature, select Restore User Defaults from the Exit menu and press <Enter>. Use this feature to retrieve user-defined default settings that were saved previously.

Boot Override

This feature allows the user to override the Boot priorities sequence in the Boot menu, and immediately boot the system with a device specified by the user instead of the one specified in the boot list. This is a one-time override.

IBA 40G Slot BA 500 v1066

UEFI: Built-in EFI Shell

Launch EFI Shell from filesystem device

Appendix A

BIOS Codes

A.1 BIOS Error POST (Beep) Codes

During the POST (Power-On Self-Test) process, which is performed each time the system is powered on, system errors may be detected.

Non-fatal errors are those which, in most cases, allow the system to continue with the bootup process. The error messages normally appear on the screen.

Fatal errors are those which will not allow the system to continue to boot up. If a fatal error occurs, you should consult with your system manufacturer for possible repairs.

The fatal errors are usually communicated through repeated patterns of audible beeps. Each pattern of audible beeps listed below corresponds to its respective error.

BIOS Beep (POST) Codes		
Beep Code	Error Message	Description
1 beep	Refresh	Circuits have been reset (Ready to power up)
5 short, 1 long	Memory error	No memory detected in system
5 long, 2 short	Display memory read/write error	Video adapter missing or with faulty memory
1 long continuous	System OH	System overheat condition

A.2 Additional BIOS POST Codes

The AMI BIOS supplies additional checkpoint codes, which are documented online at http://www.supermicro.com/support/manuals/ ("AMI BIOS POST Codes User's Guide").

When BIOS performs the Power On Self Test, it writes checkpoint codes to I/O port 0080h. If the computer cannot complete the boot process, a diagnostic card can be attached to the computer to read I/O port 0080h (Supermicro p/n AOC-LPC80-20).

For information on AMI updates, please refer to http://www.ami.com/products/.

Appendix B

Software Installation

B.1 Installing Software Programs

The Supermicro website that contains drivers and utilities for your system is located at http://www.supermicro.com/wftp. Some of these must be installed, such as the chipset driver.

After accessing the product drivers and utilities page, go into the CDR_Images directory and locate the ISO file for your motherboard. Download this file to create a DVD of the drivers and utilities it contains. (You may also use a utility to extract the ISO file if preferred.)

After creating a DVD with the ISO files, insert the disk into the DVD drive on your system and the display shown in Figure B-1 should appear.

Another option is to go to the Supermicro website at http://www.supermicro.com/products/. Find the product page for your motherboard here, where you may download individual drivers and utilities to your hard drive or a USB flash drive and install from there.



Note: Please refer to the documents posted on our website at http://www.supermicro.com/support/manuals/ for additional instructions that may be applicable to your system.

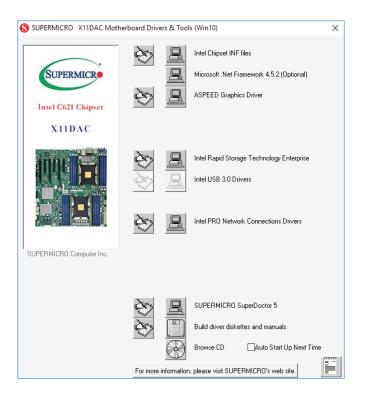


Figure B-1. Driver/Tool Installation Display Screen

Click the icons showing a hand writing on the paper to view the readme files for each item. Click a computer icon to the right of an item to install an item (from top to the bottom) one at a time. After installing each item, you must reboot the system before proceeding with the next item on the list. The bottom icon with a DVD on it allows you to view the entire contents of the DVD.

When making a storage driver diskette by booting into a driver DVD, please set the SATA Configuration to "Compatible Mode" and configure SATA as IDE in the BIOS Setup. After making the driver diskette, be sure to change the SATA settings back to your original settings.

B.2 SuperDoctor® 5

The Supermicro SuperDoctor 5 is a hardware monitoring program that functions in a command-line or web-based interface in Windows and Linux operating systems. The program monitors system health information such as CPU temperature, system voltages, system power consumption, fan speed, and provides alerts via email or Simple Network Management Protocol (SNMP).

SuperDoctor 5 comes in local and remote management versions and can be used with Nagios to maximize your system monitoring needs. With SuperDoctor 5 Management Server (SSM Server), you can remotely control power on/off and reset chassis intrusion for multiple systems with SuperDoctor 5 or IPMI. SD5 Management Server monitors HTTP, and SMTP services to optimize the efficiency of your operation.



Note: The default Username and Password for SuperDoctor 5 is ADMIN / ADMIN.

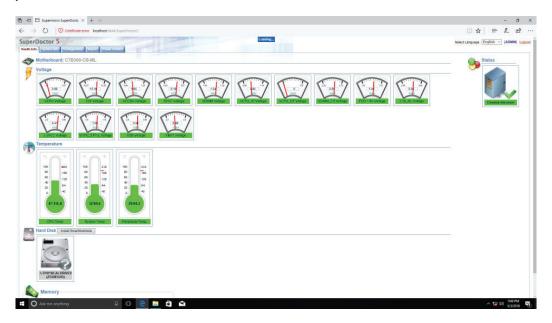


Figure B-2. SuperDoctor 5 Interface Display Screen (Health Information)



Note: The SuperDoctor 5 program and user's manual can be downloaded from the Supermicro website at http://www.supermicro.com/products/nfo/sms_sd5.cfm.

Appendix C

Standardized Warning Statements

The following statements are industry standard warnings, provided to warn the user of situations which have the potential for bodily injury. Should you have questions or experience difficulty, contact Supermicro's Technical Support department for assistance. Only certified technicians should attempt to install or configure components.

Read this section in its entirety before installing or configuring components.

These warnings may also be found on our website at http://www.supermicro.com/about/policies/safety_information.cfm.

Battery Handling



Warning! There is the danger of explosion if the battery is replaced incorrectly. Replace the battery only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions

電池の取り扱い

電池交換が正しく行われなかった場合、破裂の危険性があります。交換する電池はメーカーが推奨する型、または同等のものを使用下さい。使用済電池は製造元の指示に従って処分して下さい。

警告

电池更换不当会有爆炸危险。请只使用同类电池或制造商推荐的功能相当的电池更换原有电 池。请按制造商的说明处理废旧电池。

警告

電池更換不當會有爆炸危險。請使用製造商建議之相同或功能相當的電池更換原有電池。請按 照製造商的說明指示處理廢棄舊電池。

Warnung

Bei Einsetzen einer falschen Batterie besteht Explosionsgefahr. Ersetzen Sie die Batterie nur durch den gleichen oder vom Hersteller empfohlenen Batterietyp. Entsorgen Sie die benutzten Batterien nach den Anweisungen des Herstellers.

Attention

Danger d'explosion si la pile n'est pas remplacée correctement. Ne la remplacer que par une pile de type semblable ou équivalent, recommandée par le fabricant. Jeter les piles usagées conformément aux instructions du fabricant.

¡Advertencia!

Existe peligro de explosión si la batería se reemplaza de manera incorrecta. Reemplazar la batería exclusivamente con el mismo tipo o el equivalente recomendado por el fabricante. Desechar las baterías gastadas según las instrucciones del fabricante.

!אזהרה

קיימת סכנת פיצוץ של הסוללה במידה והוחלפה בדרך לא תקינה. יש להחליף את הסוללה בסוג התואם מחברת יצרן מומלצת. סילוק הסוללות המשומשות יש לבצע לפי הוראות היצרן.

هناك خطر من انفجار في حالة اسحبذال البطارية بطريقة غير صحيحة فعليل اسحبذال البطارية فعليا البطارية فعليا فقط بنفس النبع أو ما يعادلها مما أوصث به الشرمة المصنعة حخلص من البطاريات المسحعملة وفقا لحعليمات الشرمة الصانعة

경고!

배터리가 올바르게 교체되지 않으면 폭발의 위험이 있습니다. 기존 배터리와 동일하거나 제조사에서 권장하는 동등한 종류의 배터리로만 교체해야 합니다. 제조사의 안내에 따라 사용된 배터리를 처리하여 주십시오.

Waarschuwing

Er is ontploffingsgevaar indien de batterij verkeerd vervangen wordt. Vervang de batterij slechts met hetzelfde of een equivalent type die door de fabrikant aanbevolen wordt. Gebruikte batterijen dienen overeenkomstig fabrieksvoorschriften afgevoerd te worden.

Product Disposal



Warning! Ultimate disposal of this product should be handled according to all national laws and regulations.

製品の廃棄

この製品を廃棄処分する場合、国の関係する全ての法律・条例に従い処理する必要があります。

警告

本产品的废弃处理应根据所有国家的法律和规章进行。

警告

本產品的廢棄處理應根據所有國家的法律和規章進行。

Warnung

Die Entsorgung dieses Produkts sollte gemäß allen Bestimmungen und Gesetzen des Landes erfolgen.

¡Advertencia!

Al deshacerse por completo de este producto debe seguir todas las leyes y reglamentos nacionales.

Attention

La mise au rebut ou le recyclage de ce produit sont généralement soumis à des lois et/ou directives de respect de l'environnement. Renseignez-vous auprès de l'organisme compétent.

סילוק המוצר

!אזהרה

סילוק סופי של מוצר זה חייב להיות בהתאם להנחיות וחוקי המדינה.

التخلص النهائي من هذا المنتج ينبغي التعامل معه وفقا لجميع القبانين واللبائح البطنية عند

경고!

이 제품은 해당 국가의 관련 법규 및 규정에 따라 폐기되어야 합니다.

Waarschuwing

De uiteindelijke verwijdering van dit product dient te geschieden in overeenstemming met alle nationale wetten en reglementen.

Appendix D

UEFI BIOS Recovery

Warning: Do not upgrade the BIOS unless your system has a BIOS-related issue. Flashing the wrong BIOS can cause irreparable damage to the system. In no event shall Supermicro be liable for direct, indirect, special, incidental, or consequential damages arising from a BIOS update. If you need to update the BIOS, do not shut down or reset the system while the BIOS is updating to avoid possible boot failure.

D.1 Overview

The Unified Extensible Firmware Interface (UEFI) provides a software-based interface between the operating system and the platform firmware in the pre-boot environment. The UEFI specification supports an architecture-independent mechanism that will allow the UEFI OS loader stored in an add-on card to boot the system. The UEFI offers clean, hands-off management to a computer during system boot.

D.2 Recovering the UEFI BIOS Image

A UEFI BIOS flash chip consists of a recovery BIOS block and a main BIOS block (a main BIOS image). The recovery block contains critical BIOS codes, including memory detection and recovery codes for the user to flash a healthy BIOS image if the original main BIOS image is corrupted. When the system power is turned on, the recovery block codes execute first. Once this process is complete, the main BIOS code will continue with system initialization and the remaining POST (Power-On Self-Test) routines.



Note 1: Follow the BIOS recovery instructions below for BIOS recovery when the main BIOS block crashes.

Note 2: When the BIOS recovery block crashes, you will need to follow the procedures to make a Returned Merchandise Authorization (RMA) request. (For a RMA request, please see section 3.5 for more information). Also, you may use the Supermicro Update Manager (SUM) Out-of-Band (OOB) (https://www.supermicro.com.tw/products/nfo/SMS_SUM.cfm) to reflash the BIOS.

D.3 Recovering the Main BIOS Block with a USB Device

This feature allows the user to recover the main BIOS image using a USB-attached device without additional utilities used. A USB flash device such as a USB Flash Drive, or a USB CD/DVD ROM device can be used for this purpose. However, a USB Hard Disk drive cannot be used for BIOS recovery at this time.

The file system supported by the recovery block is FAT (including FAT12, FAT16, and FAT32) which is installed on a bootable or non-bootable USB-attached device. However, the BIOS might need several minutes to locate the SUPER.ROM file if the media size becomes too large due to the huge volumes of folders and files stored in the device.

To perform UEFI BIOS recovery using a USB-attached device, follow the instructions below.

1. Using a different machine, copy the "Super.ROM" binary image file into the Root "\" directory of a USB device or a writable CD/DVD.



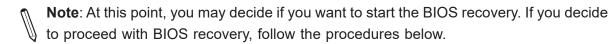
Notes: 1. If you cannot locate the "Super.ROM" file in your drive disk, visit our website at www.supermicro.com to download the BIOS package. Extract the BIOS binary image into a USB flash device and rename it "Super.ROM" for the BIOS recovery use. **2.** Before recovering the main BIOS image, confirm that the "Super.ROM" binary image file you download is the same version or a close version meant for your motherboard.



2. Insert the USB device that contains the new BIOS image ("Super.ROM") into your USB drive and reset the system when the following screen appears.



3. After locating the healthy BIOS binary image, the system will enter the BIOS Recovery menu as shown below.



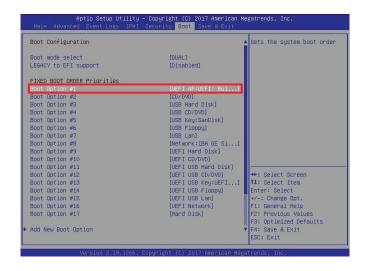


4. When the screen as shown above displays, use the arrow keys to select the item "Proceed with flash update" and press the <Enter> key. You will see the BIOS recovery progress as shown in the screen below.



Note: <u>Do not interrupt the BIOS flashing process until it has completed</u>.

- 5. After the BIOS recovery process is complete, press any key to reboot the system.
- 6. Using a different system, extract the BIOS package into a USB flash drive.
- 7. Press during system boot to enter the BIOS Setup utility. From the top of the tool bar, select Boot to enter the submenu. From the submenu list, select Boot Option #1 as shown below. Then, set Boot Option #1 to [UEFI AP:UEFI: Built-in EFI Shell]. Press <F4> to save the settings and exit the BIOS Setup utility.



8. When the UEFI Shell prompt appears, type fs# to change the device directory path. Go to the directory that contains the BIOS package you extracted earlier from Step 6. Enter flash.nsh BIOSname.### at the prompt to start the BIOS update process.

```
UEF1 Interactive Shell v2.1
ENK II
UEF1 V2.50 (American Megatrends, 0x0005000C)
Mapping table
Foi: Allas(s). Homo-foi: AUXL1
Foi:Reot(0x0)/Foi(0x14,0x0)/USB(0x11,0x0)/HD(1,MBR,0x37901D72,0x800,0x1

DASS2]
BUX0: Allas(s):
Foi:Reot(0x0)/Foi(0x14,0x0)/USB(0x11,0x0)
Press ESC in 1 seconds to skip startup.nsh or any other key to continue.
Shell) Foo:
Foi:AFINODS VO SUMPME2.03182017
FSO:VAFINODS VO SUMPME2.03182017
FSO:VAFINODS(SNJPME2.03182017)
F1394-NGFUROS(SNJPME2.03182017)
```

Note: <u>Do not interrupt this process</u> until the BIOS flashing is complete.



9. The screen above indicates that the BIOS update process is complete. When you see the screen above, unplug the AC power cable from the power supply, clear CMOS, and plug the AC power cable in the power supply again to power on the system.

```
Werlfulm NOB Block ...... done

- Update success for IE. -

- Successful Update Recovery Loader to OPRK!!

- Successful Update Recovery Loader to OPRK!!

- Successful Update IPSB!!

- Successful Update IPSB!!

- Successful Update IPSB!!

- Successful Update IPSB. IVBI and IVB2!!

- Successful Update IPSB. IVBI and IVB2!!

- HE Entire Image update success !!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to have the changes take effect!

MMNINE System must pose-off to the changes take effect!

MMNINE System must pose-off to the changes take effect!

MMNINE System must pose-off to the changes take effect!

MMNINE System must pose-off to the changes take effect!

MMNINE System must pose-off to the changes take effect!

MMNINE System must pose-off take the changes take effect!

MMNINE System must pose-off take the changes take effect!

MMNINE System must pose-off take the changes take effect!

MMNINE System must pose-off take the changes take effect!

MMNINE System must pose-off take the changes tak
```

- 10. Press to enter the BIOS Setup utility.
- 11. Press <F3> to load the default settings.
- 12. After loading the default settings, press <F4> to save the settings and exit the BIOS Setup utility.

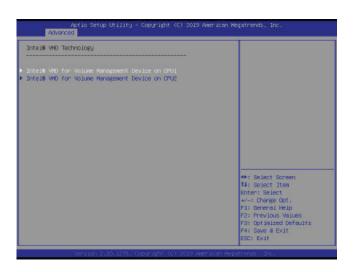
Appendix E

Configuring VROC RAID Settings

Intel® Virtual RAID on CPU (Intel® VROC) is a Redundant Array of Independent Disks (RAID) solution, which integrates with Intel® Volume Management Device (Intel® VMD), for Non-Volatile Memory Express (NVMe) solid-state drives (SSDs). The E.1 section provides instructions on how to access All Intel VMD Controllers menu items. The E.2 section explains RAID settings. The E.3 section describes the use of journaling drive for the RAID5 volume (parity based RAID).

E.1 All Intel® VMD Controllers Features

Press during system boot to enter the BIOS Setup utility. Navigate to the Advanced tab. Use the arrow keys and press <Enter> to select Chipset Configuration -> North Bridge -> IIO Configuration -> Intel® VMD Technology. The following screen will appear.



Step 1. Use the arrow keys to select Intel® VMD for Volume Management Device on CPU1 and press <Enter> to access the menu items.

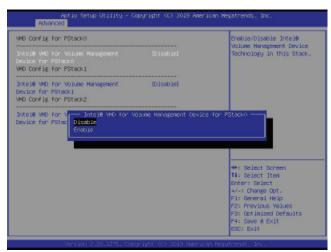
Note 1: Only use NVMe devices that have been validated by Supermicro. For the latest updates, please contact us or refer to our website at https://www.supermicro.com.tw/.

Note 2: Depending on the version of driver/utility/package, it may or may not have exactly the same as the BIOS settings/features shown in the appendix.

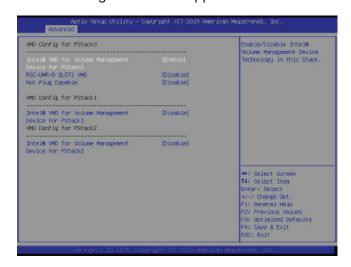
The following screen will appear.



Step 2. Intel® VMD for Volume Management Device for PStack0
The options are Disable and Enable. Set this feature to Enable.

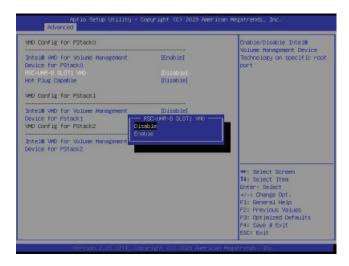


Press <Enter> and the following screen will appear.



Step 3. RSC-UMR-8 SLOT1 VMD

The feature is dependent on your motherboard/system and devices attached to the Intel® VMD controllers. The options are **Disable** and Enable. Set this feature to Enable.





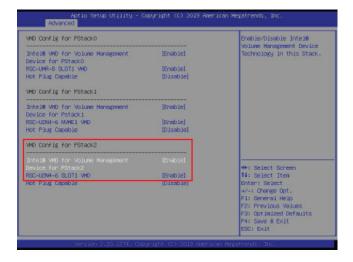
Step 4. Intel® VMD for Volume Management Device for PStack1, RSC-U2N4-6 NVME1 VMD

The options are **Disable** and Enable. Set the two features to Enable. (Refer to pages 138 and 139 for more information.)

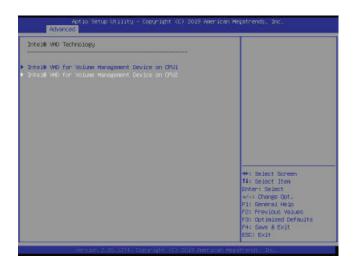


Step 5. Intel® VMD for Volume Management Device for PStack2, RSC-U2N4-6 SLOT1 VMD

The options are **Disable** and Enable. Set the two features to Enable. (Refer to pages 138 and 139 for more information.)

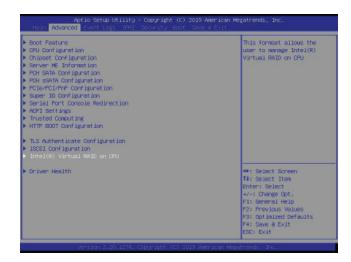


Press <Esc> and return to the main screen of Intel® VMD Technology as shown below. Use the arrow keys to select Intel® VMD for Volume Management Device on CPU2 and press <Enter> to access the menu items.



Repeat the steps (Step 1 ~ Step 5) on pages 137, 138, 139, and 140 to enable Intel® VMD for Volume Management Device for PStack0/PStack1/PStack2 and devices attached to the Intel® VMD controllers. For the changes to take effect, press <F4> to save the settings and exit the BIOS Setup utility. Press during system boot to enter the BIOS Setup utility.

Navigate to the Advanced tab.



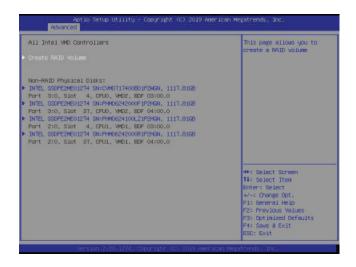
Use the arrow keys to select Intel(R) Virtual RAID on CPU and press <Enter> to access the menu items. The following screen will appear and the All Intel VMD Controllers feature has become available.



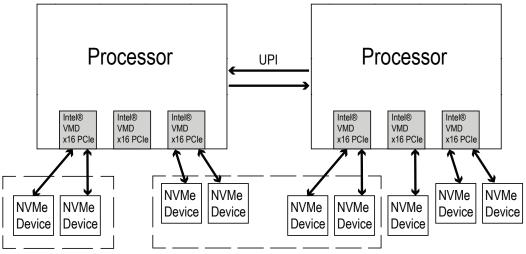
Note 1: The license and header (on the motherboard) for Intel® VROC hardware key are required. Also, be sure the version of Intel® Rapid Storage Technology enterprise (Intel® RSTe) VROC utility is 5 or above (look for Intel(R) VROC with VMD Technology x.x.x.xxxxx shown on the screen).

Note 2: Intel® VROC Premium hardware key is used in the appendix to demonstrate RAID settings.

Use the arrow keys to select All Intel VMD Controllers and press <Enter> to access the menu items. The following screen will appear. It allows the user to create RAID volumes and configure settings of NVMe devices as detected by the system.



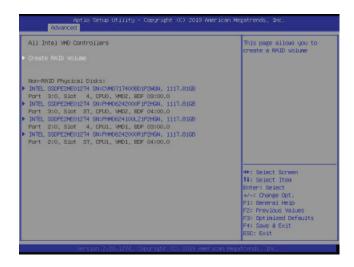
Note: A single Intel® VMD supported processor supplies 48 PCle lanes and contains three Intel® VMD controllers (domains). Refer to the following illustration for more information.



 $\ensuremath{^{\star}}$ Data RAID will be allowed to cross VMDs and processors.

E.2 Configuring RAID Settings

Refer to the instructions stated in E.1 section to access All Intel VMD Controllers menu items. Follow the steps below to create RAID volume(s).



Step 1. To create RAID volume(s), use the arrow keys to select Create RAID Volume and press <Enter>. The following screen will appear.



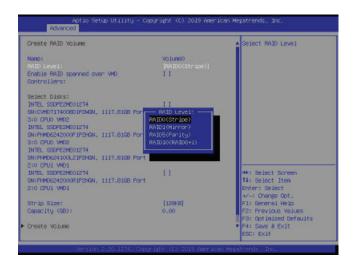
Step 2. Name:

This feature allows the user to enter the unique name of the RAID volume.



Step 3. RAID Level:

This feature allows the user to select the RAID level. The options are **RAID0(Stripe)**, RAID1(Mirror), RAID5(Parity), and RAID10(RAID0+1).

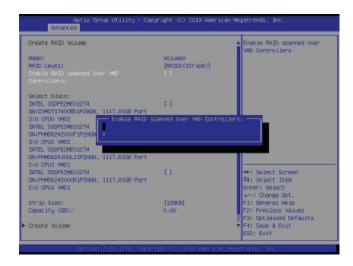


Note 1: The RAID level(s) displayed is(are) based on the number of NVMe devices connected to the system.

Note 2: Use Intel® VROC Standard hardware key to support RAID 0/1/10. Use Intel® VROC Premium hardware key (or Intel SSD Only hardware key) to support RAID 0/1/5/10.

Step 4. Enable RAID spanned over VMD Controllers

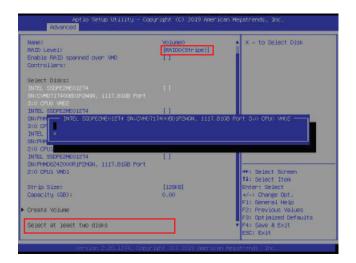
The options are **(not selected)** and X (selected). Set this feature to X if the RAID level you selected earlier from Step 3 will cross VMD domains.



Note: For a bootable RAID volume, do not cross VMD domains.

Step 5. Select Disks:

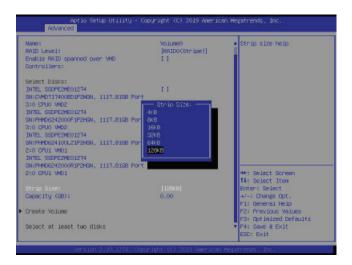
The options are **(not selected)** and X (selected). Set the features one by one to X to select the desired RAID disks.



Note: For RAID0/RAID1/RAID5/RAID10, the minimum number of NVMe devices required is two/two/three/four respectively.

Step 6. Strip Size:

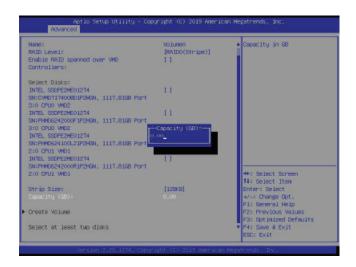
Use this feature to select the RAID strip size. The options are 4KB, 8KB, 16KB, 32KB, 64KB, and **128KB**.



Note: For RAID5, the options are 4KB, 8KB, 16KB, 32KB, **64KB**, and 128KB. For RAID10, the options are 4KB, 8KB, 16KB, 32KB, and **64KB**.

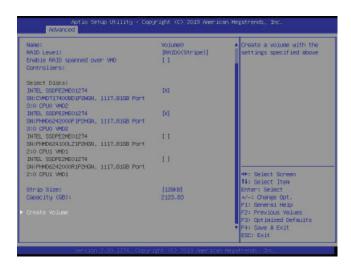
Step 7. Capacity (GB):

This feature allows the user to enter the desired RAID capacity (in GB).

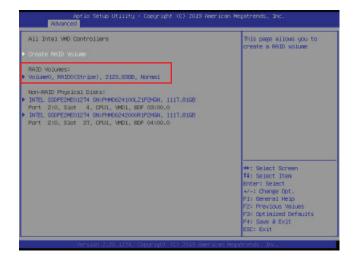


Step 8. Create Volume

Use the arrow keys to select Create Volume.

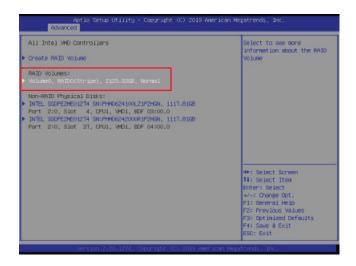


This feature is to create a RAID level with settings shown on the screen. Press <Enter> and the following screen will appear. It displays all RAID volumes.



RAID Volumes:

For detailed RAID volume information, use the arrow keys to select the desired RAID volume as shown below.



RAID VOLUME INFO

Press <Enter> and the following screen will appear.

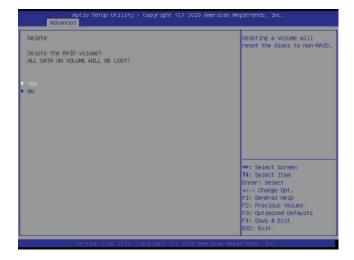


Delete

On the RAID VOLUME INFO screen, use the arrow keys to select Delete and press <Enter> to delete the RAID volume you have selected earlier (see the previous page for the RAID volume selection).

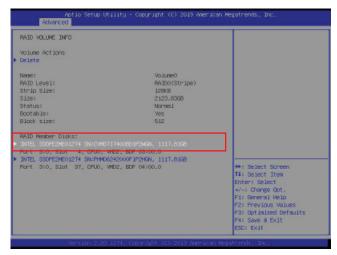


The following screen will appear. The options are Yes and No.

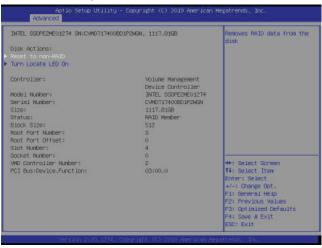


Reset to non-RAID

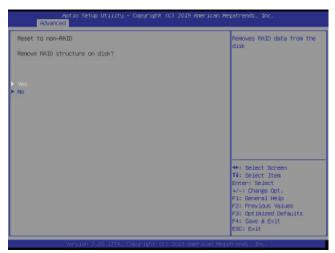
On the RAID VOLUME INFO screen (see page 149 for more information), select the desired NVMe device from the list of RAID Member Disks.



Press <Enter> and the following screen will appear.



The feature, Reset to non-RAID, allows the user to remove RAID data from the selected NVMe device. Press <Enter> and the following screen will appear. The options are **Yes** and No.

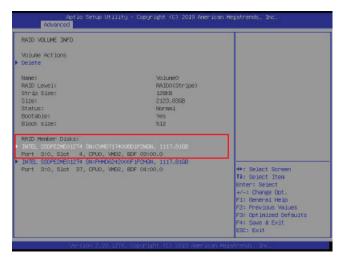


Turn Locate LED On

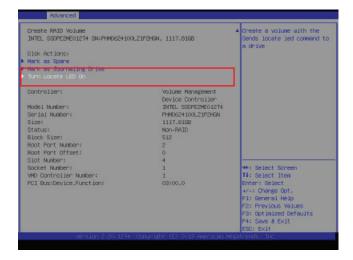
Use this feature to locate the selected device. Select a non-RAID physical disk.



Or select a RAID member disk.

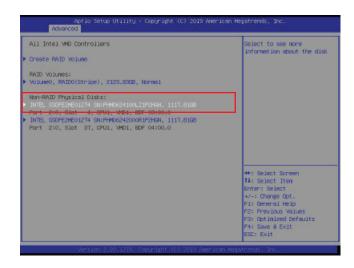


When the following screen appears, use the arrow keys to select Turn Locate LED On. Press <Enter> to locate the selected device.

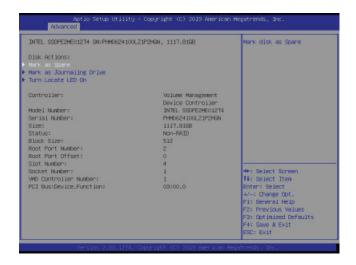


Mark as Spare

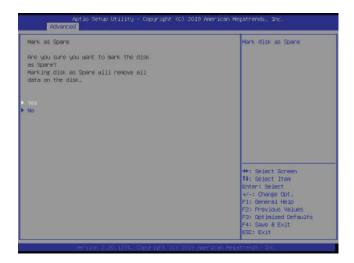
Refer to the instructions stated in E.1 section to access All Intel VMD Controllers menu items. When the following screen appears, select the desired NVMe device from the list of Non-RAID Physical Disks.



Press <Enter> and the following screen will appear.



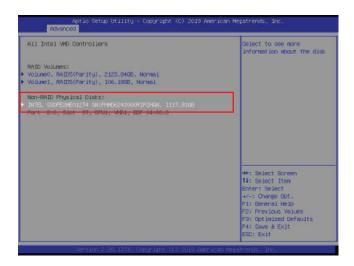
The feature, Mark as Spare, allows the user to set the selected NVMe device as a spare disk. Use the arrow keys to select Mark as Spare and press <Enter>. The following screen will appear. The options are **Yes** and No.



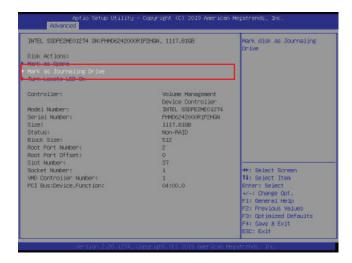
Note: A spare disk is used for automatic RAID volume rebuilds when status of failed, missing, or at risk is detected on the array disk. For a RAID0 volume, only status of at risk will trigger automatic RAID volume rebuilds.

Mark as Journaling Drive

Refer to the instructions stated in E.1 section to access All Intel VMD Controllers menu items. When the following screen appears, select the desired NVMe device from the list of Non-RAID Physical Disks.



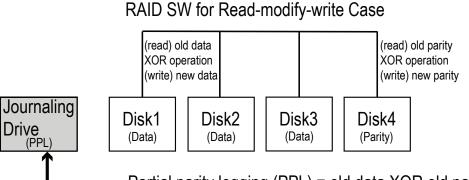
Press <Enter> and the following screen will appear.



The feature, Mark as Journaling Drive, allows the user to set the selected NVMe device as a journaling drive. Use the arrow keys to select Mark as Journaling Drive and press <Enter>. The following screen will appear. The options are **Yes** and No.



Note: RAID Write Hole (RWH) is a condition associated with a power/drive-failure/crash while writing to a RAID5 volume. The use of journaling drive that contains partial parity logging (PPL) can reduce the potential data loss. Refer to the following illustration for the use of journaling drive.

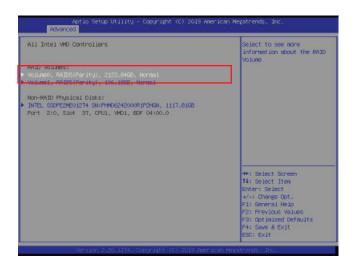


Store PPL to the journaling drive Partial parity logging (PPL) = old data XOR old parity New parity = new data XOR PPL

E.3 Use of Journaling Drive

The following steps describe the use of journaling drive for the RAID5 volume (parity based RAID).

Step 1. Refer to the instructions stated in E.1 section to access All Intel VMD Controllers menu items. When the following screen appears, use the arrow keys to select the desired RAID5 volume.



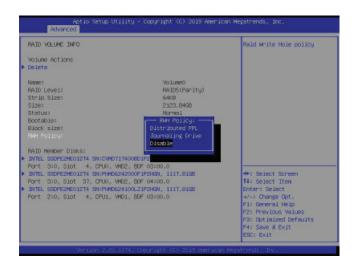
Press <Enter> and the following screen will appear.



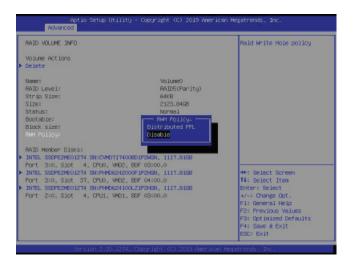
Step 2. Use the arrow keys to select RWH Policy. RWH is a scenario related to a power/drive-failure/crash.

RWH Policy

Press <Enter> and the following screen will appear. If any device has been set as a journaling drive (see pages 155 and 156), the options are Distributed PPL, Journaling Drive, and **Disable**.



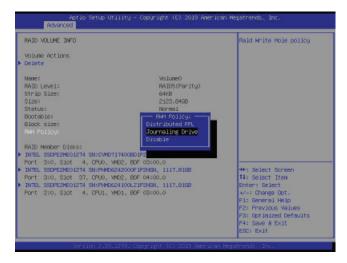
If no device has been set as a journaling drive, the options are Distributed PPL and **Disable**.



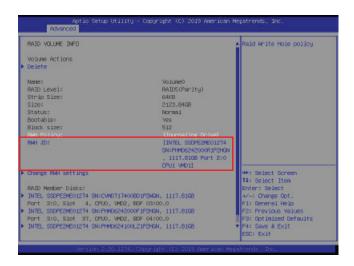
Note 1: Partial parity logging (PPL) can be defined as the result of XOR calculation of old data and old parity. PPL is a feature available for RAID5 volumes. While a power/drive-failure/crash occurring, PPL information helps rebuild the RAID volume and reduce the potential data loss.

Note 2: For the RWH condition, the Intel® RSTe 5.X or above RWH closure algorithm provides the option of use of an additional NVMe device for RAID volume rebuilds (Journaling Drive RWH closure mode). Without the use of an additional NVMe device, PPL distributed RWH closure mode can be utilized to close the RWH by using the parity drive for example.

Step 3. Set the feature, RWH Policy, to Journaling Drive.

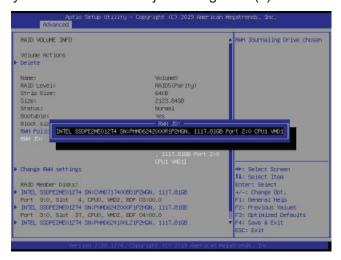


Press <Enter> and the RWH JD feature will become available as shown below.



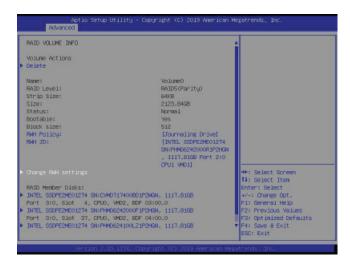
RWH JD

Use the arrow keys to select RWH JD. Press <Enter> and the following screen will appear. The feature displays the information of journaling drive(s).

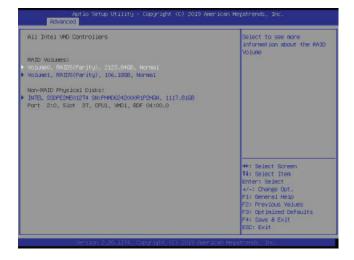


Step 4. Use the arrow keys and press <Enter> to select the desired journaling drive from the option list of RWH JD.

Step 5. For the changes to take effect, use the arrow keys to select Change RWH settings and press <Enter>.



The user will be returned to the main screen of All Intel VMD Controllers as shown below.



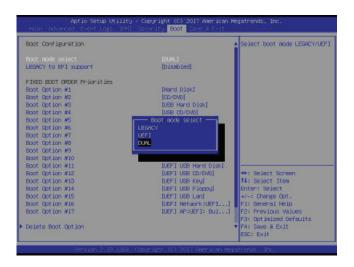
Appendix F

Secure Boot Settings

Secure boot is a feature of UEFI (Unified Extensible Firmware Interface) that ensures boot loaders are digitally signed and validated. The F.1, F.2, and F.3 sections provide instructions on how to enable the secure boot features. The F.4 section states Key Management settings.

F.1 Boot mode select Feature

Press during system boot to enter the BIOS Setup utility. Navigate to the Boot tab. Use the arrow keys to select Boot mode select and press <Enter>. The options are LEGACY, UEFI, and **DUAL**. Set Boot mode select to UEFI. For the changes to take effect, press <F4> to save the settings and exit the BIOS Setup utility.



F.2 Secure Boot/ Secure Boot Mode/ CSM Support Features

Press during system boot to enter the BIOS Setup utility. Navigate to the Security tab as shown below.



Use the arrow keys to select Secure Boot and press <Enter> to access the menu items. The following screen will appear.



Secure Boot

This feature is available when the platform key (PK) is pre-registered where the platform operates in the User mode and compatibility support module (CSM) support is disabled in the BIOS Setup utility. Select Enabled for secure boot flow control. The options are **Disabled** and Enabled.

Secure Boot Mode

Use this feature to set the secure boot mode. The options are Standard and **Custom**. Select Standard to load manufacturer's default secure variables. Select Custom to change the image execution policy and to manage secure boot keys.

CSM Support

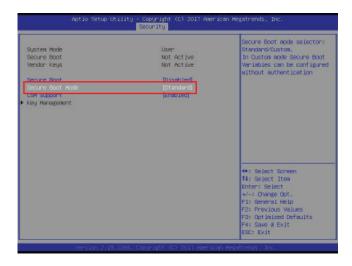
Select Enabled to support the legacy CSM, which provides compatibility support for traditional legacy BIOS for system boot. The options are Disabled and **Enabled**.



F.3 Secure Boot Settings

To have the secure boot support, be sure to follow the steps below (Step 1 \sim Step 4).

Step 1. Set Secure Boot Mode to Standard. Press Yes to install factory default keys as needed.



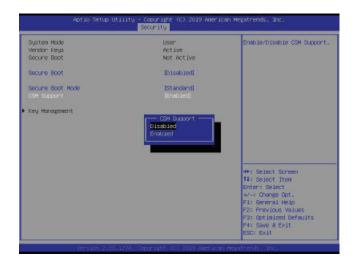


Note: The Key Management menu will become unavailable when Secure Boot Mode is set to Standard.

Step 2. For the changes to take effect, press <F4> to save the settings and exit the BIOS Setup utility.



Step 3. Press during system boot to enter the BIOS Setup utility. Navigate to the Security tab and enter the Secure Boot menu. Set CSM Support to Disabled.

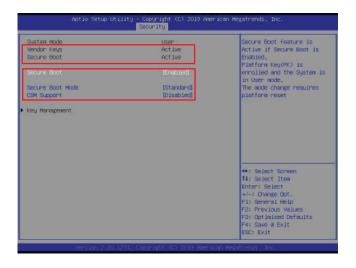


For the changes to take effect, press <F4> to save the settings and exit the BIOS Setup utility.

Step 4. Press during system boot to enter the BIOS Setup utility. Navigate to the Security tab and enter the Secure Boot menu. Set Secure Boot to Enabled.



For the changes to take effect, press <F4> to save the settings and exit the BIOS Setup utility. Press during system boot to enter the BIOS Setup utility. Navigate to the Security tab and enter the Secure Boot menu. The following screen will appear.



Note: Once Secure Boot is enabled, CSM Support will become disabled and the legacy environment is no longer valid. The authorized UEFI support such as UEFI OS, AOC UEFI FW, and UEFI PXE server are allowed.

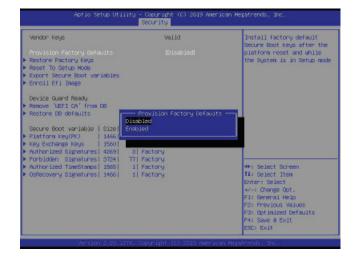
F.4 Key Management Settings

The Key Management menu as shown below, which is available when Secure Boot Mode is set to Custom, allows the secure boot keys to be installed via the external device and be involved in the secure boot process.



Provision Factory Defaults

This feature is to provision the default secure boot keys set by the manufacturer when system is in the Setup mode. The options are **Disabled** and Enabled.



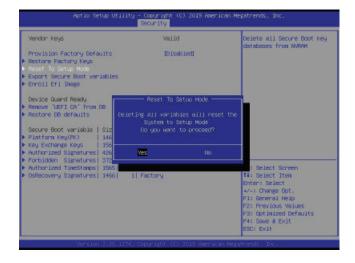
► Restore Factory Keys

Select and press Yes to restore factory default secure boot keys and key variables. Also, it will reset the system to the User mode. The options are **Yes** and No.



▶ Reset To Setup Mode (available when the System Mode is in User mode)

Select and press Yes to clear all secure boot variables and reset the system to the Setup mode. The options are **Yes** and No.



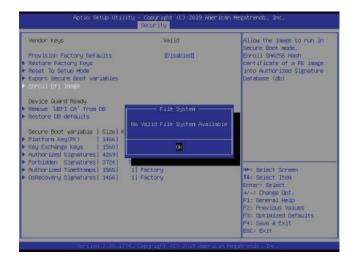
▶ Export Secure Boot variables

Use this feature to export NVRAM content of secure boot variables to files in a root folder on a file system device.



► Enroll Efi Image

This feature is to enroll SHA256 hash of the binary into the Authorized Signature Database (DB) and to allow the image to run in the secure boot mode.



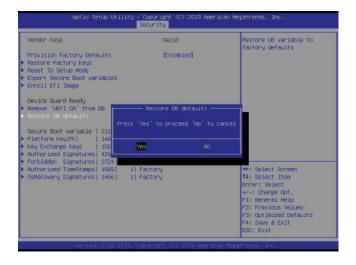
▶ Remove 'UEFI CA' from DB (available when the system is not in Device Guard Ready)

Select and press Yes to remove Microsoft UEFI CA certificate from the DB. The options are **Yes** and No.



▶ Restore DB defaults

Select and press Yes to restore the DB variables to factory defaults. The options are **Yes** and No.



*Refer to the following settings for keys and signatures related to secure boot.

► Platform Key (PK)

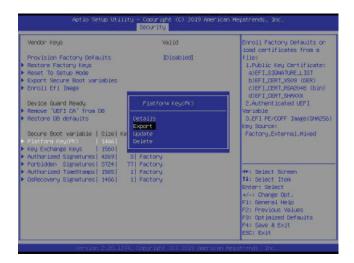
The Platform Key (PK), which is pre-installed in firmware during manufacturing, provides full control of the secure boot key hierarchy. The options are **Details**, Export, Update, and Delete. Select Details to display detailed information of PK. Select Export to save the current PKs to a FAT formatted USB flash drive. Select Update to load the factory defaults or load PKs from a file on the external device. Select Delete to clear the current PKs and reset the system to the Setup mode. See the following for more information of each option.



Details: Use the arrow keys to select Details and press <Enter>. It displays detailed information of PK as shown below.



Export: Use the arrow keys to select Export. It is to save the current PKs to a FAT formatted USB flash drive.

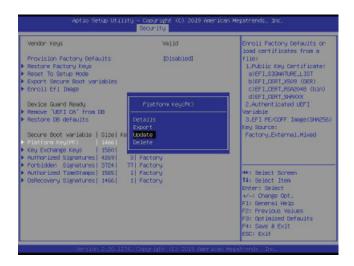


Press <Enter> and the following screen will appear.

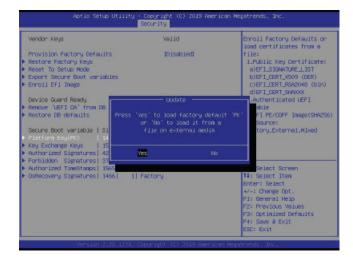


Note: Refer to the right panel of the screen for the file formats accepted.

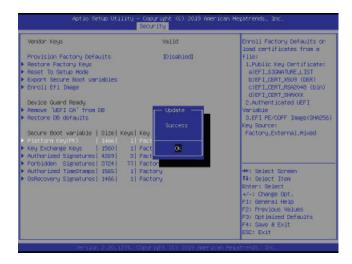
Update: Use the arrow keys to select Update. It is to load the factory defaults or load PKs from a file on the external device.



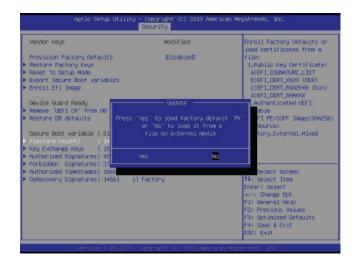
Press <Enter> and the following screen will appear.



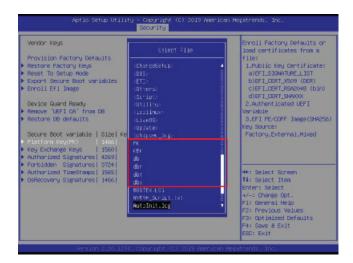
To load the factory defaults, navigate to Yes and press <Enter>. The following screen will appear.

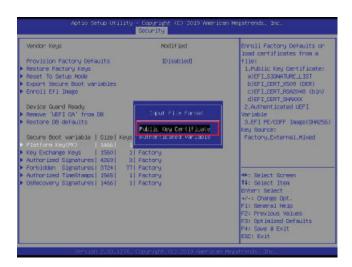


To load PKs from a file on the external device, navigate to No and press <Enter>.



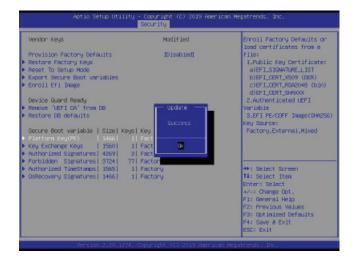
When the following screen appears, select the USB flash drive that contains the desired file.



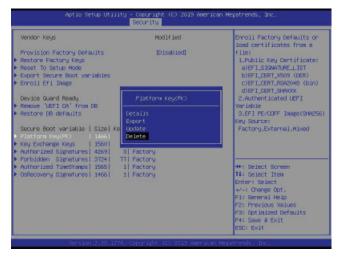


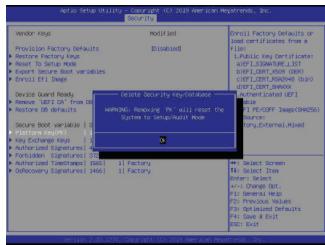


Press <Enter> and the following screen will appear.



Delete: Use the arrow keys to select Delete and press <Enter> to clear the current PKs and reset the system to the Setup mode.





► Key Exchange Key

The Key Exchange Key (KEK), which is held by the operating system vendor, can be updated by the holder of the PK and be used by secure boot to protect access to signatures databases. The options are **Details**, Export, Update, Append, and Delete. Select Details to display detailed information of KEKs. Select Export to save the current KEKs to a FAT formatted USB flash drive. Select Update to load the factory defaults or load KEKs from a file on the external device. Select Append to load the factory defaults or load KEKs from a file on the external device. Select Delete to clear the current KEKs or to delete only one certificate from the key database. (Refer to page 171 for the Export process. Refer to pages 172, 173, 174, and 175 for the Update process.)



Append: Use the arrow keys to select Append.



Press <Enter> and the following screen will appear.



To load the factory defaults, navigate to Yes and press <Enter>. The following screen will appear.



To load KEKs from a file on the external device, navigate to No and press <Enter>. Refer to pages 174 and 175 on how to load KEKs from a file on the external device.

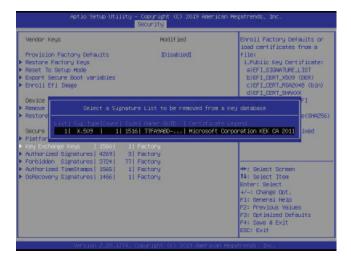


Delete: Use the arrow keys to select Delete and press <Enter>. Navigate to Yes and press <Enter> to clear the current KEKs.





Navigate to No and press <Enter> to delete only one certificate from the key database.



► Authorized Signatures

Authorized Signature Database (DB) contains authorized signing certificates and digital signatures. The options are **Details**, Export, Update, Append, and Delete. Select Details to display detailed information of Authorized Signatures. Select Export to save the current DB to a FAT formatted USB flash drive. Select Update to load the factory defaults or load DB from a file on the external device. Select Append to add variables to the existing DB. Select Delete to clear the current DB or to delete only one certificate from the key database. (Refer to page 171 for the Export process. Refer to pages 172, 173, 174, and 175 for the Update process. Refer to pages 176 and 177 for the Append process. Refer to page 178 for the Delete process.)



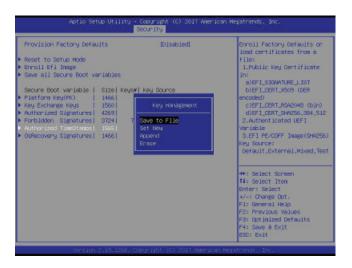
► Forbidden Signatures

Forbidden Signature Database (DBX), which is the inverse of DB, contains forbidden certificates and digital signatures. The options are **Details**, Export, Update, Append, and Delete. Select Details to display detailed information of Forbidden Signatures. Select Export to save the current DBX to a FAT formatted USB flash drive. Select Update to load the factory defaults or load DBX from a file on the external device. Select Append to add variables to the existing DBX. Select Delete to clear the current DBX or to delete only one certificate from the key database. (Refer to page 171 for the Export process. Refer to pages 172, 173, 174, and 175 for the Update process. Refer to pages 176 and 177 for the Append process. Refer to page 178 for the Delete process.)



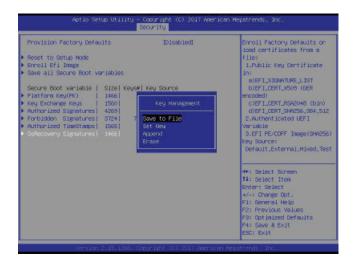
► Authorized TimeStamps

Authorized Timestamp Database (DBT) is used to issue and check signed time stamp certificates. The options are **Details**, Export, Update, Append, and Delete. Select Details to display detailed information of Authorized Timestamps. Select Export to save the current DBT to a FAT formatted USB flash drive. Select Update to load the factory defaults or load DBT from a file on the external device. Select Append to add variables to the existing DBT. Select Delete to clear the current DBT or to delete only one certificate from the key database. (Refer to page 171 for the Export process. Refer to pages 172, 173, 174, and 175 for the Update process. Refer to pages 176 and 177 for the Append process. Refer to page 178 for the Delete process.)



▶OsRecovery Signatures

OsRecovery Signatures Database (DBR) contains secure boot authorized recovery variables. The options are **Details**, Export, Update, Append, and Delete. Select Details to display detailed information of OsRecovery Signatures. Select Export to save the current DBR to a FAT formatted USB flash drive. Select Update to load the factory defaults or load DBR from a file on the external device. Select Append to add variables to the existing DBR. Select Delete to clear the current DBR or to delete only one certificate from the key database. (Refer to page 171 for the Export process. Refer to pages 172, 173, 174, and 175 for the Update process. Refer to pages 176 and 177 for the Append process. Refer to page 178 for the Delete process.)



Appendix G

Configuring iSCSI Settings

Internet small computer system interface (iSCSI) is a protocol that defines how block-level data transports between the iSCSI initiator and iSCSI target over an Internet protocol (IP) network. The iSCSI initiator (client/host) enables a connection to the iSCSI target and initiates I/O requests. The iSCSI target can be a group of storage devices or an intermediate device attached to storage devices. The iSCSI initiator and iSCSI target must connect to an IP network. To have iSCSI settings available, refer to instructions stated in the G.1 section. The G.2 section explains iSCSI settings.

G.1 PCIe/PCI/PnP Features

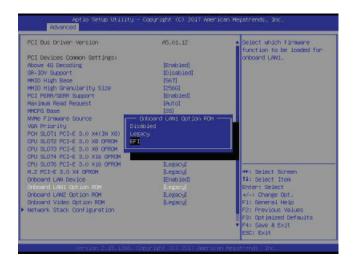
Press during system boot to enter the BIOS Setup utility. Navigate to the Advanced tab. Use the arrow keys to select PCIe/PCI/PnP Configuration and press <Enter> to access the menu items.



Note: Be sure to have configuration information for the iSCSI initiator and iSCSI target before starting iSCSI settings.

Onboard LAN1 Option ROM

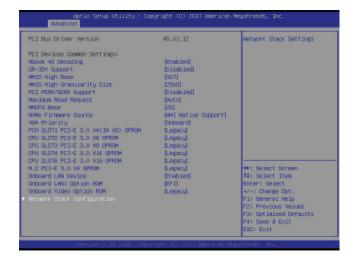
Use the arrow keys to select Onboard LAN1 Option ROM and press <Enter>. The options are Disabled, **Legacy**, and EFI. Set this feature to EFI.



Note: If Onboard LAN1 Option ROM is set to EFI, all features for onboard LAN option ROM will be set to EFI by the EFI driver. Additionally, these features will become unavailable except Onboard LAN1 Option ROM.

Network Stack Configuration

Use the arrow keys to select Network Stack Configuration and press <Enter> to access the menu items.





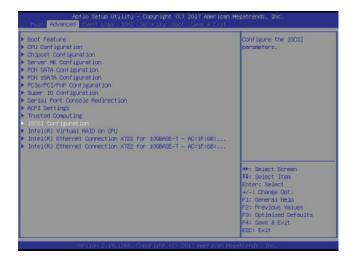
Ipv4 PXE Support/Ipv6 PXE Support

To enable Ipv4/Ipv6 PXE boot support, use the arrow keys to select and set Ipv4 PXE Support/Ipv6 PXE Support to Enabled.



Note: Enable both Ipv4 PXE Support and Ipv6 PXE Support to have iSCSI settings available. In some cases, enabling either one feature may also have iSCSI settings available depending on the configuration of iSCSI initiator and iSCSI target.

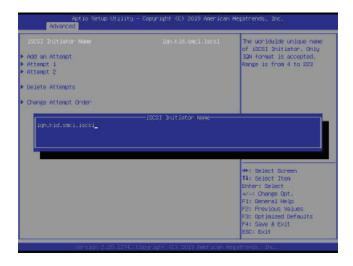
For the changes to take effect, save settings and restart the system. Press during system boot to enter the BIOS Setup utility. When the BIOS main screen appears, navigate to the Advanced tab. Use the arrow keys to select iSCSI Configuration and press <Enter> to access the menu items.



G.2 Configuring iSCSI Settings

iSCSI Initiator Name

Use this feature to enter the unique initiator name in iSCSI qualified name (IQN) format.

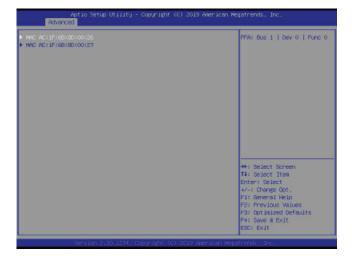


Add an Attempt

Use the arrow keys to select Add an Attempt.



Press <Enter> and the following screen will appear. Use the arrow keys to select the desired media access control address (MAC address), network interface card (NIC) port.

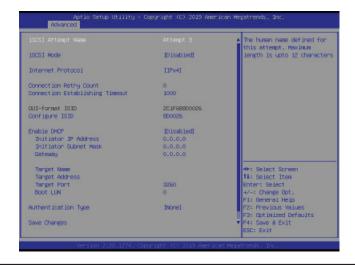


Press <Enter> and the following screen will appear.



iSCSI Attempt Name

This feature displays the iSCSI attempt name.



iSCSI Mode

Use this feature to set the iSCSI mode. The options are **Disabled**, Enabled, and Enabled for MPIO. Multipath I/O (MPIO) is a feature that allows the system to route I/O through the available paths if the active path fails (be sure to have more than one physical path connected to the system).





Note: Enabling the feature, iSCSI Mode, is required for iSCSI configuration.

Internet Protocol

Use this feature to set the Internet protocol. The options are IPv4, IPv6, and Autoconfigure.





Connection Retry Count

The valid range is 0~16. Use this feature to enter the number of logon sessions allowed for the iSCSI initiator to restart with the iSCSI target if the first logon connection fails.



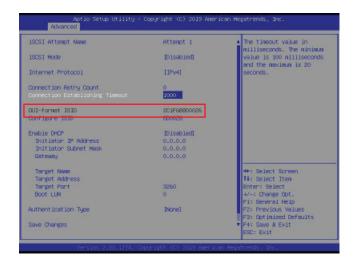
Connection Establishing Timeout

Use this feature to set the logon connection establishing timeout (in milliseconds). The valid range is from 100 milliseconds to 20 seconds.



OUI-format ISID

This feature displays the default ISID in OUI format. The value (in six bytes) is derived from the MAC address of the NIC port that you selected earlier.



Configure ISID

Press <Enter> to configure the ISID. The default value is derived from the last three bytes of the OUI-format ISID. Also, only the last three bytes of the ISID are configurable.



Enable DHCP

Use this feature to disable/enable dynamic host configuration protocol (DHCP) server service for the iSCSI initiator. The options are **Disabled** and Enabled.



Note: Set the feature, Enable DHCP, to Disabled if you would like to specify the iSCSI initiator IP address/subnet mask/gateway.

Initiator IP Address (available when Enable DHCP is set to Disabled)

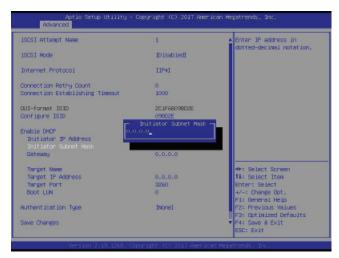
Use this feature to enter the desired iSCSI initiator IP address.





Initiator Subnet Mask (available when Enable DHCP is set to Disabled)

Use this feature to enter the desired iSCSI initiator subnet mask.



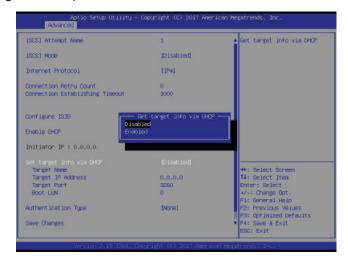
Gateway (available when Enable DHCP is set to Disabled)

Use this feature to enter the desired iSCSI initiator gateway.



Get target info via DHCP (available when Enable DHCP is set to Enabled)

Use this feature to disable/enable dynamic host configuration protocol (DHCP) server service for the iSCSI target. The options are **Disabled** and Enabled.



Note 1: Set the feature, Get target info via DHCP, to Disabled if you would like to specify the iSCSI target name/IP address/boot LUN.

Note 2: LUN stands for logical unit number, which is used to identify a logical/physical disk.

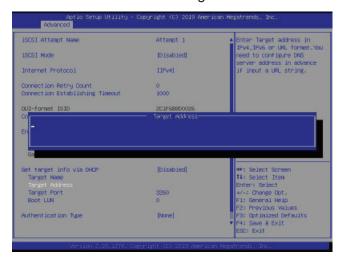
Target Name

Use this feature to enter the desired iSCSI target name in IQN format.



Target Address

Use this feature to enter the desired iSCSI target IP address.



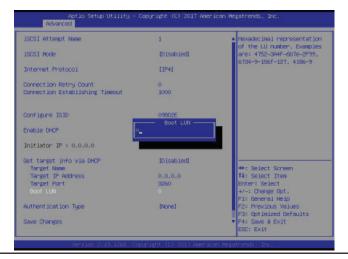
Target Port

This feature displays the iSCSI target port.



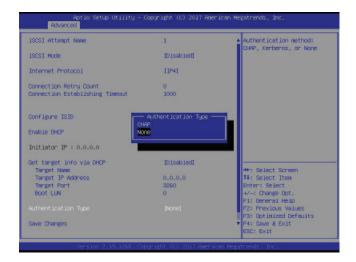
Boot LUN

Use this feature to enter the LUN ID of boot LUN.



Authentication Type

Use this feature to set the authentication method. The options are CHAP and None.



Note: Challenge handshake authentication protocol (CHAP) is a protocol used to verify the identity of the peer of a connection.

CHAP Type (available when Authentication Type is set to CHAP)

Use this feature to set the CHAP type. The options are One way and Mutual.



Note 1: If one way (unidirectional) CHAP authentication is performed, the iSCSI target authenticates the iSCSI initiator.

Note 2: If mutual (bidirectional) CHAP authentication is performed, the iSCSI target and iSCSI initiator authenticate each other.

CHAP Name (available when Authentication Type is set to CHAP)

Use this feature to enter the CHAP name authenticated by the iSCSI target.



CHAP Secret (available when Authentication Type is set to CHAP)

Use this feature to enter the CHAP secret (12~16 characters) authenticated by the iSCSI target.



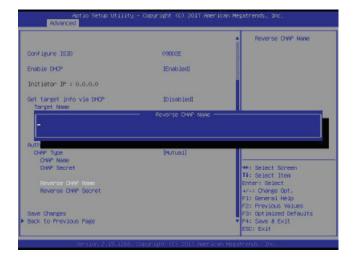
CHAP Status

This feature displays the CHAP status.



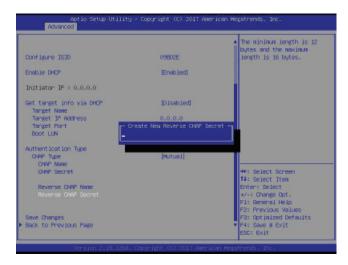
Reverse CHAP Name (available when CHAP Type is set to Mutual)

Use this feature to enter the CHAP name authenticated by the iSCSI initiator.



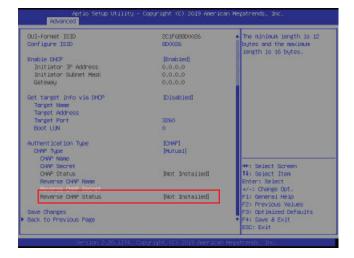
Reverse CHAP Secret (available when CHAP Type is set to Mutual)

Use this feature to enter the CHAP secret (12~16 characters) authenticated by the iSCSI initiator.



Reverse CHAP Status (available when CHAP Type is set to Mutual)

This feature displays the reverse CHAP status.



Save Changes

Use the arrow keys to select Save Changes and press <Enter> to save settings shown on the screen.



Note: For the changes to take effect, save settings and restart the system.

Back to Previous Page

Use the arrow keys to select Back to Previous Page and press <Enter>.

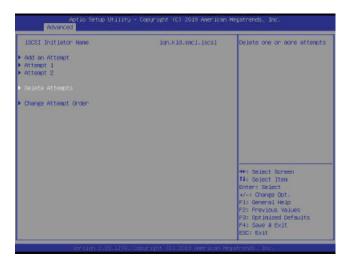


The user will be returned to the main screen of iSCSI Configuration as shown below.



Delete Attempts

Use the arrow keys to select Delete Attempts.



Press <Enter> and the following screen will appear.



Attempt 1

Use the feature to disable/enable Attempt 1. The options are **Disabled** and Enabled.



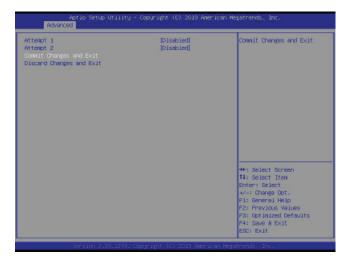
Attempt 2

Use the feature to disable/enable Attempt 2. The options are **Disabled** and Enabled.



Commit Changes and Exit

Press <Enter> to save changes and return to the main screen of iSCSI Configuration.



Discard Changes and Exit

Press <Enter> to return to the main screen of iSCSI Configuration without any change.



Change Attempt Order

Use the arrow keys to select Change Attempt Order.

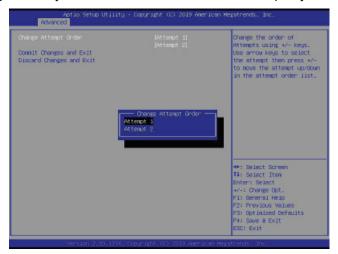


Press <Enter> and the following screen will appear.



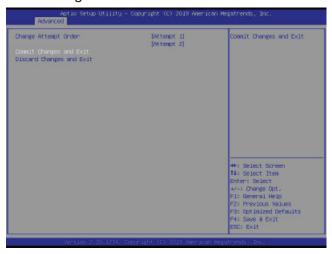
Change Attempt Order

This feature is to change the Attempt order. Use arrow keys to select the desired Attempt, then <+/-> keys to move up/down the selected Attempt. For instance, move up the selected Attempt by using <+> key. Move down the selected Attempt by using <-> key.



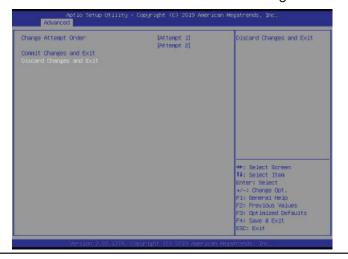
Commit Changes and Exit

Press <Enter> to save changes and return to the main screen of iSCSI Configuration.



Discard Changes and Exit

Press <Enter> to return to the main screen of iSCSI Configuration without any change.



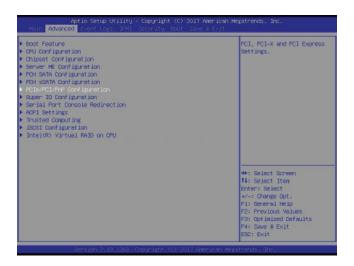
Appendix H

Configuring Network Interface Card (NIC) Settings

The appendix describes settings of onboard Intel® LAN devices via the BIOS Setup utility supported by the Unified Extensible Firmware Interface (UEFI) driver.

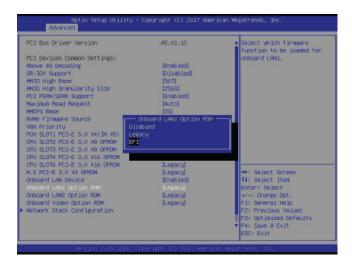
H.1 Network Interface Card (NIC) Settings

Press during system boot to enter the BIOS Setup utility. Navigate to the Advanced tab. Use the arrow keys to select PCIe/PCI/PnP Configuration and press <Enter> to access the menu items.



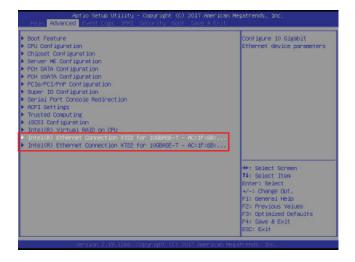
Onboard LAN1 Option ROM (available when NIC(s) is(are) detected by the system)

Use the arrow keys to select Onboard LAN1 Option ROM and press <Enter>. The options are Disabled, **Legacy**, and EFI. Set this feature to EFI.

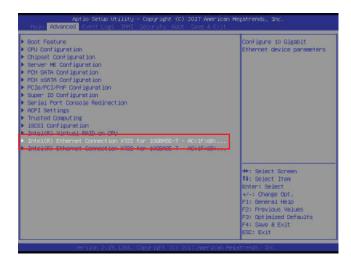


Note: If Onboard LAN1 Option ROM is set to EFI, all features for onboard LAN option ROM will be set to EFI by the EFI driver. Additionally, these features will become unavailable except Onboard LAN1 Option ROM.

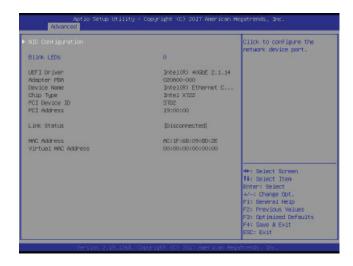
For the changes to take effect, press <F4> to save the settings and exit the BIOS Setup utility. Press during system boot to enter the BIOS Setup utility. Navigate to the Advanced tab. The feature(s) for onboard Intel® LAN device(s) will become available for configuration as shown below.



Use the arrow keys to select the desired onboard LAN device as shown below.

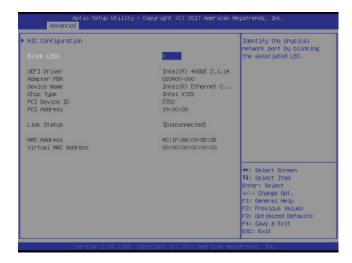


Press <Enter> and the following screen will appear. It displays the detailed information for the selected onboard LAN device.



Blink LEDs

This feature allows the user to set the LED blink duration (in seconds). The valid range is $0\sim15$ (seconds).



NIC Configuration

Use the arrow keys to select NIC Configuration.



Press <Enter> and the following screen will appear.



Wake on LAN

Use the arrow keys to select Wake On LAN and press <Enter>. The following screen will appear. The options are **Disabled** and Enabled. Set this feature to support system wake-up via the selected LAN device.

